

AT09423: SAM-BA Overview and Customization Process**ATSAMA5D3x****Introduction**

To help customers to benefit of the Atmel® SAM-BA® (SAM Boot Assistant) In-System Programmer functionalities, this application note provides a full detailed overview to understand how to customize SAM-BA by creating new custom boards based on the Atmel evaluation kits.

The aim of the customization is to reuse the existing architecture proposed in SAM-BA.

The customization guide proposed is based on the SAMA5D3-EK board.

Moreover, this customization process can be reproduced on any Atmel SAM device based board to get a real custom/user board fully implemented and accessible from the SAM-BA Graphical User Interface.

Prerequisites

- Hardware:
 - Atmel SAMA5D3x-EK
 - Any SAMA5D3x custom board
- Software:
 - Atmel SAM-BA 2.12 or higher
 - Atmel SAM-BA 2.12 patch 6 or higher
 - Sourcery™ CodeBench Lite 2013.05-23 for ARM® EABI
 - GNU Make 3.81
 - GNU Core utils 5.3
 - Notepad ++ (text editor)



Contents

1 SAM-BA Overview	4
1.1 Introduction	4
1.1.1 Architecture	4
1.1.2 How to get SAM-BA Installation File.....	5
1.2 SAM-BA Directory Organization on Windows	5
1.2.1 Applets.....	6
1.2.2 doc.....	7
1.2.3 drv (Driver).....	7
1.2.4 Example.....	7
1.2.5 TCL_lib	7
1.3 Graphical User Interface (SAM-BA GUI)	8
1.3.1 SAM-BA GUI Overview.....	9
2 Customization Process Overview	12
2.1 Customization Level Definition	12
2.2 First Level of Customization: The Applet Configuration TCL Files	12
2.3 Second Level of Customization: The Applets Source Code Customization	13
2.4 Third Level of Customization: The Applets Source Code Library Customization	13
2.5 Last level of Customization: Applet Compilation	14
2.6 Understand Interactions Between tcl/tk Scripts and Applets	14
2.6.1 Customized_board_example.tcl Description.....	15
2.6.2 LowLevel.tcl Description	19
3 Software Prerequisites.....	21
3.1 Sourcery CodeBench Lite 2013.05-23 for ARM EABI	21
3.1.1 Introduction.....	21
3.1.2 Installation	21
3.2 GNU Make 3.81	23
3.2.1 Introduction.....	23
3.2.2 Installation	23
3.3 GNU Core Utils 5.3.....	25
3.3.1 Introduction.....	25
3.3.2 Installation	25
4 Customization Step 1: Duplicate an Existing Solution as a Base for the Customization.....	26
4.1 Duplicate the TCL Folder Organization from an Existing One	26
4.2 Duplicate the Applet Folder Organization from an Existing One	27
5 Customization Step 2: Add a New Custom Board to the Existing TCL Database .	28
5.1 Add a New Board Entry.....	28
5.1.1 Modify the "boards.tcl" File	28
6 Customization Step 3: Customize the SAM-BA Graphical User Interface	30
6.1 Add a New Crystal Value in SAM-BA GUI's	30
6.2 Add a New Memory Tab in the SAM-BA GUI Main Window	31
7 Customization Step 5: Modify SAM-BA Applets to fit with a Custom Hardware...	34
7.1 Customize Low-Level Initialization Applet	34
7.1.1 Simple Example.....	34

7.1.2	Adapt Existing Applets to the New Hardware	36
7.2	Low Level Customization to Implement the Oscillator Bypass Mode	38
7.2.1	Bypass Mode Overview	38
7.2.2	Summary of the Different Steps to Perform	40
7.2.3	Step 1: Understanding the Initial Clock Setting During the Boot ROM	40
7.2.4	Step 2: Understanding the Clock Switching Mechanism	41
7.2.5	Step 3: Defining the Bypass Mode Program Flow	42
7.2.6	Step 4: Bypass Mode Code Implementation.....	43
7.3	Customize an External Memory Applet	46
7.3.1	External Memory Customization Process Overview	46
7.3.2	Customization Files Overview	46
7.3.3	SDR/DDR Customization Example.....	47
8	Compile the SAM-BA Applets and Test Your Modifications.....	62
9	References	67
Appendix A	Full Implementation of the Bypass Mode	68
Appendix B	Revision History	71

1 SAM-BA Overview

1.1 Introduction

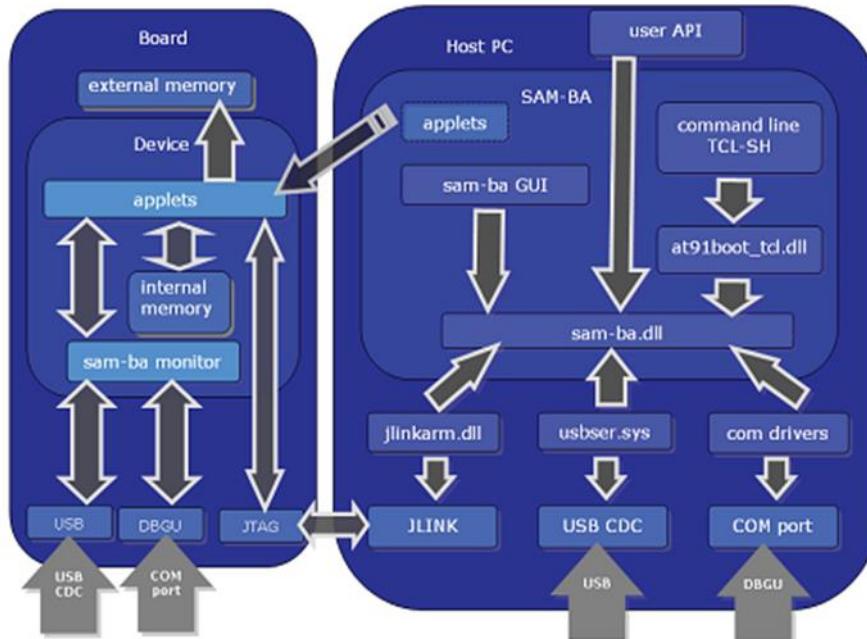
Atmel SAM Boot Assistance (SAM-BA) software provides an open set of tools for programming Atmel AT91SAM ARM Thumb-based microcontrollers. They are based on a common dynamic linked library (DLL), the AT91Boot_DLL. It is used by SAM-BA, and all ISP tools.

Customers can use SAM-BA as a tool to program their own board, designed by themselves. But, SAM-BA default settings are based on Atmel ARM-based evaluation kits and customers might have different crystals and memories on their own design. In that case SAM-BA needs to be customized.

Before starting the different hands-on assignments let's clarify start by an overview of SAM-BA.

1.1.1 Architecture

The SAM-BA is composed of two parts; the host and the target device board, as shown in the figure below:



The host part runs on computer. It sends programming files and programming instructions over a download cable to the target.

The target part is a hardware design, running in the ARM Thumb-based devices. It accepts the programming data content and required information about the target external memory device which was sent by the host, and follows the instructions to write/read data to/from the external memory device.

- SAM-BA key features:
 - Perform in-system programming through JTAG, RS232, or USB interfaces
 - Provides both AT91SAM embedded flash programming and external flash programming solutions
 - May be used via a Graphical User Interface (GUI) or started in batch mode from a DOS window
 - Runs under Windows® 2000, XP, and 7
 - Memory and peripheral display content
 - User scripts executable from SAM-BA Graphical User Interface or a shell

To learn more about SAM-BA, refer to the AT91 ISP/SAM-BA user guide document available at the following link: <http://www.atmel.com/images/6421b.pdf>. Or simply use the SAM-BA user guide document located in [C:\Program Files \(x86\)\Atmel\sam-ba_X.xx\doc](C:\Program Files (x86)\Atmel\sam-ba_X.xx\doc).

1.1.2 How to get SAM-BA Installation File

SAM-BA is available for free directly from this Atmel web page:

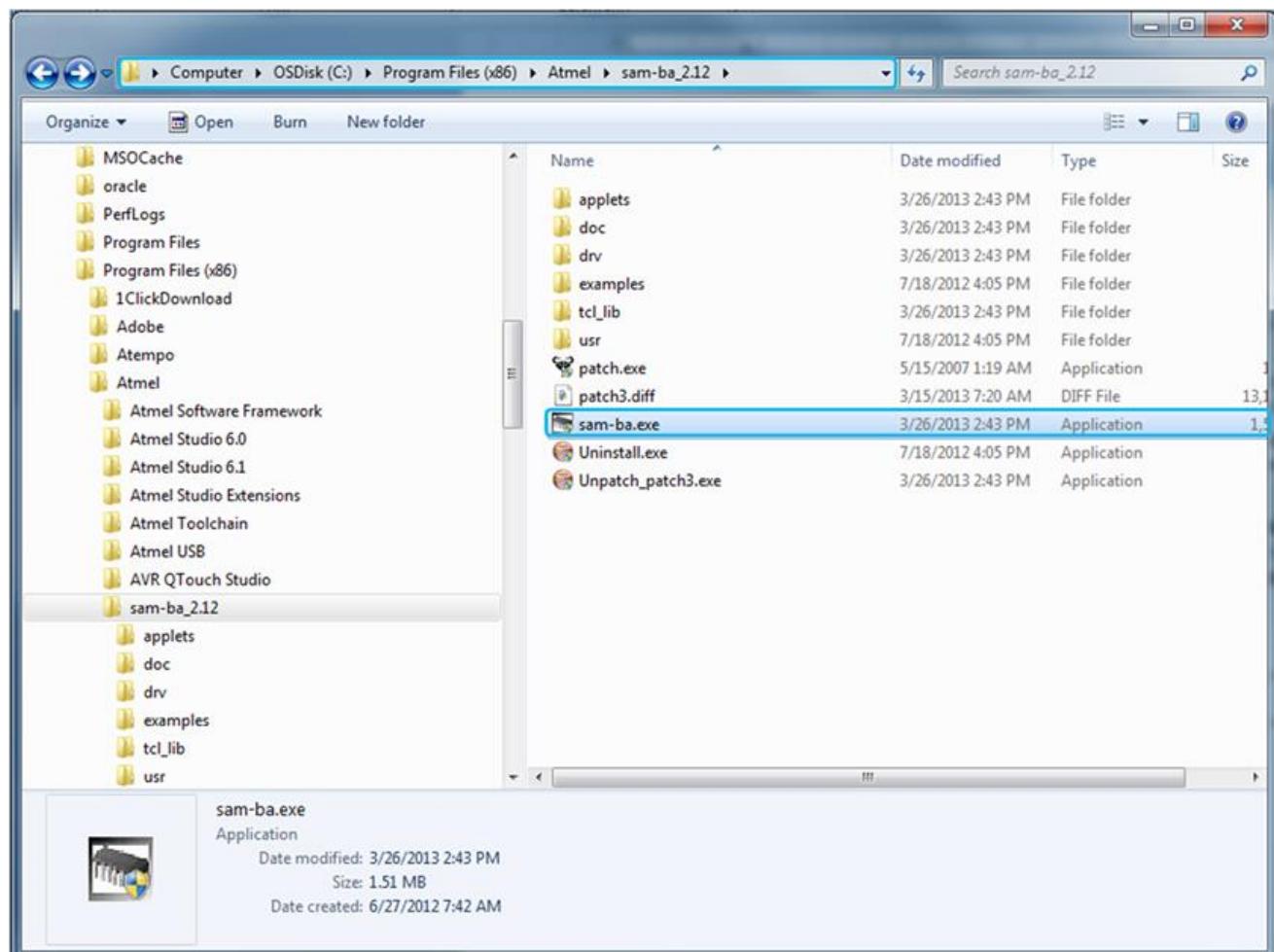
<http://www.atmel.com/tools/atmelsam-bain-systemprogrammer.aspx>

Several components are available:

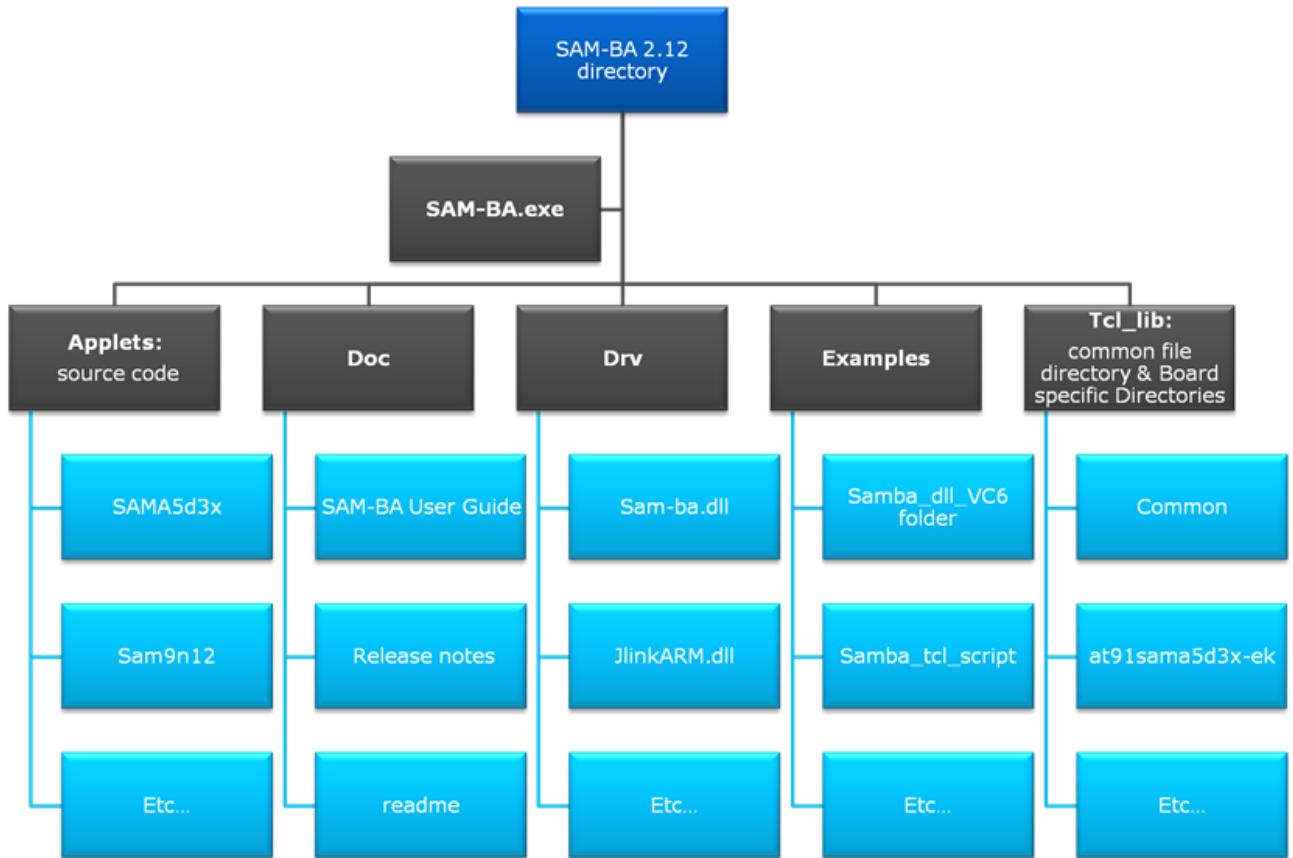
- SAM-BA for Windows (XP, Vista, and 7 editions)
 - Install file for the SAM-BA package. SAM-BA User's Guide is included in the package.
- SAM-BA 2.12 for Linux®
 - SAM-BA Package for Linux
- atm6124 USB CDC signed driver for Windows XP, Windows Vista®, Win7, and Win8
 - Signed version of atm6124 USB CDC driver
- SAM-BA Patch
 - This file provides the new features and bugs corrected of the current release of SAM-BA

1.2 SAM-BA Directory Organization on Windows

Once installed on a Windows computer, the runtime directory for SAM-BA is [C:\Program Files \(x86\)\Atmel\sam-ba_X.xx](C:\Program Files (x86)\Atmel\sam-ba_X.xx). In this folder, you will find the <sam-ba.exe> file and all the files required by SAM-BA when it is running:



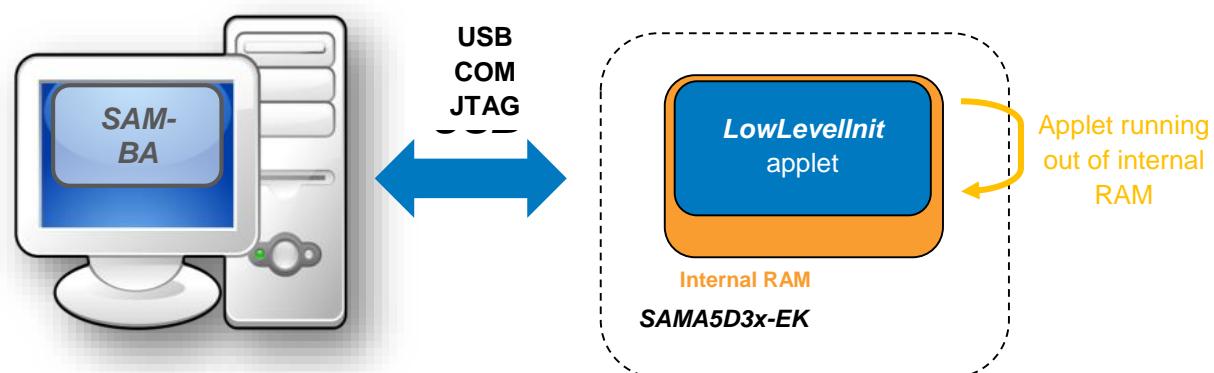
The SAM-BA directory is organized as:



1.2.1 Applets

The base directory of sources is: [C:\Program Files \(x86\)\Atmel\sam-ba_X.xx\applets](C:\Program Files (x86)\Atmel\sam-ba_X.xx\applets). This folder is not used when SAM-BA is running. It just contains the applet sources and instructions on how to build them.

An applet is a small program which is used by SAM-BA in order to be able to program non-volatile memories, low-level initialization, or other peripherals. For each Atmel AT91SAM device, there is one dedicated applet to each external memory device the chip can deal with. Each applet contains the programming algorithm for its dedicated memory.



For instance, with the AT91SAMA5D3x-ek, SAM-BA has to be able to program SDRAM, NAND flash, Data flash, Serial flash, and NOR flash, which are located in

[C:\Program Files \(x86\)\Atmel\sam-ba_2.12\applets\sama5d3x\sam-ba_applets](C:\Program Files (x86)\Atmel\sam-ba_2.12\applets\sama5d3x\sam-ba_applets).

1.2.2 doc

This folder contains all documents to help the user to learn more about SAM-BA, such as:

- SAM-BA User Guide
- releasenote.txt
- readme.txt

1.2.3 drv (Driver)

This folder contains all the drivers required by SAM-BA GUI to communicate with the board or with the targeted memory, such as:

- AT91Boot_TCL.dll: an intermediate DLL is used to transform TCL commands.
- sam-ba.dll: an OLE COM component for SAM-BA.
- atm6124_cdc.inf: Windows USB CDC Driver Setup File for ATMEL AT91 USB to Serial Converter.
- JLinkARM.dll: a DLL for using J-Link / J-Trace with third-party programs from SEGGER.
- SAMBA_DLL.tlb: type library file of sam-ba.dll.

1.2.4 Example

This folder contains several examples on how to use SAM-BA in different contexts:

- samba_dll_usage_VC6 directory
 - Example OLE_MFC project under Visual C++ 6.0
 - Example OLE_without_MFC project under Visual C++ 6.0
- samba_tcl_script
 - Example tcl script file to access NAND flash

1.2.5 TCL_lib

The TCL_lib directory which contains:

- a common files directory, with all generic TCL scripts used to load applets, communicate with them, and perform read / write operations,
- several board specific folders (into *at91sama5d3x-ek* for the *at91sama5d3x-ek* for example), containing the applet binary files and the TCL file used to describe the SAM-BA GUI for each board (what memory is on the board, what is the applet name for each memory).

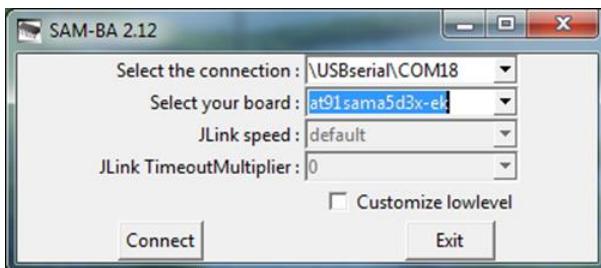
Just after having installed SAM-BA, in order to make it able to program these peripherals, all the applets are already precompiled. That explains why these five binary files and many others are located in the *C:\Program Files (x86)\Atmel\sam-ba_X.xx\tcl_lib\at91sama5d3x-ek* folder and ready to be used by SAM-BA to make the connection successful.

1.3 Graphical User Interface (SAM-BA GUI)

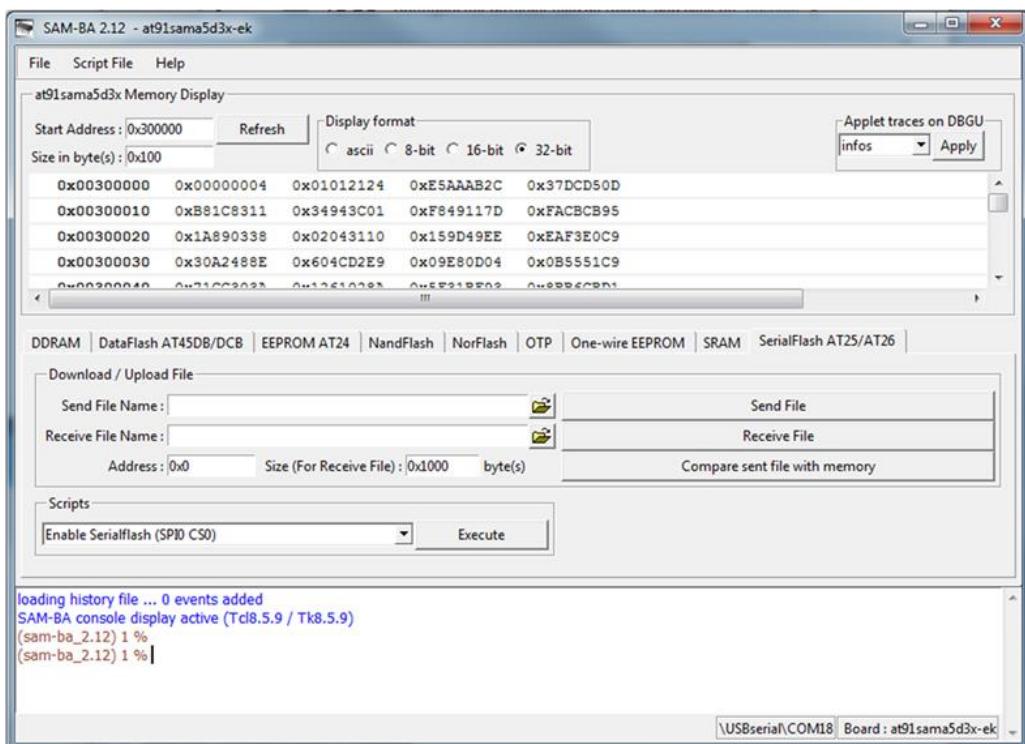
Once installed on a Windows computer, SAM-BA is opened by double-clicking on the SAM-BA icon:



The connection window should appear:



If the settings are correct, the SAM-BA GUI window is opened a few seconds after having clicked on "connect":



Before starting the description of the different fields of the main SAM-BA GUI window, let's spend some lines to clarify what has been executed by SAM-BA just before the main window is displayed.

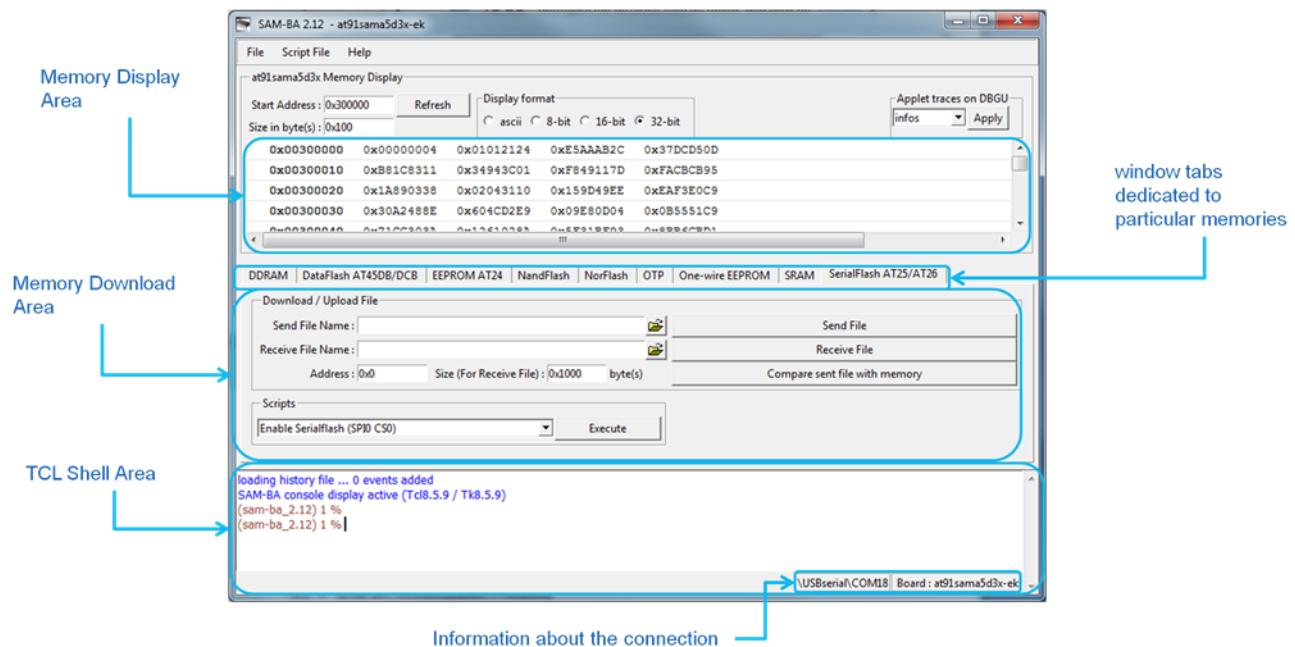
To make the connection between the board and the PC available, several applet executions have been performed, such as:

- Board low-level initialization
- Clock settings (PLL, oscillators, crystals, etc.)
- Communication (USB, RS232)
- eMPU case: dedicated applet to initialize the DDR memories.

Once the low-level initialization is done and the connection is well detected, the communication can start between the PC and the board. Then the main SAM-BA GUI main window is displayed.

1.3.1 SAM-BA GUI Overview

SAM-BA GUI main window provides several different fields as described in the figure below:

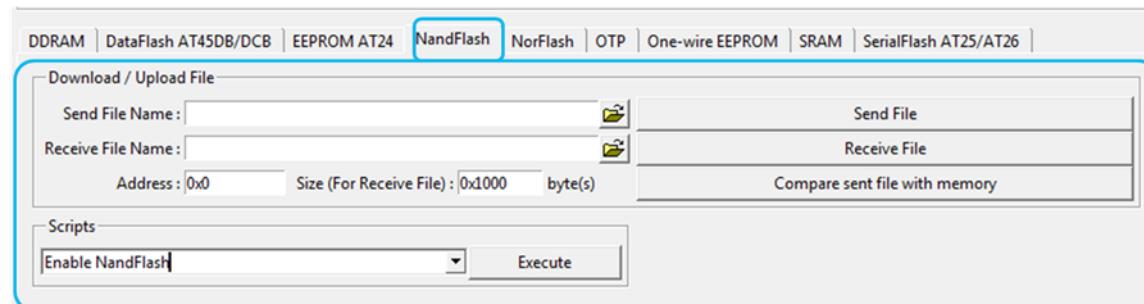


The user can find:

- The memory display area: Memory dump.
- Memory Download area: Applet Graphical User Interface composed of dedicated memory window tabs such as:
 - EEPROM tabs
 - DataFlash tabs
 - Serial Flash
 - NAND Flash
 - Etc.
- TCL Shell area: TCL script execution trace.
 - With some information about the ongoing connection

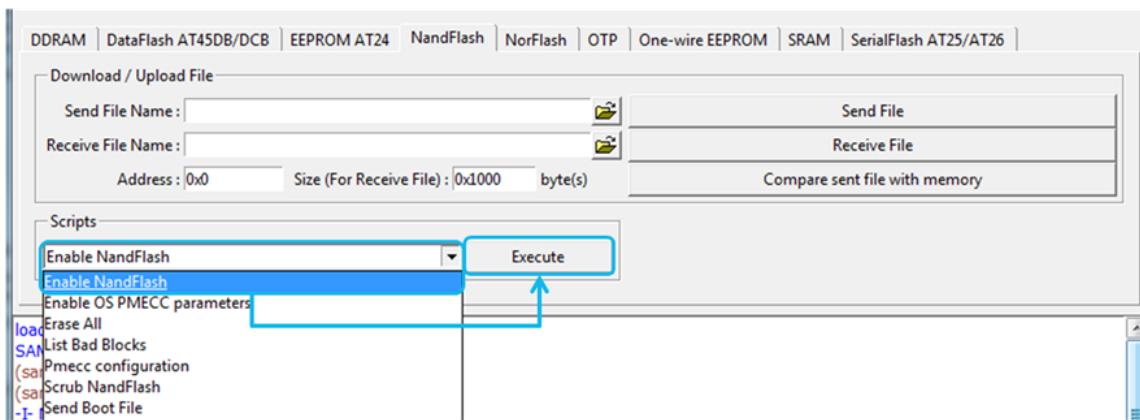
The base of the main window stays the Applet Graphical User Interface where the user spends most of time to program the targeted device memory.

For instance, the **NAND FLASH** window tabs Memory Download area window tabs, provides a simple way to upload and download data into internal and external memories. For each memory, files can be sent and received, and the target's memory content can be compared with a file on our computer:

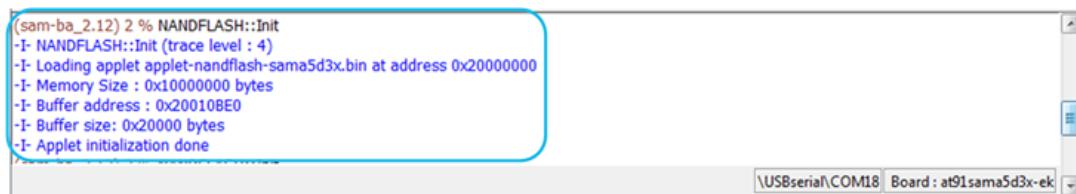


Only binary file format is supported by SAM-BA GUI.

This area also gives an access to some specific scripts for the different memories available on the board through a drop-down menu:



During a script execution, the TCL Shell window is used to display the different steps of the applet execution:



At this time, the target handles the programming algorithm by loading applets into the on board XIP memory.

The target switches between two modes:

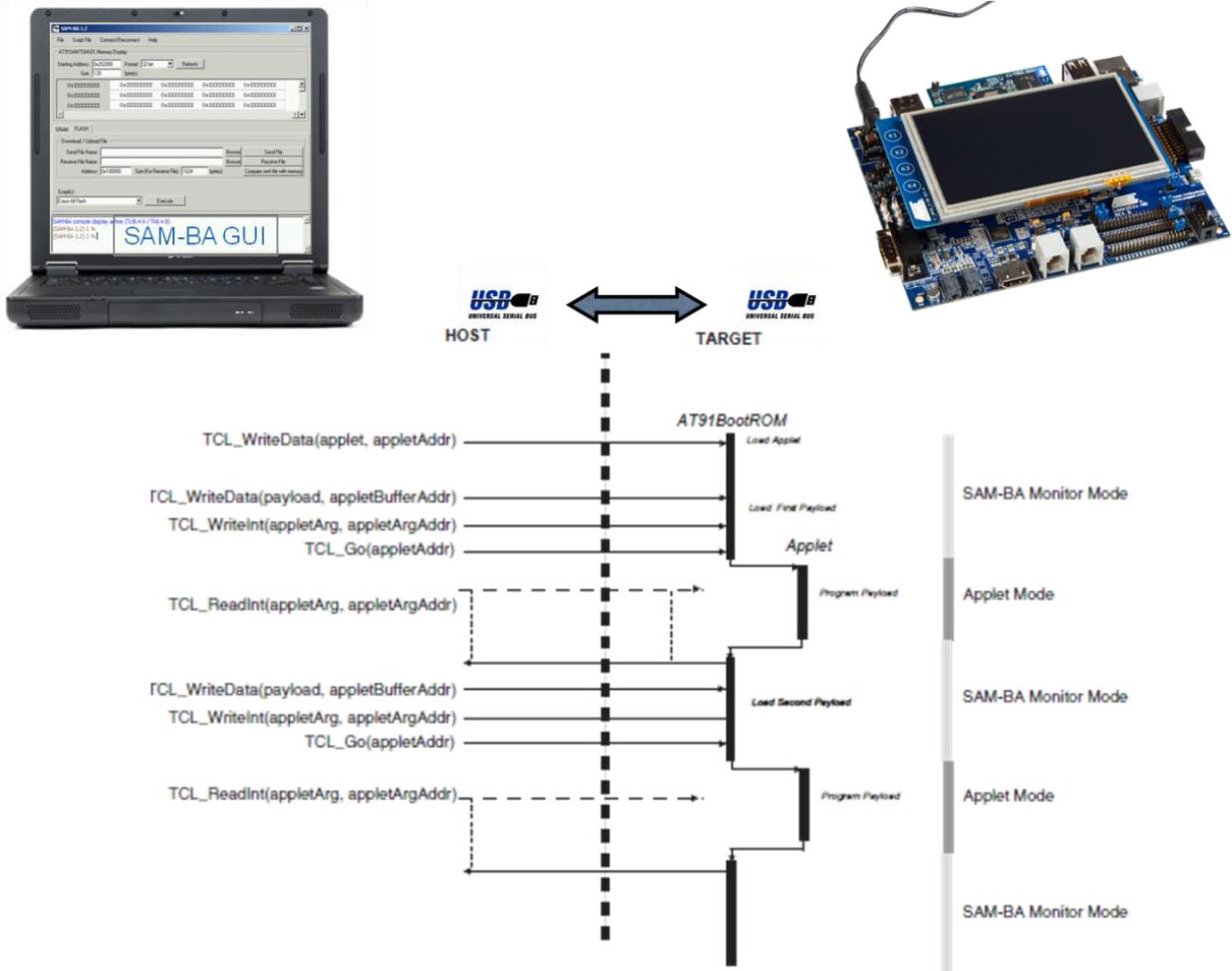
- SAM-BA Monitor Mode: is the command interpreter that runs in the ROM memory when the chip is connected with USB or COM port to the computer. It allows the computer to send or receive data to/from the target. All transfers between host and device are done when the device is in SAM-BA monitor mode. The SAM-BA monitor mnemonics commands are given in the table below:

Command	Action	Argument(s)	Example
N	Set Normal Mode	No argument	N#
T	Set Terminal Mode	No argument	T#
O	Write a byte	Address, Value#	O200001,CA#
o	Read a byte	Address,#	o200001,#
H	Write a half word	Address, Value#	H200002,CAFE#
h	Read a half word	Address,#	h200002,#
W	Write a word	Address, Value#	W200000,CAFEDECA#
w	Read a word	Address,#	w200000,#
S	Send a file	Address,#	S200000,#
R	Receive a file	Address, NbOfBytes#	R200000, 1234#
G	Go	Address#	G200200#
V	Display version	No argument	V#

SAM-BA commands are indeed very basic. They are sent to the applet by using TCL commands as [TCL_WriteData \(applet, appletAddr\)](#), [TCL_WriteInt \(applet, appletAddr\)](#), [TCL_ReadInt \(applet, appletAddr\)](#) from the PC, etc.

- Applet Mode: in this mode, the device performs programming operations and is not able to communicate with the host. As reminder, an applet is a small piece of software running on the target. It is loaded in the device memory while the device is in SAM-BA monitor mode using **TCL_Write** command.

The device switches from SAM-BA monitor mode to Applet mode using the **TCL_Go** command. The device executes the applet code. At the end of the current operation, the device switches back to SAM-BA monitor mode as described below:



To learn more on the SAM-BA monitor, refer to the **SAMA5D3** product family datasheet found here: <http://www.atmel.com/products/microcontrollers/arm/sama5.aspx?tab=documents>.

An applet can execute different programming or initialization commands. Before switching to applet mode, the host prepares command and arguments data required by the applet in a mailbox mapped in the device memory.

During its execution, the applet decodes the commands and arguments prepared by the host and execute the corresponding function. The applet returns state, status and result values in the mailbox area. Usually, applets include INIT, buffer read, buffer write functions. To program large files, the whole programming operation is split by the host into payloads. Each payload is sent to a device memory buffer using SAM-BA monitor command **TCL_Write**. The host prepares the mailbox with the Buffer write command value, the buffer address and the buffer size. The host then forces the device in Applet mode using a **TCL_Go** command. The host polls the end of payload programming by trying to read the state value in the mailbox. The device will answer to the host as soon as it returns to SAM-BA monitor mode. In case of USB connection, when the host polls while the device is in Applet mode, the device NACK IN packets sent by the host.

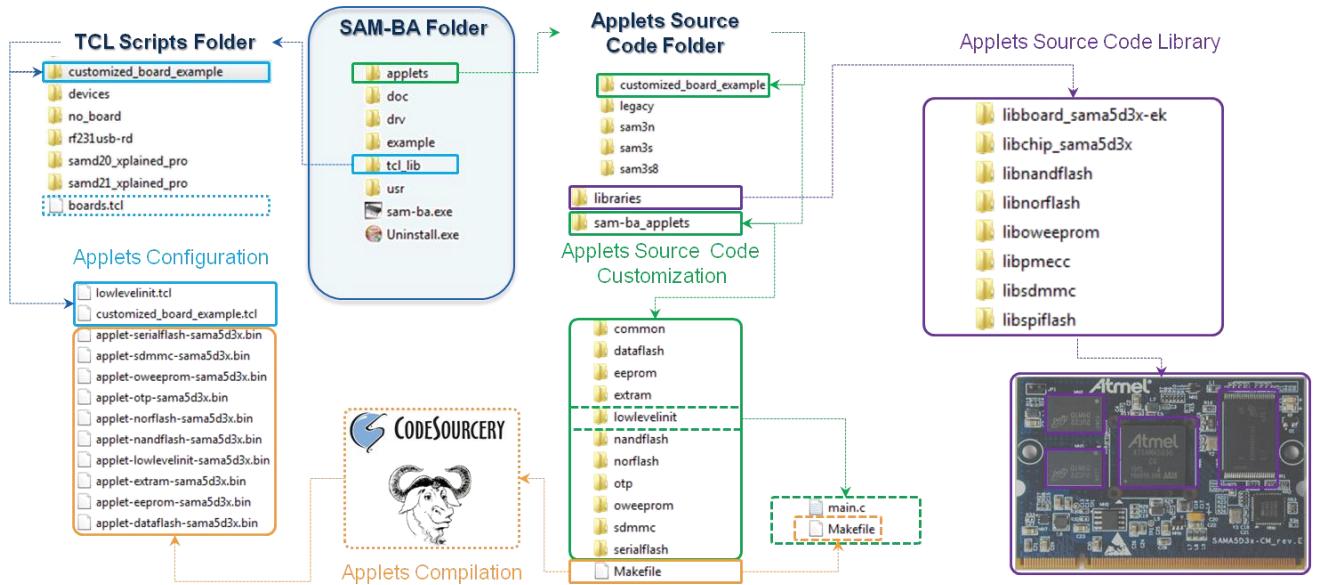
2 Customization Process Overview

2.1 Customization Level Definition

Customization means that the user will have to reuse most of the existing part of the SAM-BA architecture. The customization of SAM-BA requires to understand what the different levels of the customization, which summarizes what the main possibilities that SAM-BA offers are. The figure below introduces the levels of the customization.

In case users want to use SAM-BA on their own custom board, which is different from the Atmel Evaluation Kit, they may need to adapt the code of the applets and recompile some of them. All the sources are provided with the SAM-BA installer, and the applets are written in C.

Consider the figure below.



In this scheme we consider that the customization is realized by creating the “`customized_board_example`” directory. For more convenience, this directory is duplicated from any existing Atmel board implementation. More details on the different step to proceed will be provided in the next coming sections.

According to the color code introduced by the figure above, using different colors allows distinguishing the different level of this customization.

2.2 First Level of Customization: The Applet Configuration TCL Files

First Level of customization: The Applet Configuration TCL files. These files are located in the TCL Scripts Folder (`tcl lib`). Depending on the hardware requirements, only modifying these files may be sufficient to make the board able to connect to SAM-BA. In terms of customizations, the files to be modified are:

- `Boards.tcl`, directly located in the `\sam-ba_2.14\tcl lib` directory, this file is a kind of board database which lists all the targeted boards supported by SAM-BA software. # Board folder MUST have the same name as the board, in this case `customized_board_example`. Modifying this list will change the “Select your board” drop down menu list from the SAM-BA connection window. Refer to Section [1.3 Graphical User Interface \(SAM-BA GUI\)](#).
- Inside the `\sam-ba_2.14\tcl lib\customized_board_example` folder, two files are significant in the SAM-BA customization process:
 - `customized_board_example.tcl`, which is the main configuration file used to call the required applet, regarding the Low-level initialization and the memories initialization. This file must be

- modified when the user wants to customized SAM-BA according to the application hardware requirements.
- *lowlevelinit.tcl*, this file is used to call the low-level initialization applet. From this file the user is able to select what kind of clock configuration he has to use regarding the application.

2.3 Second Level of Customization: The Applets Source Code Customization

Second Level of Customization: The Applets Source Code Customization. In this level, the user understood that modifying the **Applet Configuration TCL files**, is not sufficient regarding the hardware requirements of his application. In this case, the user has to dig into the applet architecture to figure out how it is possible to reuse the main low-level functions implemented into the provided libraries. **Once the modifications are done the applets needs to be recompiled.** In terms of customization the applet source code are located inside the `\sam-ba_2.14\applets\customized_board_example` directory, duplicated from any other existing applet directory which contains two sub-directories:

- *Libraries*: This directory provides all the low-level drivers developed by Atmel Engineers for the targeted device and for the board requirements. The next level of customization will provide more details on this section.
- *sam-ba_applets*: Contains several sub-folders and the *makefile* used to recompile the applets. Depending on the hardware memory set, one directory per memory is provided. If the user has duplicated the existing *sama5d3x* applet directory to generate his own *customized_board_example* the directory set should look-like this:
 - *Common*
 - *Dataflash*
 - *Eeprom*
 - *Extram*
 - *Lowlevelinit*
 - *Nandflash*
 - *Norflash*
 - *Otp*
 - *Oweeprom*
 - *Sdmmc*
 - *Serialflash*
 - *Makefile*

Most of these folders are related to a hardware memory, except the *lowlevelinit* which is related to the main clock configurations. Depending on the hardware configuration of the custom board, the user will have to modify the *main.c* file provided inside each directory.

2.4 Third Level of Customization: The Applets Source Code Library Customization

Third Level of Customization: The Applets Source Code Library Customization. This level of the customization is the highest one mostly required when the user wants to modify the low level driver of a memory, a peripheral, or of the clock configuration while the provided low level driver does not fit with the application requirements. For instance, the user application DDR or the LPDDR memory does not match with the one initially related to the Atmel evaluation kit, the memory architecture and/or the timings need to be modified. This directory is a legacy of the Atmel Software package and contains the following architecture:

- *libboard_sama5d3x-ek*
- *libchip_sama5d3x*
- *libnandflash*

- *libnorflash*
- *liboweprom*
- *libpmecc*
- *libsdmmc*
- *libspiflash*

In this application note we are going to address different user cases but we consider a custom board initially based on the SAMA5D3x-EK, which is already supported in SAM-BA. So we will reuse most part of the existing applets for this evaluation kit.

2.5 Last Level of Customization: Applet Compilation

Last level of Customization: Applet compilation: Once an applet is modified either from the Second Level or the Third level of the customization, it needs to be recompiled. Using the makefile provided from the [*sam-ba_2.14\applets\customized_board_example\ sam-ba_applets\ directory*](#).

The next section will introduce the tools required to compile an Applet under a windows computer.

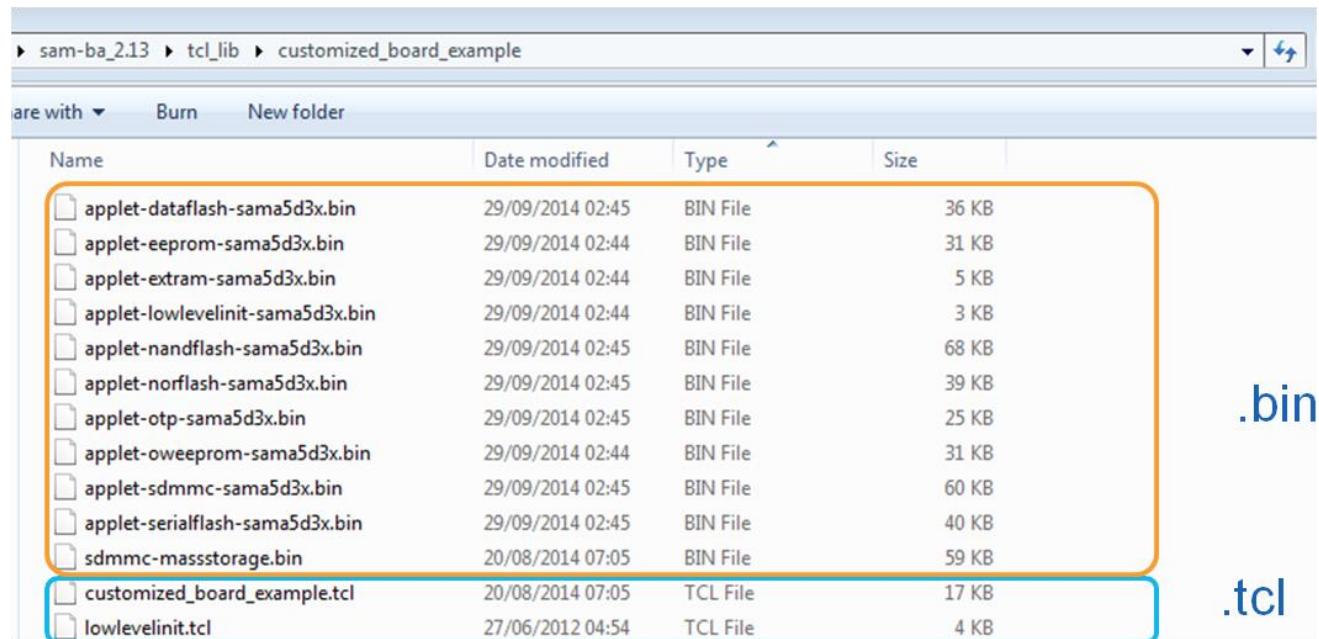
Once compiled each binary is then automatically copied into the directory: [*\sam-ba_2.14\tcl_lib\customized_board_example*](#).

The last chapter of this application note explain how to recompile an applet.

2.6 Understand Interactions Between tcl/tk Scripts and Applets

In this section the aim is to understand the *.tcl* files used to communicate with an applet:

After having a look at the [*\sam-ba_2.14\tcl_lib\customized_board_example*](#) the following architecture can be observable:



Name	Date modified	Type	Size
applet-dataflash-sama5d3x.bin	29/09/2014 02:45	BIN File	36 KB
applet-eeprom-sama5d3x.bin	29/09/2014 02:44	BIN File	31 KB
applet-extram-sama5d3x.bin	29/09/2014 02:44	BIN File	5 KB
applet-lowlevelinit-sama5d3x.bin	29/09/2014 02:44	BIN File	3 KB
applet-nandflash-sama5d3x.bin	29/09/2014 02:45	BIN File	68 KB
applet-norflash-sama5d3x.bin	29/09/2014 02:45	BIN File	39 KB
applet-otp-sama5d3x.bin	29/09/2014 02:45	BIN File	25 KB
applet-oweprom-sama5d3x.bin	29/09/2014 02:44	BIN File	31 KB
applet-sdmmc-sama5d3x.bin	29/09/2014 02:45	BIN File	60 KB
applet-serialflash-sama5d3x.bin	29/09/2014 02:45	BIN File	40 KB
sdmmc-massstorage.bin	20/08/2014 07:05	BIN File	59 KB
customized_board_example.tcl	20/08/2014 07:05	TCL File	17 KB
lowlevelinit.tcl	27/06/2012 04:54	TCL File	4 KB

Two different types of files are in this folder:

- Binaries: By default SAM-BA provides all the binaries initially required to connect to an Atmel board. This folder contains all the initial binaries. But once compiled each binary is then automatically copied into the directory, erasing the previous ones. The proposed method of duplicating makes sense if the user does not want to break the initial component of SAM-BA.

- TCL files:
 - *customized_board_example.tcl*, which is the main configuration file used to call the required applet, regarding the Low-level initialization and the memories initialization. This file must be modified when the user wants to customize SAM-BA GUI according to the application hardware requirements, by adding additional window tab for example.
 - *lowlevelinit.tcl*, this file is used to call the low-level initialization applet. From this file the user is able to select what kind of clock configuration he has to use regarding the application.

2.6.1 Customized_board_example.tcl Description

This file is composed of several parts used

- to configure the hardware the applets has to address.
- to add the memory options to the Graphical User Interface.
- **CHIP Name**: Specifies the chip ID and configure some global parameters to make the applet able to check if the ongoing function is compliant with the chip.
- **BOARD Specific Parameters**: This part is used to provide some hardware arguments to the applet such as:
 - *extRamVdd*: Specifies the Power supply Voltage value for the external memory, to the applet.
 - *extRamType*: Specifies the external memory type to the applet.
 - *extRamDataBusWidth*: Specifies the external memory data bus width to the applet.
 - *extDDDRamModel*: Specifies the model of DDR used (this option is mainly used for common memories used across the Atmel Evaluation Kits).

```
#####
## BOARD SPECIFIC PARAMETERS
#####
namespace eval BOARD {
  variable sramSize          0x20000
  variable maxBootSize        65328
  # Default setting for DDRAM
  # Vdd Memory 1.8V = 0 / Vdd Memory 3.3V = 1
  variable extRamVdd 0
  # External SDRAM = 0 / External DDR2 = 1 / LPDDR = 2

  variable extRamType 1
  #!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!
  #For LPDDR change me here
  #variable extRamType 2
  #!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!
  # Set bus width (16 or 32)
  variable extRamDataBusWidth 16
  # DDRAM Model (0: MT47H64M16HR, 1: MT47H128M16RT
  variable extDDDRamModel 1

  # Note: DEVICE/ADDRESSES (A2, A1, A0): The A2, A1 or A0 pins are device address inputs
  # that are hardwired or left not connected for hardware compatibility with other AT24CXX
  # devices.
  # Modify 'eepromDeviceAddress' to meet the hardware connection.
  variable eepromDeviceAddress 0x51
}

set target(board) at91sama5d3x-ek

# Source procedures for compatibility with older SAM-BA versions
if { [ catch { source "$libPath(extLib)/common/functions.tcl" } errMsg ] } {
  if {$commandLineMode == 0} {
    tk_messageBox -title "File not found" -message "Function file not found:\n$errMsg" -type ok -icon error
  } else {
    puts "-E- Function file not found:\n$errMsg"
    puts "-E- Connection abort"
  }
}
```

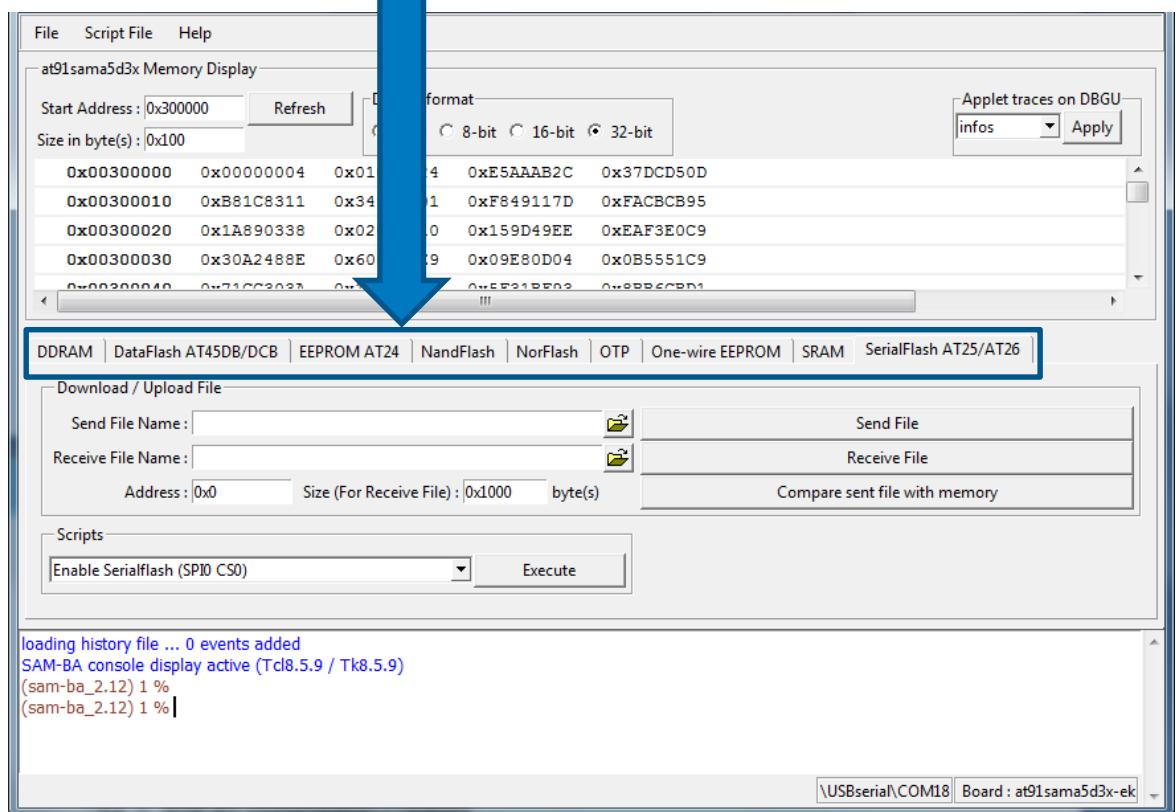
```

        exit
    }

    array set memoryAlgo {
        "SRAM"           ":::sama5d3x_sram"
        "DDRAM"          ":::sama5d3x_ddram"
        "SDMMC"          ":::sama5d3x_sdmmc"
        "DataFlash AT45DB/DCB"  ":::sama5d3x_dataflash"
        "SerialFlash AT25/AT26"  ":::sama5d3x_serialflash"
        "EEPROM AT24"    ":::sama5d3x_eeprom"
        "NandFlash"      ":::sama5d3x_nandflash"
        "NorFlash"       ":::sama5d3x_norflash"
        "OTP"            ":::sama5d3x_otp"
        "One-wire EEPROM"  ":::sama5d3x_ow"
        "DDR2 / SDRAM Map"  ":::sama5d3x_ddr2_sdram_map"
        "Peripheral"     ":::sama5d3x_peripheral"
        "ROM"            ":::sama5d3x_rom"
        "REMAP"          ":::sama5d3x_remap"
    }
}

```

Used for the GUI



In terms of customization it is important to check these parameters and make them fit with the final hardware. This will allow the applet to select the correct functions.

This will directly modify the SAM-BA GUI by adding or removing the dedicated window tab for each memories. Refer to Section [6.2 Add a New Memory Tab in the SAM-BA GUI Main Window](#).

- **Low Level Initialization:** This is the first applet called and it refers to the file “[LowLevel.tcl](#)”, see Section [2.6.2 LowLevel.tcl Description](#).

```

122  #####
123  ## Low Level Initialization
124  #####
125  if { [ catch { source "$libPath(extLib)/$target(board)/lowlevelinit.tcl" } errMsg ] } {

```

- **SRAM:** Specifies the address of the internal SRAM of the chip, the size and the script used to write or read the internal SRAM.

```
#####
## SRAM
#####
array set sama5d3x_sram {
    dftDisplay 1
    dftDefault 0
    dftAddress 0x00300000
    dftSize 0x10000
    dftSend "RAM::sendFile"
    dftReceive "RAM::receiveFile"
    dftScripts ""
}
```

The functions “*RAM::sendFile & RAM::receiveFile*” are implemented in the directory *sam-ba_2.14\tcl_lib\common* in the file *generic.tcl*.

If this file is opened, it can be understood how the function

- “send file” is managed using the `TCL_Write_Data` function which directly comes from the `AT91Boot_TCL.dll` file.
- “receive file” is managed using the `TCL_Read_Data` function which directly comes from the `AT91Boot_TCL.dll` file.
- **DDRAM:** This part is important to be considered in terms of the customization of SAM-BA. All the board parameters previously configured from the “BOARD Specific Parameters” will determine the final arguments sent to the applet mailbox in the *low_level_init.tcl* file.

```
#####
## DDRAM
#####
array set sama5d3x_ddram {
    dftDisplay 0
    dftDefault 0
    dftAddress 0x20000000
    dftSize "$GENERIC::memorySize"
    dftSend "RAM::sendFile"
    dftReceive "RAM::receiveFile"
    dftScripts "::sama5d3x_ddram_scripts"
}
if {$BOARD::extRamType == 1 || $BOARD::extRamType == 2} {
    set sama5d3x_ddram(dftDisplay) 1
}

set RAM::appletAddr 0x308000
set RAM::appletMailboxAddr 0x308004
set RAM::appletFileName "$libPath(extLib)/$target(board)/applet-extram-
sama5d3x.bin"
puts "-I- External RAM Settings : extRamVdd=$BOARD::extRamVdd, ext-
tRamType=$BOARD::extRamType, extRamDataBusWidth=$BOARD::extRamDataBusWidth, ext-
tDDDRamModel=$BOARD::extDDDRamModel"

array set sama5d3x_ddram_scripts {
    "Enable DDR2" "GENERIC::Init $RAM::appletAddr $RAM::appletMailboxAddr
$RAM::appletFileName [list $::target(comType) $::target(traceLevel) $BOARD::ext-
tRamVdd 1 $BOARD::extRamDataBusWidth $BOARD::extDDDRamModel]"
    "Enable LPDDR2" "GENERIC::Init $RAM::appletAddr $RAM::appletMailboxAddr
$RAM::appletFileName [list $::target(comType) $::target(traceLevel) $BOARD::ext-
tRamVdd 2 $BOARD::extRamDataBusWidth $BOARD::extDDDRamModel]"
}
```

```

# Initialize SDRAM/DDRAM
if {[catch {GENERIC::Init $RAM::appletAddr $RAM::appletMailboxAddr $RAM::appletFileName [list $::target(comType) $::target(traceLevel) $BOARD::extRamVdd $BOARD::extRamType $BOARD::extRamDataBusWidth $BOARD::extDDRamModel]} dummy_err] }
{
    set continue no
    if {$commandLineMode == 0} {
        set continue [tk_messageBox -title "External RAM init" -message "External RAM initialization failed.\nExternal RAM access is required to run applets.\nContinue anyway ?" -icon warning -type yesno]
    } else {
        puts "-E- Error during external RAM initialization."
        puts "-E- External RAM access is required to run applets."
        puts "-E- Connection abort"
    }
    # Close link
    if {$continue == no} {
        TCL_Close $target(handle)
        exit
    }
} else {
    puts "-I- External RAM initialized"
}

```

- **SERIALFLASH; DATAFLASH; EEPROM; One-Wire EEPROM; NANDFLASH; SDMMC; NORFLASH; OTP**; these parts are all composed of the same fields used to determine the graphical menu in the SAM-BA GUI for each memory. Example given for the **NANDFLASH**:

```

299 #####
300 ## NANDFLASH
301 #####
302 array set sama5d3x_nandflash {
303     dftDisplay 1
304     dftDefault 0
305     dftAddress 0x0
306     dftSize    "$GENERIC:memorySize"          Generic Scripts
307     dftSend    "GENERIC::SendFile"
308     dftReceive "GENERIC::ReceiveFile"
309     dftScripts "::sama5d3x_nandflash_scripts"
310 }
311
312 array set sama5d3x_nandflash_scripts {
313     "Enable NandFlash"           "NANDFLASH::Init"
314     "Pmecc configuration"       "NANDFLASH::NandHeaderValue"
315     "Enable OS PMECC parameters" "NANDFLASH::NandHeaderValue HEADER 0xc0902405"
316     "Send Boot File"           "NANDFLASH::SendBootFilePmecc"
317     "Erase All"                "NANDFLASH::EraseAll"
318     "Scrub NandFlash"          "NANDFLASH::EraseAll $NANDFLASH::scrubErase"
319     "List Bad Blocks"          "NANDFLASH::BadBlockList"
320 }
321
322 set NANDFLASH::appletAddr 0x20000000 Memory address and Applet location
323 set NANDFLASH::appletMailboxAddr 0x20000004
324 set NANDFLASH::appletFileName "$libPath(extLib)/$target(board)/applet-nandflash-sama5d3x.bin"

```

2.6.2 LowLevel.tcl Description

This file is used to call the low-level initialization applet.

In SAM-BA, there is a new feature, **Customize lowlevel**, which allows users to configure the Master Clock (MCK) of the target device in an easier way.

In each board specific folder, there is a tcl/tk script named *lowlevel.tcl*. The *<board>.tcl* will call a function, **LOWLEVEL::Init**, which is defined in *lowlevel.tcl*.

In *lowlevel.tcl*, the list *mainOsc(crystalList)* contains all available crystal frequencies of the device. Users can add a user-defined frequency to the list.

A dedicated applet, **lowlevelinit** applet, implements the low level initialization. Like other applets, the address, the mailbox address, and the applet name of this lowlevel applet are defined.

There are three key parameters transferred to the applet by SAM-BA.

```
set mainOsc(crystalList) [list \
    "12000000" ]

set mainOsc(initOsc) 0
set mainOsc(initXal) 12000000

namespace eval LOWLEVEL {

    variable appletAddr          0x308000
    variable appletMailboxAddr   0x308004
    variable appletFileName      "$libPath(extLib) /$target(board) /applet-lowlev-
elinit-sama5d3x.bin"
}
```

Mode specifies the mode of low level initialization.

- If **mode** is **EK_MODE**, the applet will call *EK_LowLevelInit()* to configure the target device just the same as EK does.
- If **mode** is **USER_DEFINED_CRYSTAL**, the applet will call *user_defined_LowlevelInit()* to configure the target device, which should be implemented by users. A selected frequency will be passed to this function as a parameter, named **crystalFreq**.
- If **mode** is **BYPASS_MODE**, the target device should be configured to be clocked by an external clock. Function *bypass_LowLevelInit()* should be implemented by users to complete the configuration. A specified frequency will be passed to this function as a parameter, named **extClk**.

CrystalFreq is the selected frequency of the crystal oscillator. The value of the frequency is one of those in the list *mainOsc(crystalList)*, which is defined in *lowlevel.tcl*. **CrystalFreq** is used by *user_defined_LowlevelInit()* when **mode** is **USER_DEFINED_CRYSTAL**.

ExtClk is the specified frequency of the external clock of the target device. The value of the frequency is specified by users in SAM-BA GUI. **ExtClk** is used by *bypass_LowLevelInit()* when **mode** is **BYPASS_MODE**.

```
proc LOWLEVEL::Init {} {

    global mainOsc
    global commandLineMode
    global target

    switch $mainOsc(mode) {
        bypassMode {
            set mode 2
        }
    }
}
```

```

        boardCrystalMode {
            set mode 1
        }

        default {
            set mode 0
        }
    }
}

```

If the user's board is mounted with a crystal of a frequency different from that on the EK board or the target device is clocked by an external clock, the function [user_defined_LowLevelInit\(\)](#) or [bypass_LowLevelInit\(\)](#) should be implemented in advance and the low-level applet needs to be re-compiled and replace the one in the board specific folder. For information on how to implement the low level initialization, refer to [EK_LowLevelInit\(\)](#), or refer to Section [7.2 Low Level Customization to Implement the Oscillator Bypass Mode](#).

Once the parameters set, the mailbox is ready to be sent to the applet containing all the parameters:

```

if {[catch {GENERIC::Init $LOWLEVEL::appletAddr $LOWLEVEL::appletMailboxAddr
$LOWLEVEL::appletFileName [list $::target(comType) $::target(traceLevel) $mode
$mainOsc(osc) $mainOsc(xal)]} dummy_err]} {
    set continue no
    if {$commandLineMode == 0} {
        set continue [tk_messageBox -title "Low level init" -message "Low
level initialization failed.\nLow level initialization is required to run ap-
plets.\nContinue anyway ?" -icon warning -type yesno]
    } else {
        puts "-E- Error during Low level initialization."
        puts "-E- Low level initialization is required to run applets."
        puts "-E- Connection abort!"
    }
    # Close link
    if {$continue == no} {
        TCL_Close $target(handle)
        exit
    }
} else {
    puts "-I- Low level initialized"
}
}

```

3 Software Prerequisites

This chapter describes how to install all the required software tools to compile the new applets, which must be done before starting a customization case.

3.1 Sourcery CodeBench Lite 2013.05-23 for ARM EABI

3.1.1 Introduction



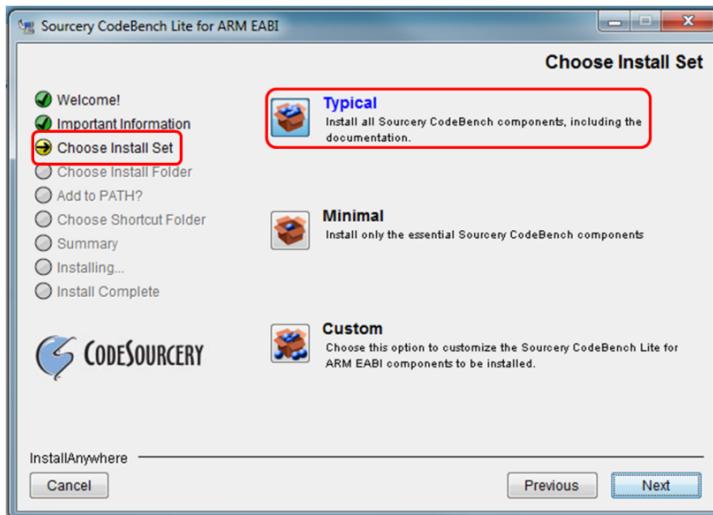
Sourcery G++ Lite for ARM EABI is intended for developers working on embedded applications or firmware for boards without an operating system, or that run an RTOS or boot loader. This Sourcery CodeBench™ configuration is not intended for Linux or µClinux™ kernel, or application development.

Download link:

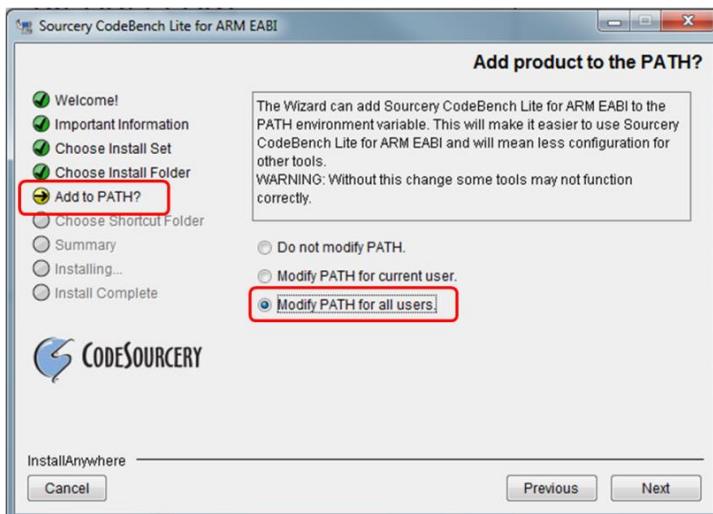
<http://www.mentor.com/embedded-software/sourcery-tools/sourcery-codebench/editions/lite-edition/>

3.1.2 Installation

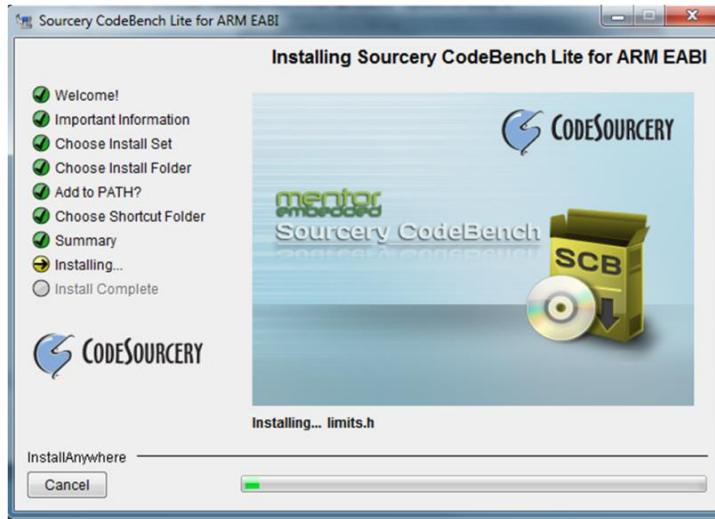
- Execute the [arm-2013.05-23-arm-none-eabi.exe](http://www.mentor.com/embedded-software/sourcery-tools/sourcery-codebench/editions/lite-edition/) file and follow the instructions:
 - Choose “*Typical*” option in step 3



- Choose “*Modify PATH for all users*” option in step 5



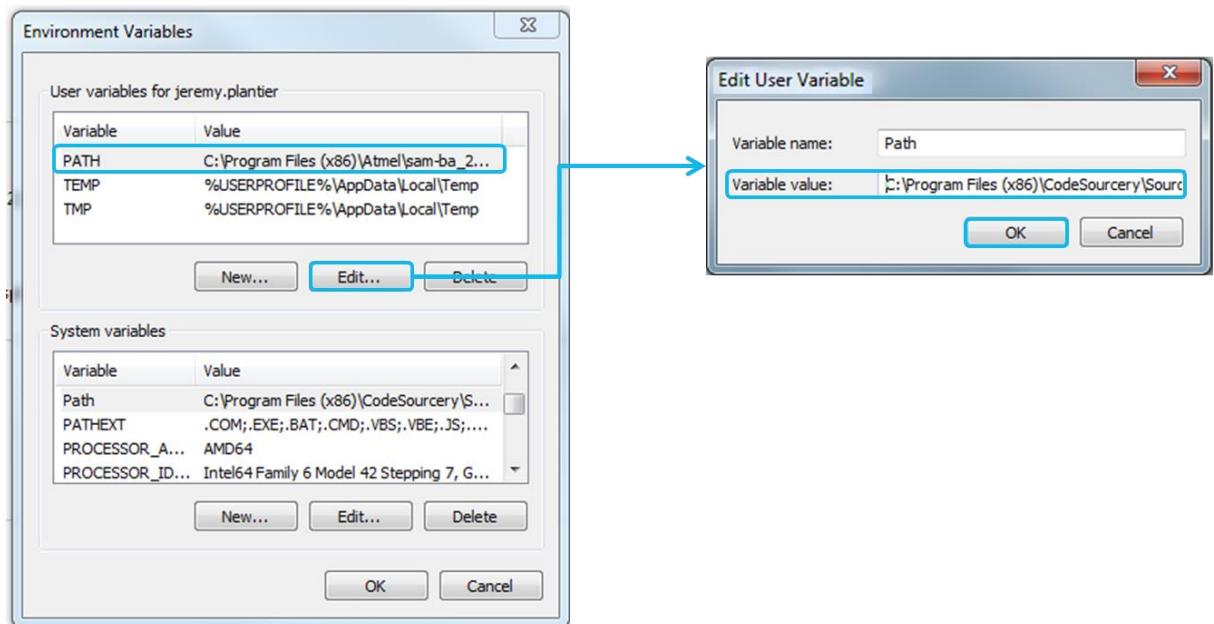
- Follow next instructions till the install process starts



- Press “*Done*” at the end of the install process
 - Once the installation process is finished, verify whether ARM EABI’s PATH environment variable has been correctly added in system:
 - Open a “*Command Prompt*” in Windows ([Start -> Accessories -> Command Prompt](#))
 - Type “`arm-none-eabi-gcc -v`” in command line to check the version number
 - The following results should be displayed:

If you cannot see this information, the install process did not correctly set the PATH variable during Code CodeBench Lite 2012.05-23 for ARM EABI installation.

- In this case, add the PATH variable manually as described:
 - Right click on (My) "Computer" -> Properties -> Advanced Systems Settings->Advanced -> Environment Variables -> User variables -> PATH"
 - Select the "PATH" user variables and click "Edit"
 - For Windows 32-bit OS users: add "C:\Program Files\CodeSourcery\Sourcery_CodeBench_Lite_for_ARM_EABI\bin" at the beginning of Variable value box.
 - For Windows 64-bit OS users: add "C:\Program Files (x86)\CodeSourcery\Sourcery_CodeBench_Lite_for_ARM_EABI\bin" at the beginning of Variable value box.



- Click “OK” to complete the setting
- Then click “OK” to close the Environment Variable Window and System properties window
- Open a new command prompt and enter “`arm-none-eabi-gcc -v`” to test again

Now Sourcery CodeBench Lite 2012.09-63 for ARM EABI should be correctly installed.

3.2 GNU Make 3.81

3.2.1 Introduction



Make is a tool which controls the generation of executables and other non-source files of a program from the program's source files.

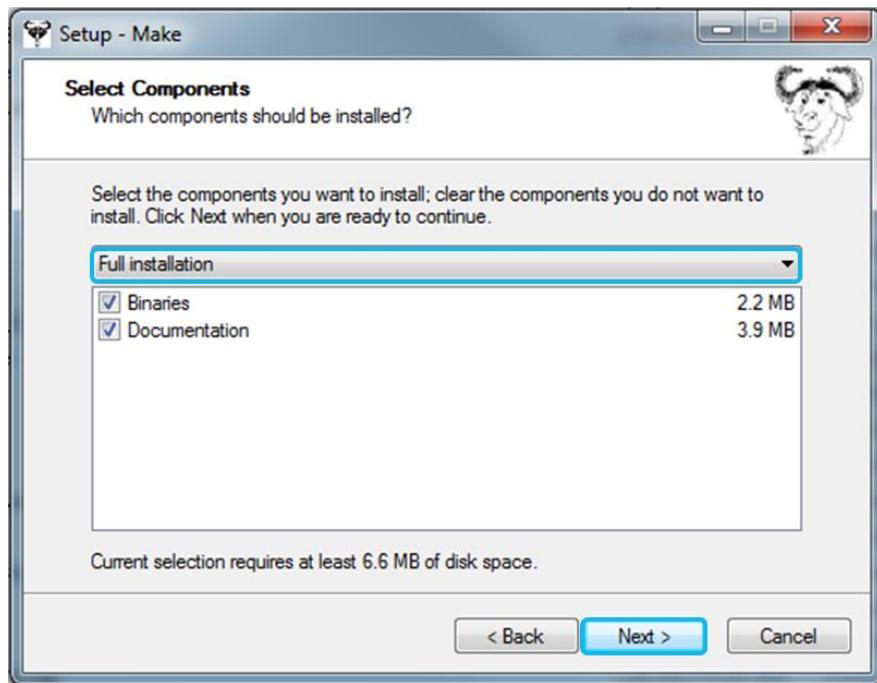
Make gets its knowledge of how to build your program from a file called the *makefile*, which lists each of the non-source files and how to compute it from other files. When you write a program, you should write a makefile for it, so that it is possible to use Make to build and install the program.

Download link:

<http://gnuwin32.sourceforge.net/packages/make.htm>

3.2.2 Installation

- Execute the `make-3.81.exe` file and follow the instructions:
 - Be sure that the “*Full installation*” options have been chosen during the installation process:



- Click on the “*next*” button till “*Finish*” to complete the installation
- Add cross compile environment path to windows:
 - Right click on (My) “*Computer* -> *Properties* -> *Advanced Systems Settings*->*Advanced* -> *Environment Variables* -> *User variables* -> *PATH*”
 - Select the “*PATH*” user variables and click “*Edit*”:
 - **For Windows 32-bit OS users:** add “*C:\Program Files\GnuWin32\bin*” at the beginning of Variable value box.
 - **For Windows 64-bit OS users:** add “*C:\Program Files (x86)\GnuWin32\bin*” at the beginning of Variable value box.
 - Click “*OK*” to complete setting
 - Check if “*GNU make*” PATH environment variable has been added:
 - Open a new “Command Prompt” in Windows (*Start* -> *Accessories* -> *Command Prompt*)
 - Input “*make -v*” in command line to check the version number
 - The following results should be displayed:

```
C:\>make -v
GNU Make 3.81
Copyright (C) 2006 Free Software Foundation, Inc.
This is free software; see the source for copying conditions.
There is NO warranty; not even for MERCHANTABILITY or FITNESS FOR A
PARTICULAR PURPOSE.

This program built for i386-pc-mingw32
C:\>
```

3.3 GNU Core Utils 5.3

3.3.1 Introduction

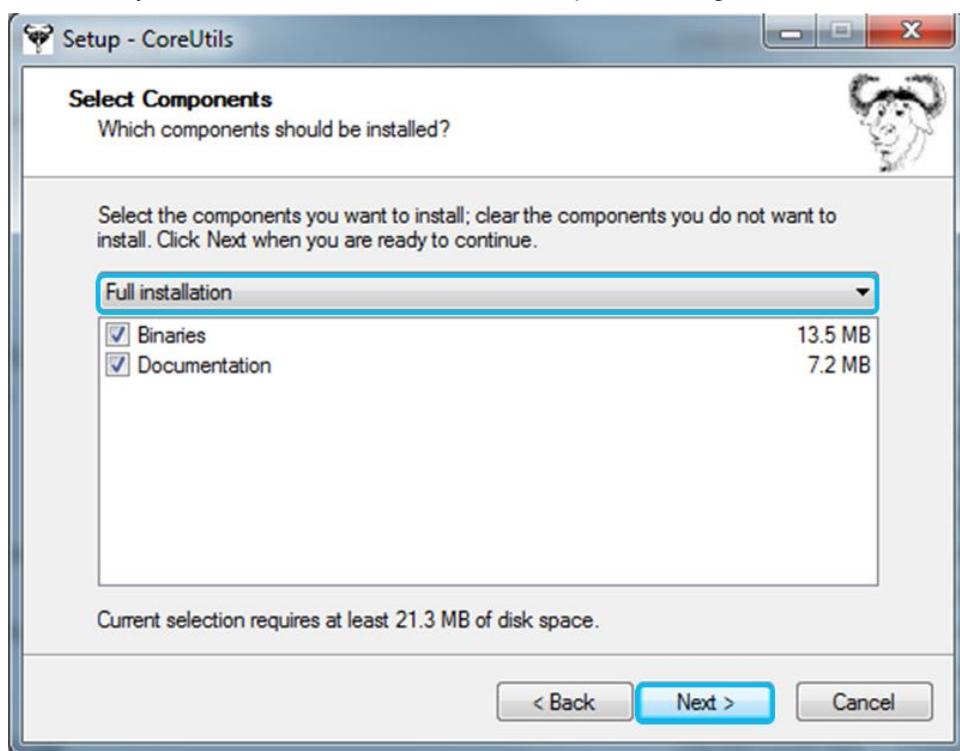
The GNU Core Utilities are the basic file, shell and text manipulation utilities of the GNU operating system. These are the core utilities which are expected to exist on every operating system. This tool package contains Linux tools like mkdir, rm, sh, touch, and more. It will be used by Makefile, which is used to compile the SAM-BA applets.

Download link:

<http://gnuwin32.sourceforge.net/packages/coreutils.htm>

3.3.2 Installation

- Execute the [coreutils-5.3.0.exe](#) and follow the instructions:
 - Make sure you have selected “*Full installation*” options during installation



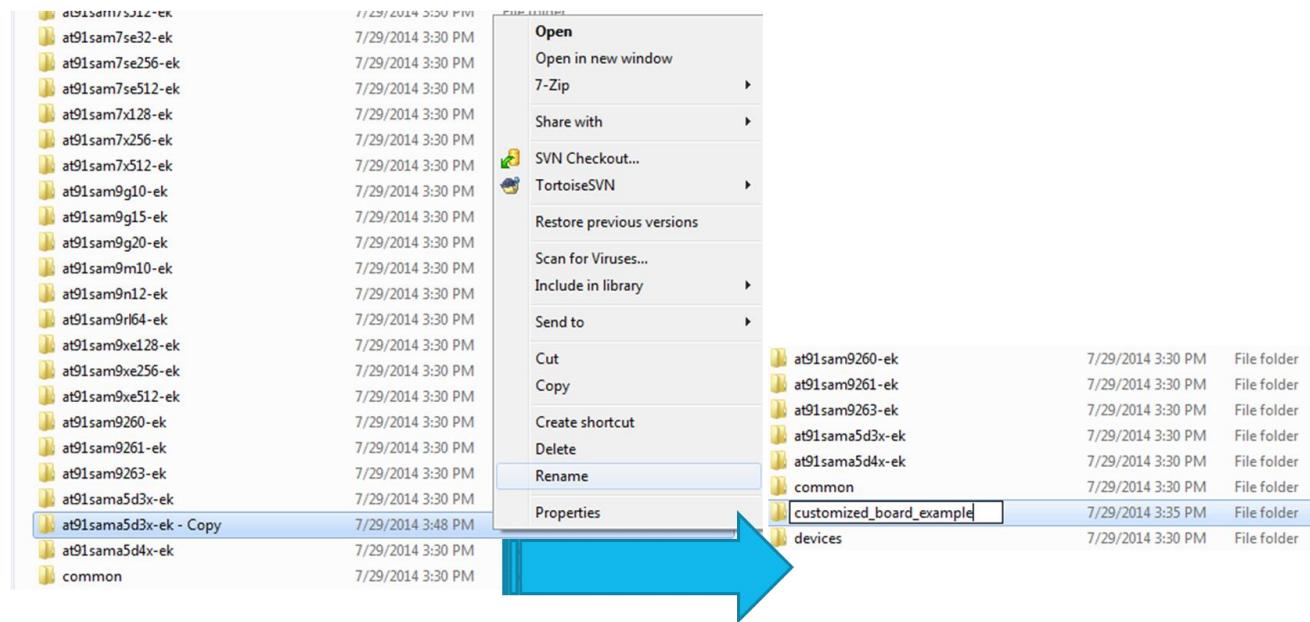
- Click on the “*next*” button till “*Finish*” to complete the installation

4 Customization Step 1: Duplicate an Existing Solution as a Base for the Customization

4.1 Duplicate the TCL Folder Organization from an Existing One

The best way to successfully implement a custom board is to keep the same folder organization, by copying one of the [AT91SAMxx-ek](#) and renaming it according to a new board name.

For instance, create a copy of the [at91sama5d3x](#) folder from [sam-ba_X.xx/tcl/lib](#) directory in the same folder and rename it into “[customized_board_example](#)” as described below:



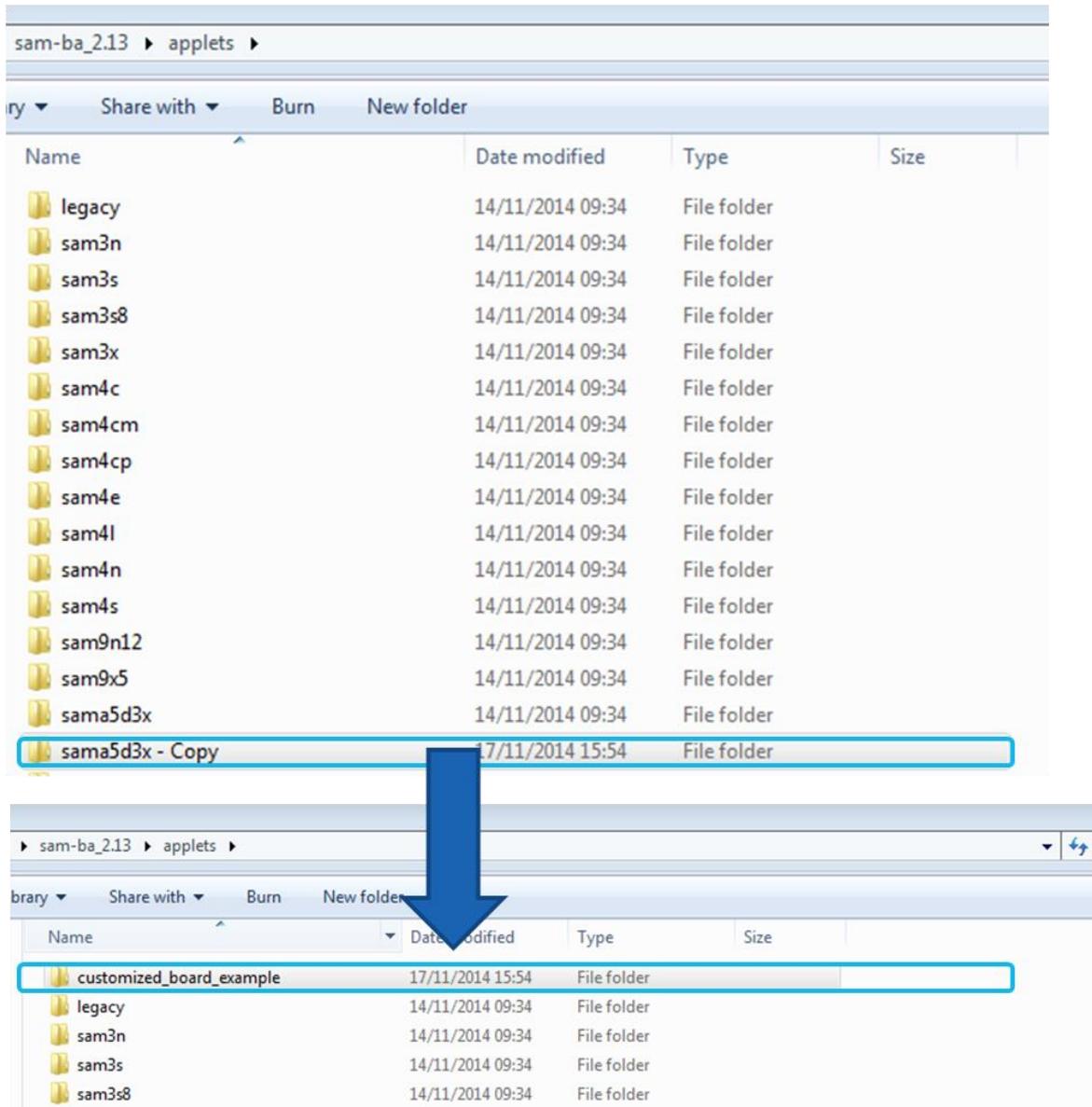
Then go into the new “[customized_board_example](#)” directory to rename the “[at91sama5d3x.tcl](#)” file into “[customized_board_example.tcl](#)”:

Name	Date modified	Type	Size
applet-dataflash-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	36 KB
applet-eeprom-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	31 KB
applet-extram-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	5 KB
applet-lowlevelinit-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	3 KB
applet-nandflash-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	68 KB
applet-norflash-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	39 KB
applet-otp-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	25 KB
applet-oweprom-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	31 KB
applet-sdmmc-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	60 KB
applet-serialflash-sama5d3x.bin	7/14/2014 8:45 AM	BIN File	40 KB
customized_board_example.tcl	5/26/2014 5:13 AM	TCL File	16 KB
lowlevelinit.tcl	6/27/2012 4:54 AM	TCL File	4 KB

As a result the “[customized_board_example](#)” board should appear from the SAM-BA GUI connection window as shown by the following picture:

4.2 Duplicate the Applet Folder Organization from an Existing One

Go in to the following directory: `\sam-ba_2.14\applets` and create a copy of the `sama5d3x` folder and rename it into “`customized_board_example`” as described:



Now the “`customized_board_example`” can reuse the whole applet source code of the one used for the `SAMA5D3x-ek`.

5 Customization Step 2: Add a New Custom Board to the Existing TCL Database

5.1 Add a New Board Entry

To add support for a new board, a new device entry must be added in the devices array at first. Adding a new board entry allows to add a new board instance in the drop-down menu of the SAM-BA startup screen.

For example, if users have their own boards with *SAMA5D3x* device; add alias *customized_board_example* in the original line for *SAMA5D3x* device.

5.1.1 Modify the “*boards.tcl*” File

The “*boards.tcl*” file is used to make SAM-BA able to load the corresponding applets of the specified board. As a consequence, a new entry must be added in the board array with an associated description file path. Then a dedicated directory must be created (see below).

The figure below shows that for each Atmel evaluation kit, a dedicated path is provided to SAM-BA allowing the dedicated applet to load correctly. The aim in this step is to reproduce this architecture for a custom example.



The file is located in the directory *C:\Program Files (x86)\Atmel\sam-ba_X.xx\tcl_lib*:

Open the *boards.tcl* file in a text editor with a syntax recognition (e.g.: Notepad++) and add a new board by adding a new entry in the “set boards” array ‘from code line #107) and the corresponding directory, as explained below:

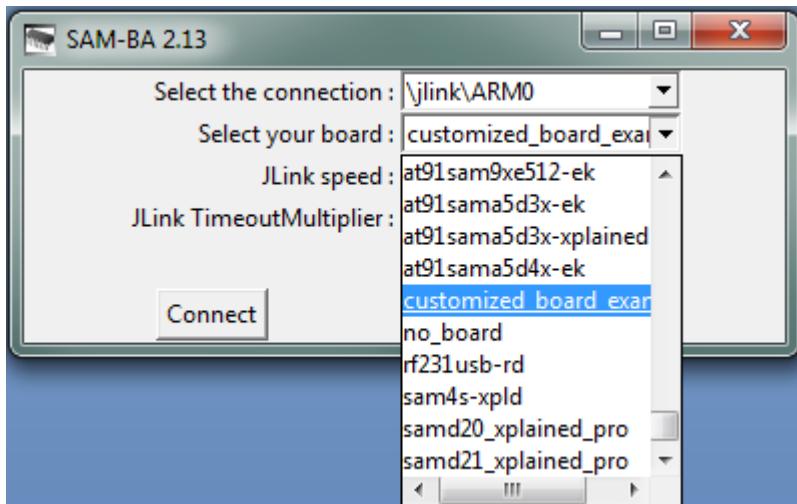
```
115
116
117
118
119
120
121
122
123
    "at91cap7-dk-mem33" "at91cap7-dk/at91cap7-dk-mem33.tcl"
    "at91cap7-stk"      "at91cap7-stk/at91cap7-stk.tcl"
    "at91sama5d3x-ek"  "at91sama5d3x-ek/at91sama5d3x-ek.tcl"
    "customized_board_example" "customized_board_example/customized_board_example.tcl"
    "at91sama5d3x-xplained" "at91sama5d3x-ek/at91sama5d3x-ek.tcl"
    "at91sama5d4x-ek"      "at91sama5d4x-ek/at91sama5d4x-ek.tcl"
    "no_board"             "no_board/no_board.tcl"
}
```



The directory must have the same name as the board. Take care that the text editor used is executed as administrator, otherwise saving files will fail.



To apply the previous modifications, SAM-BA GUI must be restarted if required.



Once the board is registered in the database, its functionality remains to be implemented through the applet customization. The previous implementation simply allows SAM-BA to be able to load the applets binaries file when a dedicated command is sent to SAM-BA GUI.

6 Customization Step 3: Customize the SAM-BA Graphical User Interface

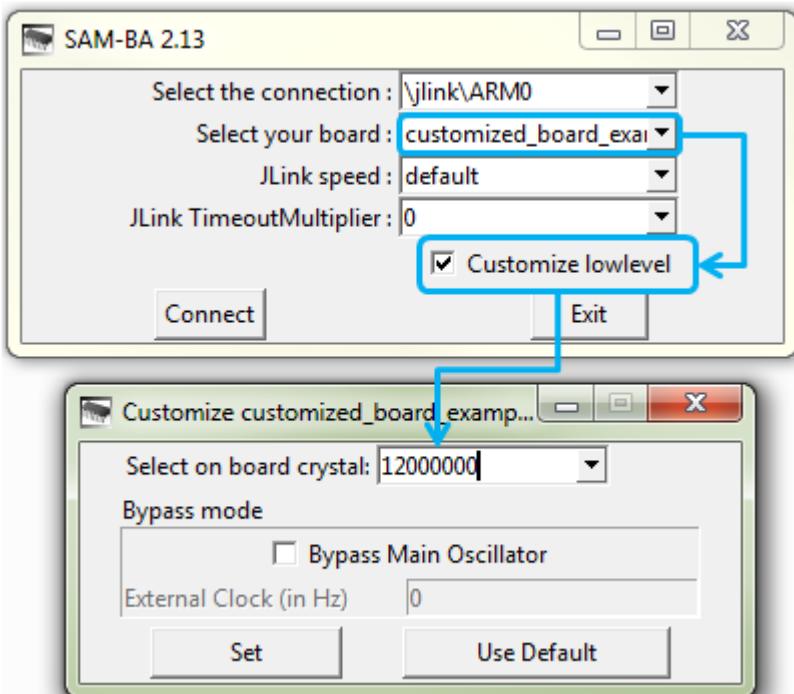
In this chapter, how to add / or to modify the SAM-GA GUI features is explained. The following two examples are targeted to be the most common part the users/customers are supposed to meet.

The first example is about how to customize TCL/TK script to add a new crystal value from the “*customize low level*” option of the SAM-BA GUI’s connection window.

The second example is about how to modify or to add a new memory tab to the SAM-BA GUI’s main window.

6.1 Add a New Crystal Value in SAM-BA GUI’s

From SAM-BA 2.11 and 2.12, a new option is available: “*Customize low level*” which allows users to configure the Master Clock (MCK) of the target device in an easier way, as for example for the *SAMA5D3x-ek* below:



In each board specific folder, there is a tcl/tk script named *lowlevel.tcl*. The *<board>.tcl* will call a command through SAM-BA, *LOWLEVEL::Init*, which is used in *lowlevel.tcl*.

In this step we will make the assumption that a different onboard crystal is used. As a consequence the main oscillator *low_level_init* function has to be modified to fit with the new hardware modifications. Therefore, the corresponding applet will be modified accordingly and recompiled.

Now, go to the directory *C:\Program Files (x86)\Atmel\sam-ba_2.12\tcl_lib\customized_board_example* and open the *lowlevelinit.tcl* file in a text editor. In this file the list *mainOsc(crystalList)* contains all available crystal frequencies of the device. Users can add a user-defined frequency to the list.

```
28
29  set mainOsc(crystalList) [list \
30    "12000000" ]
31
32  set mainOsc(initOsc) 0
33  set mainOsc(initXal) 12000000
```

For instance, from the SAMA5D3x product family datasheet available in the Resources\Datasheet folder, in the Electrical chapter, we can read that the main oscillator operating frequency is in the range 8MHz to 16MHz.

The list `mainOsc(crystalList)` must be modified in the `lowlevel.tcl` file located in the `C:\Program Files (x86)\Atmel\sam-ba_2.12\tcl_lib\customized_board_example` directory as in this example:

```

28
29     set mainOsc(crystalList) [list \
30         "80000000" "12000000" "16000000" ]
31

```

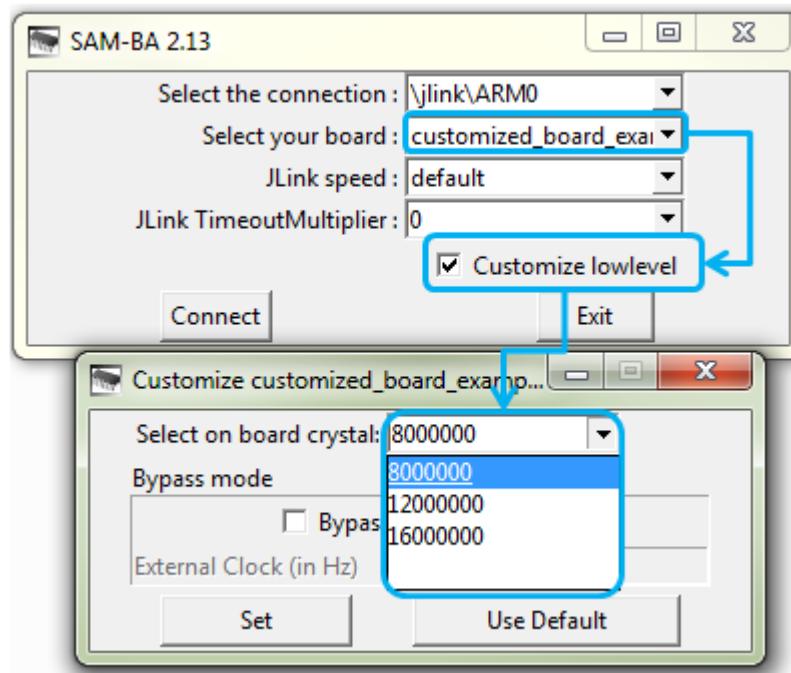
A dedicated applet, `lowlevelinit` applet, implements the low level initialization. Like other applets, the address, the mailbox address, and the applet name of this `lowlevel` applet are defined as described in the `lowlevel.tcl`:

```

35     namespace eval LOWLEVEL {
36
37         variable appletAddr      0x308000
38         variable appletMailboxAddr 0x308004
39         variable appletFileName   "$libPath(extLib) /$target(board) /applet-lowlevelinit-sama5d3x.bin"
40
41 }

```

Now, restart SAM-BA and click on the “*customize low level*” check box to see the modifications.



6.2 Add a New Memory Tab in the SAM-BA GUI Main Window

To add a new memory window tab in the SAM-BA GUI main window, the file “`customized_board_example`” has to be modified.

The `customized_board_example.tcl` file is located in the directory `\sam-ba_2.14\tcl_lib\customized_board_example`, and can be opened in a text editor.

In `customized_board_example.tcl`, the “`set memoryAlgo`” array contains all available window tabs corresponding to each memory on board. Users can add a new one by adding an instance to the “`set memoryAlgo`” array as described below.

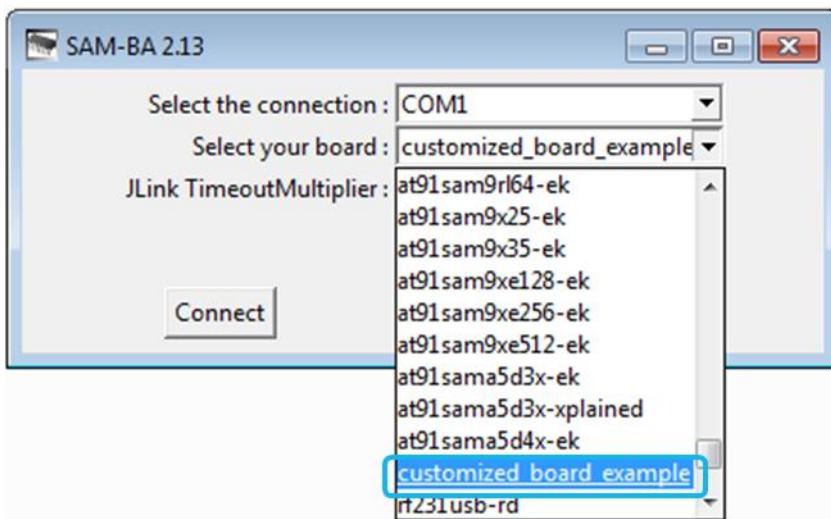
To add a new tab, modify the “`set memoryAlgo`” array in the `customized_board_example.tcl` file located in `\sam-ba_2.14\tcl_lib\customized_board_example` directory as explained below:

```

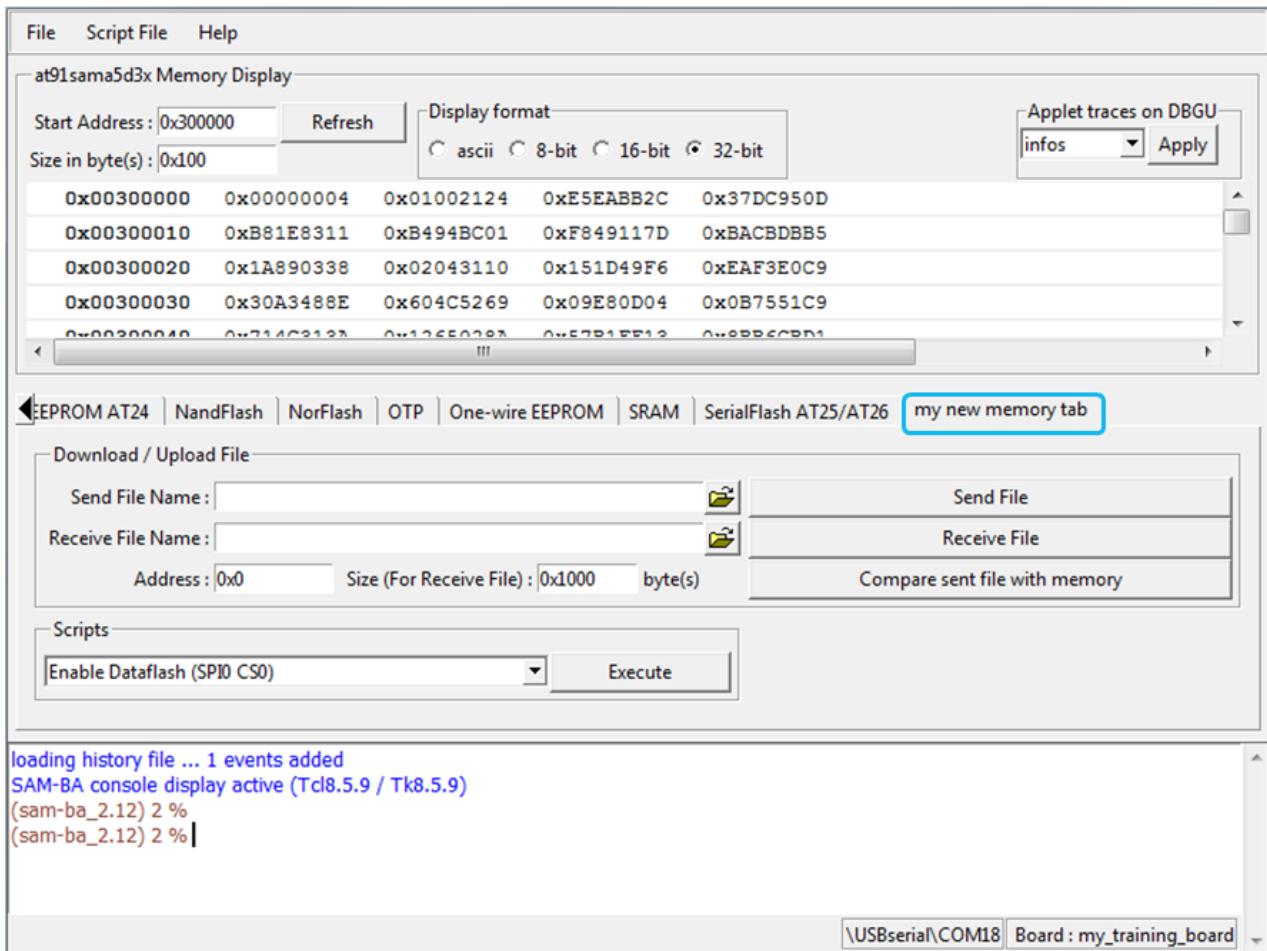
72  array set memoryAlgo {
73      "SRAM"           "::sama5d3x_sram"
74      "DDRAM"          "::sama5d3x_ddram"
75      "DataFlash AT45DB/DCB"  "::sama5d3x_dataflash"
76
77      "my new memory tab"  "::sama5d3x_dataflash"
78
79      "SerialFlash AT25/AT26"  "::sama5d3x_serialflash"
80      "EEPROM AT24"        "::sama5d3x_eeprom"
81      "NandFlash"          "::sama5d3x_nandflash"
82      "NorFlash"          "::sama5d3x_norflash"
83      "OTP"               "::sama5d3x_otp"
84      "One-wire EEPROM"   "::sama5d3x_ow"
85      "DDR2 / SDRAM Map"  "::sama5d3x_ddr2_sram_map"
86      "Peripheral"        "::sama5d3x_peripheral"
87      "ROM"               "::sama5d3x_rom"
88      "REMAP"             "::sama5d3x_remap"
89  }

```

To see your modification, restart SAM-BA GUI and select the “*customized_board_example.tcl*” from the “Select your board” dropdown menu:



The SAM-BA GUI main window should appear as follow:



As a result, the new memory tab appears.

7 Customization Step 5: Modify SAM-BA Applets to fit with a Custom Hardware

7.1 Customize Low-Level Initialization Applet

7.1.1 Simple Example

In this example, the `lowlevelinit.tcl` file is opened in a text editor; Go to the directory `\sam-ba_2.14\tcl_lib\customized_board_example` and reopen the `lowlevelinit.tcl` file in a text editor.

In the `LOWLEVEL::Init` procedure, from the code line #43, **Mode** specifies the mode of low level initialization.

- If **mode** is `EK_MODE`, the applet will call `EK_LowLevelInit()` to configure the target device just the same as EK does
- If **mode** is `USER_DEFINED_CRYSTAL`, the applet will call `user_defined_LowlevelInit()` to configure the target device, which should be implemented by the users. A selected frequency will be passed on to this function as a parameter, named `crystalFreq`.
- If **mode** is `BYPASS_MODE`, the target device should be configured to be clocked by an external clock. Function `bypass_LowLevelInit()` should be implemented by the users to complete the configuration. A specified frequency will be passed on to this function as a parameter, named `extClk`.

```
43 proc LOWLEVEL::Init {} {
44
45     global mainOsc
46     global commandLineMode
47     global target
48
49     switch $mainOsc(mode) {
50         bypassMode {
51             set mode 2
52         }
53
54         boardCrystalMode {
55             set mode 1
56         }
57
58         default {
59             set mode 0
60         }
61     }
}
```

We can see there that the tcl/tk script call a different function which directly depends on the selected mode from the SAM-BA GUI first window.

The parameters are sent to the applet by using this command line from the `lowlevelinit.tcl` tcl/tk script:

```
63 if {[catch {GENERIC::Init
64     $LOWLEVEL::appletAddr
65     $LOWLEVEL::appletMailboxAddr
66     $LOWLEVEL::appletFileName [list $::target(comType) $::target(traceLevel) $mode $mainOsc(osc) $mainOsc(xal)]} dummy_err]} {
```

The `lowlevelinit.tcl` tcl/tk script calls another tcl/tk script, `GENERIC::Init` which is used to extract the parameters to be sent to the applet.

This script can be found from the `\sam-ba_2.14\tcl_lib\common` directory by opening the `generic.tcl` file.

As a result go to the directory path:

`..\sam-ba_2.14\applets\my_training_board\sam-ba_applets\lowlevelinit` and open the `main.c` file in code line #170 to see the applet implementation, which depends on the selected mode from the `lowlevel.tcl` script:

```

170 int main(int argc, char **argv)
171 {
172     struct _Mailbox *pMailbox = (struct _Mailbox *) argv;
173     uint32_t mode, crystalFreq, extClk;
174     uint32_t comType = pMailbox->argument.inputInit.comType;
175     uint32_t baud_value;
176
177     /* -----
178     /* INIT:
179     /* -----
180     if (pMailbox->command == APPLET_CMD_INIT) {
181
182         mode = pMailbox->argument.inputInit.mode;
183         crystalFreq = pMailbox->argument.inputInit.crystalFreq;
184         extClk = pMailbox->argument.inputInit.extClk;
185
186         switch (mode) {
187             case EK_MODE:
188                 EK_LowLevelInit();
189                 pMailbox->status = APPLET_SUCCESS;
190
191                 break;
192             case USER_DEFINED_CRYSTAL:
193                 user_defined_LowlevelInit(crystalFreq);
194                 pMailbox->status = APPLET_SUCCESS;
195                 break;
196             case BYASS_MODE:
197                 bypass_LowLevelInit(extClk);
198                 pMailbox->status = APPLET_SUCCESS;
199                 break;
200             default:
201                 pMailbox->status = APPLET_DEV_UNKNOWN;
202                 break;
203             }
204         } else {
205             pMailbox->status = APPLET_DEV_UNKNOWN;
206         }
207     }

```

The cases “EK_MODE”, “USER_DEFINED_CRYSTAL” & “BYPASS” are well defined at the code line #43-45 and correspond to the different mode from the tcl/tk script.

CrystalFreq is the selected frequency of the crystal oscillator. The value of the frequency is one of those in the list `mainOsc(crystalList)`, which is defined in `lowlevel.tcl`. `CrystalFreq` used by `user_defined_LowlevelInit()` when the **mode** is `USER_DEFINED_CRYSTAL`.

ExtClk is the specified frequency of the external clock of the target device. The value of the frequency is specified by users in SAM-BA GUI. `Extclk` is used by `bypass_LowlevelInit()` when **mode** is `BYPASS_MODE`.

If user's board mounts a crystal of a frequency different from the one available on the EK board, or the target device is clocked by an external clock, the function `user_defined_LowlevelInit()` or `bypass_LowLevelInit()` should be implemented in advance and the `lowlevel` applet needs to be recompiled and should replace the one in the `C:\Program Files (x86)\Atmel\sam-ba_2.12\tcl_lib\my_training_board` folder.

In our case only the `user_defined_LowlevelInit()` will be implemented in this hands-on.

Before starting to implement the `user_defined_LowlevelInit()`, go to the `EK_LowLevelInit()` function (code line #149) declaration which is called in the case of the “`EK_MODE`”, and find some information about how to configure low level init such as main oscillator crystal frequency:

```

146  /**
147  * \brief Configure the PMC as EK setting
148  */
149  static void EK_LowLevelInit (void)
150  {
151  LowLevelInit();
152 }
```

`EK_LowLevelInit()` function calls the `LowLevelInit()` function which is included in the `board_lowlevel.c` file located in the `sam-ba_2.14\applets\my_training_board\libraries\libboard_sama5d3x-ek\sources` thanks to the command “`#include include/board_lowlevel.h`”.

Now that you understood interactions between tcl/tck scripts and applets, let's customize SAM-BA applets to the newly created board.

7.1.2 Adapt Existing Applets to the New Hardware

Now let's try to customize the SAM-BA applets to adapt them to new hardware. In this assignment, only the main oscillator configuration will be customized, but the process stays the same for other parameters such as for example PINOUT customization.

To do that, go to the `sam-ba_2.14\applets\my_training_board\libraries\libboard_sama5d3x-ek\source` directory and open the `board_lowlevel.c` file to see how the oscillator is initialized at low level initialization:

As the SAM-BA implementation is typically the same as the at91lib library used in the Atmel software package implementation, the entire libraries required to configure the chip and the board are available under the following path: `C:\Program Files (x86)\Atmel\sam-ba_2.12\applets\my_training_board\libraries`.

```

70 /**
71 * \brief Performs the low-level initialization of the chip.
72 * This includes EFC and master clock configuration.
73 * It also enable a low level on the pin NRST triggers a user reset.
74 */
75 extern WEAK void LowLevelInit( void )
76 {
77     uint32_t i;
78
79     /* DDR reset */
80     MPDDRC->MPDDRC_LPR = MPDDRC_LPR_LPCB_DEEP_PWD |MPDDRC_LPR_CLK_FR_ENABLED;
81
82     /* Disable DDR clock. */
83     PMC->PMC_PCDR1 |= (1 << (ID_MPDDRC-32));
84     PMC->PMC_SCDR |= PMC_SCER_DDRCK;
85
86     PMC_SelectExt12M_Osc();
87     PMC_SwitchMck2Main();
88     PMC_SetPllA( CKGR_PLLAR_STUCKTO1 |
89                  CKGR_PLLAR_PLLACOUNT(0x3F) |
90                  CKGR_PLLAR_OUTA(0x0) |
91                  CKGR_PLLAR_MULA(65) |
92                  CKGR_PLLAR_DIVA(1),
93                  0);
94     PMC_SetMckPllDiv(PMC_MCKR_PLLADIV2_DIV2);
95     PMC_SetMckPrescaler(PMC_MCKR_PRES_CLOCK);
96     PMC_SetMckDivider(PMC_MCKR_MDIV_PCK_DIV3);
97     PMC_SwitchMck2Pll();
98 }
```

Go to the `..sam-ba_2.14\applets\my_training_board\libraries\libchip_sama5d3x\source` directory, and open the `pmc.c` file to see the function implementations used to initialize the main oscillator.

Go back into the applet `main.c` file in `sam-ba_2.14\applets\my_training_board\sam-ba_applets\lowlevelinit folder`, go to the code line #133 and modify the “`user_defined_LowLevelInit()`” function to implement correctly the crystal frequency values:

```
129  /***
130  * \brief Configure the PMC if the frequency of the external oscillator is different from the one mounted on EK
131  * \param crystalFreq The frequency of the external oscillator
132  */
133  static void user_defined_LowlevelInit (uint32_t crystalFreq)
134  {
135  }
```

As we use the SAMA5D3x-EK board as example, the onboard XTAL remains the same 12MHz. But the `lowlevelinit()` function must be re implemented from the `user_defined_LowlevelInit()` to recompile the applet and to use the customize lowlevel menu from the SAM-BA GUI.

- Add the following code lines (in red) in `user_defined_LowlevelInit()` and the definition (in red too) just above that function:

```
/* Define the User customization led */
#define LED_TEST (1 << 24)

static void user_defined_LowlevelInit (uint32_t crystalFreq)
{
    LowLevelInit();
    PMC_EnablePeripheral(ID_PIOE);
    PIOE->PIO_PER  = LED_TEST;
    PIOE->PIO_OER  = LED_TEST;
    PIOE->PIO_SODR = LED_TEST;
}
```

The above codes lines have been added to confirm through a LED blinking, that the customization has worked.

- Save your modifications

The applet customization is now finished. The applet is ready to be compiled.



Refer to the last step of customization to have more details on how to compile an applet.

As a result, once compiled and if you are using the SAMA5D3x EK board, you should get the LED lit as described:

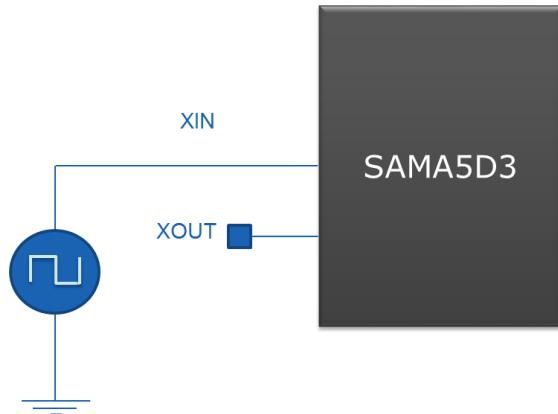


7.2 Low Level Customization to Implement the Oscillator Bypass Mode

7.2.1 Bypass Mode Overview

As described in the product datasheet and detailed in [Figure 7-1](#), it is possible for the user to directly connect an external clock source on the XIN pin. The only constraint of that is to have clock signal which must comply with the following characteristics:

Figure 7-1. Bypass Mode Representation



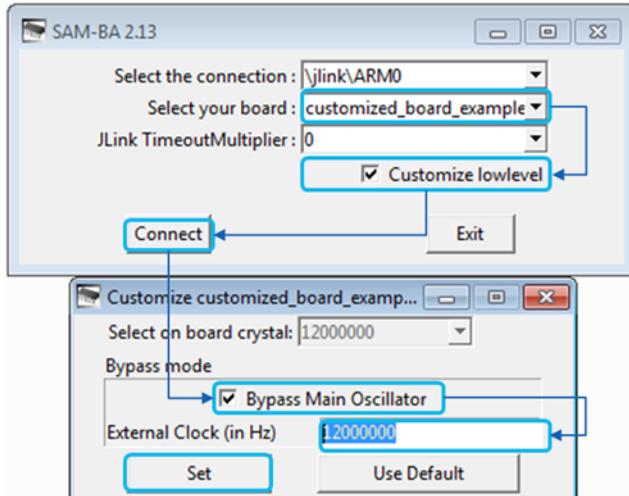
Symbol	Parameter	Conditions	Min.	Max.	Unit
$1/(t_{CPXIN})$	XIN clock frequency	-	-	50	MHz
t_{CPXIN}	XIN clock period	-	20	-	ns
t_{CHXIN}	XIN clock half half-period	-	$0.4 \times t_{CPXIN}$	$0.6 \times t_{CPXIN}$	
t_{CLXIN}	XIN clock low half-period	-	$0.4 \times t_{CPXIN}$	$0.6 \times t_{CPXIN}$	
C_{IN}	XIN input capacitance	(1)	-	25	pF
R_{IN}	XIN pulldown resistor	(1)	-	500	kΩ
V_{IN}	XIN voltage	(1)	VDDOSC	VDDOSC	V

Note: 1. These characteristics apply only when the main oscillator is in bypass mode (i.e., when MOSCEN = 0 and OSCBYPASS = 1) in the CKGR_MOR. See “PMC Clock Generator Main Oscillator Register” in the PMC section of the product datasheet.

This mode is called “Bypass mode”, because the main crystal oscillator is bypassed letting the external clock source acting as the main clock of the chip.

Once implemented in hardware, users who want to establish a connection with their hardware using SAM-BA, have to customize the [low level init](#) applet. This will make it possible for the user to enter the frequency of their system, directly through the bypass menu from [SAM-BA GUI](#) as described below:

Figure 7-2. SAM GUI Bypass Menu



Still from the `.\sam-ba_2.14\applets\my_training_board\sam-ba_applets\lowlevelinit`, open the `main.c` file at the code line #170 to see the applet implementation which depends on the selected mode from the `lowlevel.tcl` script:

```

170 int main(int argc, char **argv)
171 {
172     struct _Mailbox *pMailbox = (struct _Mailbox *) argv;
173     uint32_t mode, crystalFreq, extClk;
174     uint32_t comType = pMailbox->argument.inputInit.comType;
175     uint32_t baud_value;
176
177     /* -----
178     /* INIT:
179     /* -----
180     if (pMailbox->command == APPLET_CMD_INIT) {
181
182         mode = pMailbox->argument.inputInit.mode;
183         crystalFreq = pMailbox->argument.inputInit.crystalFreq;
184         extClk = pMailbox->argument.inputInit.extClk;
185
186         switch (mode) {
187             case EK_MODE:
188                 EK_LowLevelInit();
189                 pMailbox->status = APPLET_SUCCESS;
190
191                 break;
192             case USER_DEFINED_CRYSTAL:
193                 user_defined_LowlevelInit(crystalFreq);
194                 pMailbox->status = APPLET_SUCCESS;
195                 break;
196             case BYASS_MODE:
197                 bypass_LowLevelInit(extClk);
198                 pMailbox->status = APPLET_SUCCESS;
199                 break;
200             default:
201                 pMailbox->status = APPLET_DEV_UNKNOWN;
202                 break;
203         }
204     } else {
205         pMailbox->status = APPLET_DEV_UNKNOWN;
206     }
207 }
```

If `mode` is `BYASS_MODE`, the target device should be configured to be clocked by an external clock. The function `bypass_LowLevelInit()` should be implemented by the user to complete the configuration. A specified frequency will be passed to this function as a parameter, named `extClk`.

The `bypass_LowLevelInit()` function is defined in the `main.c` file located in the `sam-ba_2.14\applets\customized_board_example\sam-ba_applets\lowlevelinit` as described:

```
137  /**
138  * \brief Configure the PMC in bypass mode. An external clock should be input to XIN as the source clock.
139  *
140  * \param extClk The frequency of the external clock
141  */
142  static void bypass_LowLevelInit (uint32_t extClk)
143  {
144 }
```

7.2.2 Summary of the Different Steps to Perform

Before starting the code implementation, the user must:

- know exactly what are the initial clock settings applied to the chip during the first level boot loader
- know exactly how to configure another clock source to be switched on the Master clock
- define the Bypass function flow diagram required
- implement the code and recompile the applet

7.2.3 Step 1: Understanding the Initial Clock Setting During the Boot ROM

Before starting to implement the customization, the user has to refer to the product datasheet to understand exactly what are the initial conditions applied to the chip during the first boot level.

Refer to the [product datasheet](#) (SAMA5D3 Series), chapter “[Standard Boot Strategies](#)”, section “[Chip Setup](#)”, steps 2 and 3.

At boot startup, the processor clock (PCK) and the master clock (MCK) source is the 12MHz fast RC oscillator. Initialization follows the steps described below:

1. [Stack Setup](#) for ARM supervisor mode.
2. [Main Oscillator Detection](#): The Main Clock is switched to the 32kHz RC oscillator to allow external clock frequency to be measured. Then the Main Oscillator is enabled and set in the bypass mode. If the MOSCSELS bit rises, an external clock is connected and the next step is Main Clock Selection (3). If not, the bypass mode is cleared to attempt external quartz detection. This detection is successful when the MOSCXTS and MOSCSELS bits rise, else the internal 12MHz fast RC oscillator is used as the Main Clock.
3. [Main Clock Selection](#): The Master Clock source is switched from the Slow Clock to the Main Oscillator without prescaler. The PMC Status Register is polled to wait for MCK Ready. PCK and MCK are now the Main Clock.
4. [C Variable Initialization](#): Non zero-initialized data is initialized in the RAM (copy from ROM to RAM). Zero-initialized data is set to 0 in the RAM.
5. [PLLA Initialization](#): PLLA is configured to get a PCK at 96MHz and an MCK at 48MHz. If an external clock or crystal frequency running at 12MHz is found, then the PLLA is configured to allow communication on the USB link for the SAM-BA Monitor; else the Main Clock is switched to the internal 12MHz fast RC oscillator, but the USB will not be activated.

7.2.4 Step 2: Understanding the Clock Switching Mechanism

The other information to understand are the different block diagrams of the Clock Generator and the Power Management Controller:

Figure 7-3. Clock Generator Block Diagram

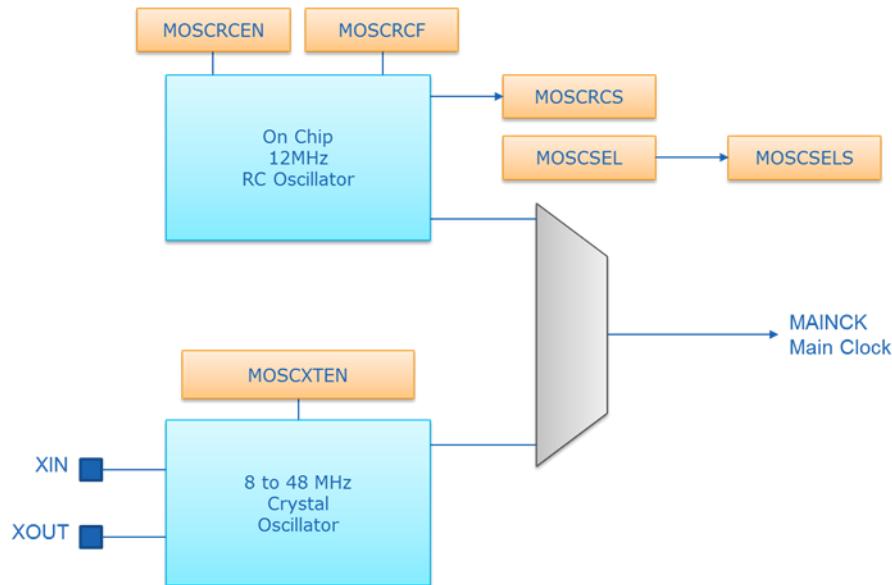
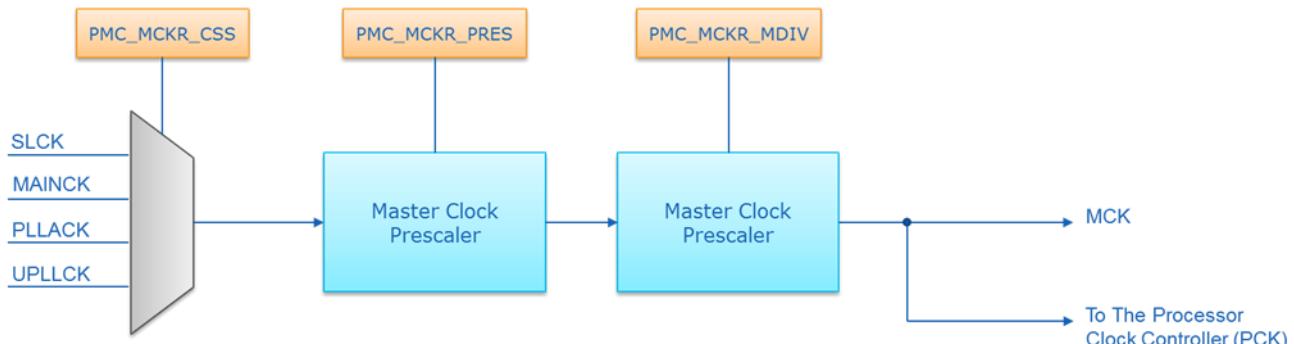


Figure 7-4. Master Clock Controller



From these block diagrams and taking into account that when the chip boots up from the ROM code and the chip initializes as explained in the product datasheet, the program flow has to be determined before starting the code implementation.

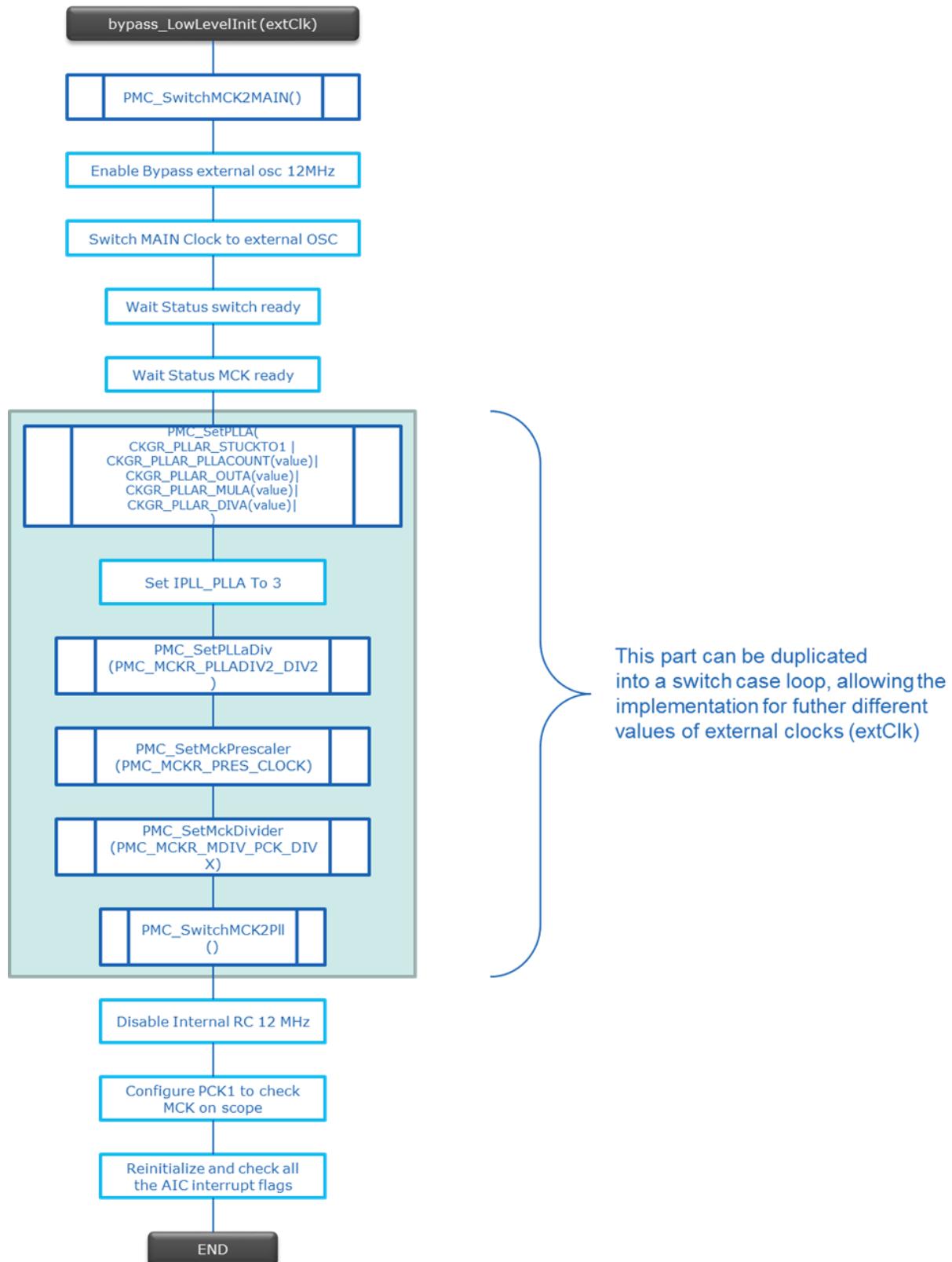
Summary of what the product datasheet says in terms of clock initialization:

"The main Clock is switched to the 32kHz RC oscillator to allow external clock frequency to be measured. Then the Main Oscillator is enabled and set in the bypass mode. If the MOSCSELS bit rises, an external clock is connected, and the next step is Main Clock Selection (3). The Master Clock source is switched from the Slow Clock to the Main Oscillator without prescaler. The PMC Status Register is polled to wait for MCK Ready. PCK and MCK are now the Main Clock."

PLLA is configured to get a PCK at 96MHz and an MCK at 48MHz. If an external clock or crystal frequency running at 12MHz is found, then the PLLA is configured to allow communication on the USB link for the SAM-BA Monitor; else the Main Clock is switched to the internal 12MHz fast RC oscillator, but USB will not be activated."

7.2.5 Step 3: Defining the Bypass Mode Program Flow

Figure 7-5. Bypass Mode Program Flow



7.2.6 Step 4: Bypass Mode Code Implementation

- The `bypass_LowLevelInit()` function prototype is defined in the `main.c` file located in the `sam-ba_2.14\applets\customized_board_example\sam-ba_applets\lowlevelinit`. The user has to complete this function to easily implement the bypass mode.

```
/** 
 * \brief Configure the PMC in bypass mode. An external clock should be input to XIN as the source clock.
 *
 * \param extClk The frequency of the external clock
 */
static void bypass_LowLevelInit (uint32_t extClk)
{}
```

- `PMC_SwitchMCK2MAIN()`: This function is already defined in the chip library located to the folder `lsam-ba_2.14\applets\customized_board_example\libraries\libchip_sama5d3x\source\pmc.c`.

```
static void bypass_LowLevelInit (uint32_t extClk)
{
    /* First Switch the MCK to the main clock oscillator */
    PMC_SwitchMck2Main();
```

- Enable Bypass external oscillator 12MHz

```
/* enable external OSC 12 MHz bypass */
PMC->CKGR_MOR = (PMC->CKGR_MOR | CKGR_MOR_MOSCXTBY) | CKGR_MOR_KEY(0x37);
```

- Switch MAIN Clock to external OSC

```
/* switch MAIN clock to external OSC */
PMC->CKGR_MOR |= CKGR_MOR_MOSCSEL | CKGR_MOR_KEY(0x37);
```

- Wait Status switch ready

```
/* wait MAIN clock status change for external OSC 12 MHz selection*/
while(!(PMC->PMC_SR & PMC_SR_MOSCSELS));
```

- Wait Status MCK ready

```
/* in case where MCK is running on MAIN CLK */
while(!(PMC->PMC_SR & PMC_SR_MCKRDY));
```

- `PMC_SetPLLA()`: This function is already defined in the chip library located to the folder `lsam-ba_2.14\applets\customized_board_example\libraries\libchip_sama5d3x\source\pmc.c`

```
/** 
 *      The PLLA configuration will depend on the extClk value which represents the frequency of the external clock signal.
 *      In this case we have to configure for any value to have the PLLA well configured.
 *      As a reminder of the PLL electrical characteristics:
 *      - Fout (the output frequency) must be in a range between 400 MHz and 800MHz (in worst case)
 *      - Fin (the input Frequency) must be in a range between 8MHz and 50 MHz
 *      - t (start-up time) must be in a range between 25 us and 100 us.
 */
switch (extClk) {
    /* When external clock frequency is 12MHz */
    case 12000000:
    /*
     * The next lines are used to configure the PLLA:
```

```

* CKGR_PLLAR_STUCKT01 must be set to 1 (Bit 29 must always be set to 1 when programming the CKGR_PLLAR.)
* CKGR_PLLAR_PLLACOUNT(value) is the number of slow clock cycles before the LOCKA bit is set in PMC_SR after
CKGR_PLLAR is written.
* CKGR_PLLAR_OUTA(value) has To be programmed to 0.
* CKGR_PLLAR_MULA(value)//0 the PLLA is disabled, 1 up to 127: The PLLA Clock frequency is the PLLA input
frequency multiplied by MULA + 1.In this case: 12*(65+1)= 792 MHz.
* CKGR_PLLAR_DIVA(value) :PLLA divider: DIVA=1 divider is bypassed
*refer to the function PMC_SetPl1A(uint32_t pll, uint32_t cpcr) from the pmc.c file, but this resets the
PMC_PLLICPR register
*/
PMC_SetPl1A(
    CKGR_PLLAR_STUCKT01 |
    CKGR_PLLAR_PLLACOUNT(0x3F) |
    CKGR_PLLAR_OUTA(0x0) |
    CKGR_PLLAR_MULA(65) |
    CKGR_PLLAR_DIVA(1),
    0);

```

- Set IPLL_PLLA To 3

```

/*refer to the 27.14.20 PLL Charge Pump Current Register paragraph of the product datasheet, IPLL_PLLA: Engi-
neering Configuration PLL ==> Should be written to 3.*/
PMC->PMC_PLLICPR = (0x3u << 8);

```

- *PMC_SetPLLaDiv ()*: This function is already defined in the chip library located to the folder `\sama_2.14\applets\customized_board_example\libraries\libchip_sama5d3x\source\pmc.c`

```

/* Bit PLLADIV2 must always be set to 1 when MDIV is set to 3. In this case 792/2 = 396MHz*/
PMC_SetMckPl1aDiv(PMC_MCKR_PLLADIV2_DIV2);

```

- *PMC_SetMckPrescaler ()*: This function is already defined in the chip library located to the folder `\sama_2.14\applets\customized_board_example\libraries\libchip_sama5d3x\source\pmc.c`

```

/* Selected clock without prescaler on the master clock */
PMC_SetMckPrescaler(PMC_MCKR_PRES_CLOCK);

```

- *PMC_SetMckDivider ()*: This function is already defined in the chip library located to the folder `\sama_2.14\applets\customized_board_example\libraries\libchip_sama5d3x\source\pmc.c`

```

/*refer to the 27.14.20 PLL Charge Pump Current Register paragraph of the product datasheet, IPLL_PLLA: Engi-
neering Configuration PLL ==> Should be written to 3.*/
PMC->PMC_PLLICPR = (0x3u << 8);

```

- *PMC_SwitchMCK2Pll ()*: This function is already defined in the chip library located to the folder `\sama_2.14\applets\customized_board_example\libraries\libchip_sama5d3x\source\pmc.c`

```

/*refer to the 27.14.20 PLL Charge Pump Current Register paragraph of the product datasheet, IPLL_PLLA: Engi-
neering Configuration PLL ==> Should be written to 3.*/
PMC->PMC_PLLICPR = (0x3u << 8);
break;
default:
break;
} // switch case closed

```

- Disable Internal RC 12MHz

```

/**
 *The next step is optional but useful if user wants to reduce the overall power consumption

```

```
 */
/* disable internal RC 12 MHz*/
PMC->CKGR_MOR = (PMC->CKGR_MOR & ~CKGR_MOR_MOSRCEN) | CKGR_MOR_KEY(0x37);
```

- Configure PCK1 to check MCK on scope

```
/*
 *The next step is optional but useful to check on scope if the MCK is correctly configured through
PCK1 (PD31)
*/

/* Configure PCK1 to measure MCK */
PIO->PIO_IDR = (1<<31);                                //Disable Interrupt on PD31
//abcdsr = PIO->PIO_ABCDSR[0];
PIO->PIO_ABCDSR[0] |= (1<<31);                         //enable the Peripheral B function which is PCK1
//abcdsr = PIO->PIO_ABCDSR[1];
PIO->PIO_ABCDSR[1] &= ~(1<<31);                      //enable the Peripheral B function which is PCK1
PIO->PIO_PDR = (1<<31);

/* Disable programmable clock 1 output */
REG_PMC_SCDR = PMC_SCDR_PCK1;                           //Disable the PCK1 output before using it
/* Enable the DAC master clock */
PMC->PMC_PCK[1] = PMC_PCK_CSS_MCK_CLK | PMC_PCK_PRES_CLOCK; // Select the master clock (MCK) to connect it to the
PCK1 without prescaler.
/* Enable programmable clock 1 output */
REG_PMC_SCER = PMC_SCER_PCK1;                           //Enable the PCK1 output before using it
/* Wait for the PCKRDY1 bit to be set in the PMC_SR register*/
while ((REG_PMC_SR & PMC_SR_PCKRDY1) == 0);
```

- Reinitialize and check all the AIC interrupt flags

```
/*
 *The next step is mandatory to be sure that no interrupt will hit during the communication with
SAM-BA
*/

/* select FIQ */
AIC->AIC_SSR = 0;
AIC->AIC_SVR = (unsigned int) defaultFiqHandler;

for (i = 1; i < 31; i++)
{
    AIC->AIC_SSR = i;
    AIC->AIC_SVR = (unsigned int) defaultIrqHandler;
}

AIC->AIC_SPU = (unsigned int) defaultSpuriousHandler;

/* Disable all interrupts */
for (i = 1; i < 31; i++)
{
    AIC->AIC_SSR = i;
    AIC->AIC_IDCR = 1 ;
}
/* Clear All pending interrupts flags */
for (i = 1; i < 31; i++)
{
    AIC->AIC_SSR = i;
    AIC->AIC_ICCR = 1 ;
}
/* Perform 8 IT acknowledge (write any value in EOICR) */
for (i = 0; i < 8 ; i++)
{
    AIC->AIC_EOICR = 0;
}
```

A finished and fully implemented code is provided in [Appendix A](#). This code provides the ability to select several different frequencies as external input clock.

7.3 Customize an External Memory Applet

The most frequent customization required is when users decide to change the external RAM or the NAND Flash device of their system. This section/subsections explains the main steps to perform to be able to customize the different kinds of memories. As the customization is to modify existing applets only, this method is an introduction for how to identify the main files to be modified and their related locations.

7.3.1 External Memory Customization Process Overview

Because the existing applet already provides the main initialization sequence used to send these parameters to the external memory, the main goal is to modify this existing applet, making it compliant with the new external RAM characteristics. Whatever the external RAM memory is, the main functions/parameters to take care are summarized in [Table 7-1](#).

Table 7-1. Customization Table

Parameter's name/function	Filename	Directory	Functionality
TCL scripts			
variable extRamVdd	customized_board_example.tcl	sam-ba_2.14\tcl_lib\customized_board_example\	External Ram Memory Power Supply Voltage (1.8V or 3.3V)
variable extRamType	customized_board_example.tcl	sam-ba_2.14\tcl_lib\customized_board_example\	External Ram Memory Type (SDRAM, DDR, DDR2, LPDDR, LPDDR2)
variable extRamDataBusWidth	customized_board_example.tcl	sam-ba_2.14\tcl_lib\customized_board_example\	External Ram Memory Data Bus Width (16-bit or 32-bit)
variable extDDRamModel	customized_board_example.tcl	sam-ba_2.14\tcl_lib\customized_board_example\	External Ram Memory Model (usually refers to devices used with Atmel evaluation kits)
SDR/DDR initialization Applet file			
Definition #define BOARD_SDRAM_SIZE	main.c	sam-ba_2.14\applets\customized_board_exam- ple\sam-ba_applets\extram\	Board DDRAM size
Definition #define SDRAM 0 #define DDRAM 1 #define LPDDR 2	main.c	sam-ba_2.14\applets\customized_board_exam- ple\sam-ba_applets\extram\	DDRAM type
Function Implementation Library file SDR/DDR initialization			
Function void BOARD_ConfigureDdram (uint8_t device)	board_memories.c	sam-ba_2.14\applets\customized_board_exam- ple\libraries\libboard_sama5d3x-ek\source\	Configures DDR
Function void BOARD_Config- ureLpDdram (void)	board_memories.c	sam-ba_2.14\applets\customized_board_exam- ple\libraries\libboard_sama5d3x-ek\source\	Configures LPDDR
void BOARD_ConfigureSdram (void)	board_memories.c	sam-ba_2.14\applets\customized_board_exam- ple\libraries\libboard_sama5d3x-ek\source\	Configures SDR
Function Implementation Library file NAND FLASH initialization			
void BOARD_Config- ureNandFlash (uint8_t bus- Width)	board_memories.c	sam-ba_2.14\applets\customized_board_exam- ple\libraries\libboard_sama5d3x-ek\source\	Configures the EBI for NandFlash ac- cess

In the following sections the process for the customization of the different memory types is introduced in a step-by-step guide. [Table 7-1](#) is used as a reference to initialize the external memory.

7.3.2 Customization Files Overview

7.3.2.1 TCL Scripts

These files have already been introduced in Section [2.6.1 Customized_board_example.tcl Description](#).

7.3.2.2 SDR/DDR Initialization Applet File

This file is the `main.c` file located in the following directory:

`sam-ba_2.14\applets\customized_board_example\sam-ba_applets\extram`.

This file is composed of several parts which will be briefly described in this section:

- **Headers:** This part implement the libraries headers of the functions used in the main.c file
- **Definitions:** These are the main constants used in the main.c file
- **Local structures:** This part is where the applet mailbox is implemented. Structure for storing parameters for each command that can be performed by the applet. All the parameters of this structure are used to store the same parameters sent by the tcl scripts.
- **Global variables:** This part is where the global variables are declared.
- **Local Functions**
 - `static unsigned char ExtRAM_TestOk(void)`
 - Go/No-Go test of the first 10KB of external RAM access
 - `int main(int argc, char **argv)`
 - Applet main entry. This function decodes the received command and executes it.

During the customization process, several parts can be modified such as the definitions and the main function.

7.3.2.3 SDR/DDR Initialization Library File

This is the `board_memories.c` located into the `sam-ba_2.14\applets\customized_board_example\libraries\libboard_sama5d3x-ek\source\` directory.

This file is where all the functions related to the memories initializations are implemented.

This file is composed of the same kind of parts as the previous file but contains the following functions:

- `void BOARD_ConfigureDdram (uint8_t device)`
- `void BOARD_ConfigureLpDdram (void)`
- `void BOARD_ConfigureSdram (void)`
- `void BOARD_ConfigureNandFlash (uint8_t busWidth)`
- `void BOARD_ConfigureNorFlash (uint8_t busWidth)`

In case of a customization, the main parameters to change to fit with the new memory AC characteristics are in these functions.

7.3.3 SDR/DDR Customization Example

The following example is a SAM-BA customization for a DDR2 external memory.



Find the related datasheet of the device (external_DDR2_device.pdf) in the folder named “Datasheet”. **The device part number is XXXXXXKB25I and the speed grade (5-5-5 or 6-6-6).**

The process introduced in this example can be reproduced for all the memory applets already available in SAM-BA.

7.3.3.1 Step 1: Customize the `customized_board_example.tcl`

- Open the `customized_board_example.tcl` file located in the `sam-ba_2.14\tcl_lib\customized_board_example\` directory.
- Modify the BOARD Specific Parameters according to the datasheet of the device: `extRamVdd`, `extRamType`, `extRamDataBusWidth`, `extDDRamModel` (introduced in Section 2.6.1 `Customized_board_example.tcl` Description).

From the device datasheet we learn that the external memory is a 1Gb DDR2 memory organized in 8.388.608 words x 8 Banks x 16 bits. Its power supply is 1.8V.

The Board specific parameters have to be modified as follow:

```
#####
## BOARD SPECIFIC PARAMETERS
#####
namespace eval BOARD {
    variable sramSize          $AT91C_IRAM_SIZE
    variable maxBootSize       65328
    # Default setting for DDRAM
    # Vdd Memory 1.8V = 0 / Vdd Memory 3.3V = 1
    variable extRamVdd 0
    # External SDRAM = 0 / External DDR2 = 1 / LPDDR = 2
    variable extRamType 1
    # Set bus width (16 or 32)
    variable extRamDataBusWidth 16
    # DDRAM Model (0: MT47H64M16HR, 1: MT47H128M16RT, 3:W971GGKB
    variable extDDRamModel 2
}
```

7.3.3.2 Step 2: Customize the SDR/DDR Initialization Applet File: *main.c*

- Open the *main.c* file located in the *sam-ba_2.14\applets\customized_board_example\sam-ba_applets\extram* directory
- In the definition part, the new memory and the new *BOARD_DDRAM_CUSTO_SIZE* have to be defined as shown (line 46 up to 61):

```
/*
 *      Definitions
 */
/* DDRAM type */
#define MT47H64M16HR      0
#define MT47H128M16RT      1
#define LPDDR              2
#define W971GGKB           3

/* Board DDRAM size*/

#define BOARD_DDRAM_SIZE_0      (64*1024*1024)    // 64 MB
#define BOARD_DDRAM_SIZE_1      (128*1024*1024)   // 128 MB
#define BOARD_SDRAM_SIZE       (32*1024*1024)    // 32 MB
#define BOARD_DDRAM_CUSTO_SIZE (64*1024*1024)    // 64 MB
```

No other customization is required in this file as all the functions required are called as described:

```
/*
 *      Local functions
 */
/**
 * \brief Applet main entry. This function decodes received command and executes it.
 *
 * \param argc  always 1
 * \param argv  Address of the argument area..
 */

int main(int argc, char **argv)
{
    struct Mailbox *pMailbox = (struct _Mailbox *) argv;
    uint32_t comType = pMailbox->argument.inputInit.comType;
    /* INIT: */
    if (pMailbox->command == APPLET_CMD_INIT)
    {
        /* Save communication link type */
        WDT->WDT_MR = WDT_MR_WDDIS;
    #if (DYN_TRACES == 1)
        //dwTraceLevel = 0;
    #endif

    #if (TRACE_LEVEL==0) && (DYN_TRACES==1)
        if (comType == DBGU_COM_TYPE)
```

```

    {
        /* Function TRACE_CONFIGURE_ISP will be bypass due to the 0 TRACE LEVEL. We
        shall reconfigure the baud rate. */
        DBGU->DBGU_MR = DBGU_MR_CHMODE_NORM | DBGU_MR_PAR_NONE;
        /* Reset and disable receiver & transmitter */
        DBGU->DBGU_CR = DBGU_CR_RSTRX | DBGU_CR_RSTTX;
        DBGU->DBGU_IDR = 0xFFFFFFFF;
        DBGU->DBGU_CR = DBGU_CR_RSTRX | DBGU_CR_RSTTX | DBGU_CR_RXDIS | DBGU_CR_TXDIS;
        /* Configure baudrate */
        DBGU->DBGU_BRGR = (BOARD_MCK / 115200) / 16;
        /* Enable receiver and transmitter */
        DBGU->DBGU_CR = DBGU_CR_RXEN | DBGU_CR_TXEN;
    }

#endif

//TRACE_INFO("-- EXTRAM Applet %s --\n\r", SAM_BA_APPLETS_VERSION);
//TRACE_INFO("-- %s\n\r", BOARD_NAME);
//TRACE_INFO("-- Compiled: %s %s --\n\r", __DATE__, __TIME__);
//TRACE_INFO("INIT command:\n\r");

//TRACE_INFO("\tCommunication link type : %lu\n\r", pMailbox->argument.in-
putInit.comType);

//TRACE_INFO("\tInit EBI Vdd : %s\n\r", (pMailbox->argument.inputInit.VddMem-
Sel)? "3.3V": "1.8V");
//BOARD_ConfigureVddMemSel(pMailbox->argument.inputInit.VddMemSel);

/* Configure DDRAM controller */

if ( pMailbox->argument.inputInit.ramType == 0)
{
    //TRACE_INFO("\tExternal RAM type : %s\n\r", "SDRAM");
    BOARD_ConfigureSdram();
    pMailbox->argument.outputInit.memorySize = BOARD_SDRAM_SIZE;
}
else if ( pMailbox->argument.inputInit.ramType == 2)
{
    /* Disable DDR clock. */
    PMC->PMC_PCDR1 |= (1 << (ID_MPDDRC-32));
    PMC->PMC_SCDR |= PMC_SCER_DDRCK;
    BOARD_ConfigureLpDdram();
    pMailbox->argument.outputInit.memorySize = BOARD_DDRAM_SIZE_0;
}
else {
    /* DDR reset */
    MPDDRC->MPDDRC_LPR = MPDDRC_LPR_LPCB_DEEP_PWD | MPDDRC_LPR_CLK_FR_ENABLED;
    /* Disable DDR clock. */
    PMC->PMC_PCDR1 |= (1 << (ID_MPDDRC-32));
    PMC->PMC_SCDR |= PMC_SCER_DDRCK;
    //TRACE_INFO("\tExternal RAM type : %s\n\r", "DDRAM");
    BOARD_ConfigureDdram(pMailbox->argument.inputInit.ddrModel);
    if (pMailbox->argument.inputInit.ddrModel == MT47H64M16HR)
    {
        pMailbox->argument.outputInit.memorySize = BOARD_DDRAM_SIZE_0;
    }
    if (pMailbox->argument.inputInit.ddrModel == MT47H128M16RT)
    {
        pMailbox->argument.outputInit.memorySize = BOARD_DDRAM_SIZE_1;
    }
}

/* Test external RAM access */
if (ExtrAM_TestOk())
{
    pMailbox->status = APPLET_SUCCESS;
}
else {
    pMailbox->status = APPLET_FAIL;
}
pMailbox->argument.outputInit.bufferAddress = ((uint32_t) & end);

```

```

        pMailbox->argument.outputInit.bufferSize = 0;
        //TRACE_INFO("\tInit successful.\n\r");
    }

    /* Acknowledge the end of command */
    //TRACE_INFO("\tEnd of applet (command : %lx --- status : %lx)\n\r", pMailbox->command,
    pMailbox->status);

    /* Notify the host application of the end of the command processing */
    pMailbox->command = ~(pMailbox->command);
    /* Send ACK character */
    if (comType == DBGU_COM_TYPE) {
        /* Wait for the transmitter to be ready */
        while ( (DBGU->DBGU_SR & DBGU_SR_TXEMPTY) == 0 ) ;
        /* Send character */
        DBGU->DBGU_THR = 0x06 ;
    }
    return 0;
}

```

The next step is to customize the function itself.

7.3.3.3 Step 3: Customize the Library File SDR/DDR Initialization: `board_memories.c`

In this file the whole process allowing to initialize the memories is described in the commented notes at the beginning of the file:

```

/** \addtogroup ddrd_module
 *
 * The DDR/SDR SDRAM Controller (DDRSDRC) is a multiport memory controller. It comprises
 * four slave AHB interfaces. All simultaneous accesses (four independent AHB ports) are in-
terleaved
 * to maximize memory bandwidth and minimize transaction latency due to SDRAM protocol.
 *
 * \section ddr2 Configures DDR2
 *
 * The DDR2-SDRAM devices are initialized by the following sequence:
 * <ul>
 * <li> EBI Chip Select 1 is assigned to the DDR2SDR Controller, Enable DDR2 clock x2 in
PMC.</li>
 * <li> Step 1: Program the memory device type</li>
 * <li> Step 2:
 * -# Program the features of DDR2-SDRAM device into the Configuration Register.
 * -# Program the features of DDR2-SDRAM device into the Timing Register HDDRSDRC2_T0PR.
 * -# Program the features of DDR2-SDRAM device into the Timing Register HDDRSDRC2_T1PR.
 * -# Program the features of DDR2-SDRAM device into the Timing Register HDDRSDRC2_T2PR.
</li>
 * <li> Step 3: An NOP command is issued to the DDR2-SDRAM to enable clock. </li>
 * <li> Step 4: An NOP command is issued to the DDR2-SDRAM </li>
 * <li> Step 5: An all banks precharge command is issued to the DDR2-SDRAM. </li>
 * <li> Step 6: An Extended Mode Register set (EMRS2) cycle is issued to choose between com-
mercial or high temperature operations.</li>
 * <li> Step 7: An Extended Mode Register set (EMRS3) cycle is issued to set all registers to
0. </li>
 * <li> Step 8: An Extended Mode Register set (EMRS1) cycle is issued to enable DLL.</li>
 * <li> Step 9: Program DLL field into the Configuration Register.</li>
 * <li> Step 10: A Mode Register set (MRS) cycle is issued to reset DLL.</li>
 * <li> Step 11: An all banks precharge command is issued to the DDR2-SDRAM.</li>
 * <li> Step 12: Two auto-refresh (CBR) cycles are provided. Program the auto refresh command
(CBR) into the Mode Register.</li>
 * <li> Step 13: Program DLL field into the Configuration Register to low(Disable DLL re-
set).</li>
 * <li> Step 14: A Mode Register set (MRS) cycle is issued to program the parameters of the
DDR2-SDRAM devices.</li>
 * <li> Step 15: Program OCD field into the Configuration Register to high (OCD calibration
default). </li>
 * <li> Step 16: An Extended Mode Register set (EMRS1) cycle is issued to OCD default
value.</li>
 * <li> Step 17: Program OCD field into the Configuration Register to low (OCD calibration
mode exit).</li>

```

```

* <li> Step 18: An Extended Mode Register set (EMRS1) cycle is issued to enable OCD
exit.</li>
* <li> Step 19,20: A mode Normal command is provided. Program the Normal mode into Mode Register.</li>
* <li> Step 21: Write the refresh rate into the count field in the Refresh Timer register.
The DDR2-SDRAM device requires a refresh every 15.625 or 7.81. </li>
* </ul>
*/
/*@{*/
/*@}*/

/** \addtogroup sdram_module
*
* \section sdram Configures SDRAM
*
* The SDR-SDRAM devices are initialized by the following sequence:
* <ul>
* <li> EBI Chip Select 1 is assigned to the DDR2SDR Controller, Enable DDR2 clock x2 in
PMC.</li>
* <li> Step 1. Program the memory device type into the Memory Device Register</li>
* <li> Step 2. Program the features of the SDR-SDRAM device into the Timing Register and into
the Configuration Register.</li>
* <li> Step 3. For low-power SDRAM, temperature-compensated self refresh (TCSR), drive
strength (DS) and partial array self refresh (PASR) must be set in the Low-power Regis-
ter.</li>
* <li> Step 4. A NOP command is issued to the SDR-SDRAM. Program NOP command into Mode Regis-
ter, the application must
* set Mode to 1 in the Mode Register. Perform a write access to any SDR-SDRAM address to
acknowledge this command.
* Now the clock which drives SDR-SDRAM device is enabled.</li>
* <li> Step 5. An all banks precharge command is issued to the SDR-SDRAM. Program all banks
precharge command into Mode Register, the application must set Mode to 2 in the
* Mode Register . Perform a write access to any SDRSDRAM address to acknowledge this com-
mand.</li>
* <li> Step 6. Eight auto-refresh (CBR) cycles are provided. Program the auto refresh command
(CBR) into Mode Register, the application must set Mode to 4 in the Mode Register.
* Once in the idle state, two AUTO REFRESH cycles must be performed.</li>
* <li> Step 7. A Mode Register set (MRS) cycle is issued to program the parameters of the
SDRSDRAM
* devices, in particular CAS latency and burst length. </li>
* <li> Step 8. For low-power SDR-SDRAM initialization, an Extended Mode Register set (EMRS)
cycle is issued to program the SDR-SDRAM parameters (TCSR, PASR, DS). The write
* address must be chosen so that BA[1] is set to 1 and BA[0] is set to 0 </li>
* <li> Step 9. The application must go into Normal Mode, setting Mode to 0 in the Mode Regis-
ter and perform a write access at any location in the SDRAM to acknowledge this command.</li>
* <li> Step 10. Write the refresh rate into the count field in the DDRSDRC Refresh Timer reg-
ister </li>
* </ul>
*/
/*@{*/
/*@}*/

```

This is exactly what is implemented into the functions themselves, as described in the following example (only the first 10 steps introduced...):

```

void BOARD_ConfigureDdram( uint8_t device )
{
    volatile uint8_t *pDdr = (uint8_t *) DDR_CS_ADDR;
    volatile uint32_t i;
    volatile uint32_t cr = 0;
    volatile uint32_t dummy_value;
#ifndef _SAMD21
    dummy_value = 0x00000000;

    /* Enable DDR2 clock x2 in PMC */
    PMC->PMC_PCR1 = (1 << (ID_MPDDRC-32));
    PMC->PMC_SCER |= PMC_SCER_DDRCK;
    MPDDRC->MPDDRC_LPR = 0;
    *(uint32_t *)0xFFFFFEA24 |= (1 << 5); // DDRSDRC High Speed Register (MPDDRC_HS) : hidden
option -> calibration during autorefresh
#endif
}

```

```

*(uint32_t *)0xF0038004 |= (0x3 << 16); // SFR_DDRCFG DDR Configuration Force DDR_DQ
and DDR_DQS input buffer always on

MPDDRC->MPDDRC_DLL_SOR = MPDDRC_DLL_SOR_S0_OFF(0x1) | MPDDRC_DLL_SOR_S1_OFF(0x0) |
MPDDRC_DLL_SOR_S2_OFF(0x1) | MPDDRC_DLL_SOR_S3_OFF(0x1);
MPDDRC->MPDDRC_DLL_MOR = (0xc5000000) | MPDDRC_DLL_MOR_MOFF(7) |
MPDDRC_DLL_MOR_CLK90OFF(0x1F) | MPDDRC_DLL_MOR_SEOFF; // Key = 0xc5000000
dummy_value = MPDDRC->MPDDRC_IO_CALIBR;
dummy_value &= ~MPDDRC_IO_CALIBR_RDIV_Msk;
dummy_value &= ~MPDDRC_IO_CALIBR_TZQIO_Msk;
dummy_value |= MPDDRC_IO_CALIBR_RDIV_RZQ_48;
dummy_value |= MPDDRC_IO_CALIBR_TZQIO(3);
MPDDRC->MPDDRC_IO_CALIBR = dummy_value;

*(uint32_t *)0xF0038004 = (0x3 << 16); // SFR_DDRCFG DDR Configuration Force DDR_DQ and
DDR_DQS input buffer always on
#endif
/* Step 1: Program the memory device type */
/* DBW = 0 (32 bits bus wide); Memory Device = 6 = DDR2-SDRAM = 0x00000006*/
MPDDRC->MPDDRC_MD = MPDDRC_MD_MD_DDR2_SDRAM;

/* Step 2: Program the features of DDR2-SDRAM device into the Timing Register.*/
if (device == MT47H128M16RT)
{
    MPDDRC->MPDDRC_CR = MPDDRC_CR_NR(3) |
    MPDDRC_CR_NC(1) |
    MPDDRC_CR_CAS(4) |
    MPDDRC_CR_NB_8 |
    MPDDRC_CR_DLL_RESET_DISABLED |
    MPDDRC_CR_DQMS_NOT_SHARED |
    MPDDRC_CR_ENRDM_OFF |
    MPDDRC_CR_UNAL_SUPPORTED |
    MPDDRC_CR_NDQS_DISABLED |
    MPDDRC_CR_OCD(0x0);
}
if (device == MT47H64M16HR)
{
    MPDDRC->MPDDRC_CR = MPDDRC_CR_NR(2) |
    MPDDRC_CR_NC(1) |
    MPDDRC_CR_CAS(3) |
    MPDDRC_CR_NB_8 |
    MPDDRC_CR_DLL_RESET_DISABLED |
    MPDDRC_CR_DQMS_NOT_SHARED |
    MPDDRC_CR_ENRDM_OFF |
    MPDDRC_CR_UNAL_SUPPORTED |
    MPDDRC_CR_NDQS_DISABLED |
    MPDDRC_CR_OCD(0x0);
}

MPDDRC->MPDDRC_TPRO = MPDDRC_TPRO_TRAS(6) // 6 * 7.5 = 45 ns
| MPDDRC_TPRO_TRCD(2) // 2 * 7.5 = 15 ns
| MPDDRC_TPRO_TWR(2) // 3 * 7.5 = 22.5 ns
| MPDDRC_TPRO_TRC(8) // 8 * 7.5 = 60 ns
| MPDDRC_TPRO_TRP(2) // 2 * 7.5 = 15 ns
| MPDDRC_TPRO_TRRD(1) // 2 * 7.5 = 15 ns
| MPDDRC_TPRO_TWTR(2) // 2 clock cycle
| MPDDRC_TPRO_TMRD(2); // 2 clock cycles

MPDDRC->MPDDRC_TPR1 = MPDDRC_TPR1_TRFC(14) // 18 * 7.5 = 135 ns (min 127.5 ns for 1Gb
DDR)
| MPDDRC_TPR1_TXSNR(16) // 20 * 7.5 > 142.5ns TXSNR: Exit self re-
fresh delay to non read command
| MPDDRC_TPR1_TXSRD(208) // min 200 clock cycles, TXSRD: Exit self re-
fresh delay to Read command
| MPDDRC_TPR1_TXP(2); // 2 * 7.5 = 15 ns

MPDDRC->MPDDRC_TPR2 = MPDDRC_TPR2_TXARD(7) // min 2 clock cycles
| MPDDRC_TPR2_TXARDS(7) // min 7 clock cycles
| MPDDRC_TPR2_TRPA(2) // min 18ns
| MPDDRC_TPR2_TRTP(2) // 2 * 7.5 = 15 ns (min 7.5ns)
| MPDDRC_TPR2_TFAW(10) ;

/* DDRSDRC Low-power Register */

```

```

    for (i = 0; i < 13300; i++) {
        asm("nop");
    }
    MPDDRC->MPDDRC_LPR = MPDDRC_LPR_LPCB_DISABLED | MPDDRC_LPR_CLK_FR_DISABLED | MPDDRC_LPR_TIMEOUT_0 | MPDDRC_LPR_APDE_FAST;

    /* Step 3: An NOP command is issued to the DDR2-SDRAM. Program the NOP command into the Mode Register, the application must set MODE to 1 in the Mode Register. */
    MPDDRC->MPDDRC_MR = MPDDRC_MR_MODE_NOP_CMD;
    /* Perform a write access to any DDR2-SDRAM address to acknowledge this command */
    *pDdr = 0; /* Now clocks which drive DDR2-SDRAM device are enabled.*/

    /* A minimum pause of 200 _ is provided to precede any signal toggle. (6 core cycles per iteration, core is at 396MHz: min 13200 loops) */
    for (i = 0; i < 13300; i++) {
        asm("nop");
    }

    /* Step 4: An NOP command is issued to the DDR2-SDRAM */
    MPDDRC->MPDDRC_MR = MPDDRC_MR_MODE_NOP_CMD;
    /* Perform a write access to any DDR2-SDRAM address to acknowledge this command.*/
    *pDdr = 0; /* Now CKE is driven high.*/
    /* wait 400 ns min */
    for (i = 0; i < 100; i++) {
        asm("nop");
    }

    /* Step 5: An all banks precharge command is issued to the DDR2-SDRAM. */
    MPDDRC->MPDDRC_MR = MPDDRC_MR_MODE_PRCGALL_CMD;
    /* Perform a write access to any DDR2-SDRAM address to acknowledge this command.*/
    *pDdr = 0;
    /* wait 400 ns min */
    for (i = 0; i < 100; i++) {
        asm("nop");
    }

    /* Step 6: An Extended Mode Register set (EMRS2) cycle is issued to choose between commercial or high temperature operations. */
    MPDDRC->MPDDRC_MR = MPDDRC_MR_MODE_EXT_LMR_CMD;
    *((uint8_t *) (pDdr + DDR2_BA1(device))) = 0; /* The write address must be chosen so that BA[1] is set to 1 and BA[0] is set to 0. */
    /* wait 2 cycles min */
    for (i = 0; i < 100; i++) {
        asm("nop");
    }

    /* Step 7: An Extended Mode Register set (EMRS3) cycle is issued to set all registers to 0. */
    MPDDRC->MPDDRC_MR = MPDDRC_MR_MODE_EXT_LMR_CMD;
    *((uint8_t *) (pDdr + DDR2_BA1(device) + DDR2_BA0(device))) = 0; /* The write address must be chosen so that BA[1] is set to 1 and BA[0] is set to 1.*/
    /* wait 2 cycles min */
    for (i = 0; i < 100; i++) {
        asm("nop");
    }

    /* Step 8: An Extended Mode Register set (EMRS1) cycle is issued to enable DLL. */
    MPDDRC->MPDDRC_MR = MPDDRC_MR_MODE_EXT_LMR_CMD;
    *((uint8_t *) (pDdr + DDR2_BA0(device))) = 0; /* The write address must be chosen so that BA[1] is set to 0 and BA[0] is set to 1. */
    /* An additional 200 cycles of clock are required for locking DLL */
    for (i = 0; i < 10000; i++) {
        asm("nop");
    }

    /* Step 9: Program DLL field into the Configuration Register.*/
    cr = MPDDRC->MPDDRC_CR;
    MPDDRC->MPDDRC_CR = cr | MPDDRC_CR_DLL_RESET_ENABLED;

    /* Step 10: A Mode Register set (MRS) cycle is issued to reset DLL. */
    MPDDRC->MPDDRC_MR = MPDDRC_MR_MODE_LMR_CMD;
    *(pDdr) = 0; /* The write address must be chosen so that BA[1:0] bits are set to 0. */
    /* wait 2 cycles min */
    for (i = 0; i < 100; i++) {

```

```

        asm("nop");
    }
    ...
    ...
    ...

```

Regarding the customization purpose, the main modifications, which have to be considered, are the external memory timing and architecture parameters, introduced in step 2. In the board_memories.c file, the existing implementation is related to the Atmel Evaluation Kits. These code lines can be copied or/and modified to just fit to the external memory.

```

/* Step 2: Program the features of DDR2-SDRAM device into the Timing Register.*/
MPDDRC->MPDDRC_CR = MPDDRC_CR_NR(2) |
    MPDDRC_CR_NC(1) |
    MPDDRC_CR_CAS(3) |
    MPDDRC_CR_NB_8 |
    MPDDRC_CR_DLL_RESET_DISABLED |
    MPDDRC_CR_DQMS_NOT_SHARED |
    MPDDRC_CR_ENRDM_OFF |
    MPDDRC_CR_UNAL_SUPPORTED |
    MPDDRC_CR_NDQS_DISABLED |
    MPDDRC_CR_OCD(0x0);

MPDDRC->MPDDRC_TPRO = MPDDRC_TPRO_TRAS(6) // 6 * 7.5 = 45 ns
| MPDDRC_TPRO_TRCD(2) // 2 * 7.5 = 15 ns
| MPDDRC_TPRO_TWR(2) // 3 * 7.5 = 22.5 ns
| MPDDRC_TPRO_TRC(8) // 8 * 7.5 = 60 ns
| MPDDRC_TPRO_TRP(2) // 2 * 7.5 = 15 ns
| MPDDRC_TPRO_TRRD(1) // 2 * 7.5 = 15 ns
| MPDDRC_TPRO_TWTR(2) // 2 clock cycle
| MPDDRC_TPRO_TMRD(2); // 2 clock cycles

MPDDRC->MPDDRC_TPR1 = MPDDRC_TPR1_TRFC(14) // 18 * 7.5 = 135 ns (min 127.5 ns for 1Gb
DDR)
| MPDDRC_TPR1_TXSNR(16) // 20 * 7.5 > 142.5ns TXSNR: Exit self re-
fresh delay to non read command
| MPDDRC_TPR1_TXSRD(208) // min 200 clock cycles, TXSRD: Exit self
refresh delay to Read command
| MPDDRC_TPR1_TXP(2); // 2 * 7.5 = 15 ns

MPDDRC->MPDDRC_TPR2 = MPDDRC_TPR2_TXARD(7) // min 2 clock cycles
| MPDDRC_TPR2_TXARDS(7) // min 7 clock cycles
| MPDDRC_TPR2_TRPA(2) // min 18ns
| MPDDRC_TPR2_TRTP(2) // 2 * 7.5 = 15 ns (min 7.5ns)
| MPDDRC_TPR2_TFAW(10);
```

The main difficulty here is to identify and make this implementation matching with the parameters introduced from the external memory datasheet.

Let's have a look at this process with the previous example (external_DDR2_device.pdf).

The customization principle will be to fill the matching values (between the parentheses) according to the value required by the external memory identified into its own datasheet.

```

/* Step 2: Program the features of DDR2-SDRAM device into the Timing Register.*/
MPDDRC->MPDDRC_CR = MPDDRC_CR_NR()
| MPDDRC_CR_NC()
| MPDDRC_CR_CAS()
| MPDDRC_CR_NB_8
| MPDDRC_CR_DLL_RESET_DISABLED
| MPDDRC_CR_DQMS_NOT_SHARED
| MPDDRC_CR_ENRDM_OFF
| MPDDRC_CR_UNAL_SUPPORTED
| MPDDRC_CR_NDQS_DISABLED
| MPDDRC_CR_OCD();

MPDDRC->MPDDRC_TPRO = MPDDRC_TPRO_TRAS()
| MPDDRC_TPRO_TRCD()
| MPDDRC_TPRO_TWR()
```

```

| MPDDRC_TPR0_TRC()
| MPDDRC_TPR0_TRP()
| MPDDRC_TPR0_TRRD()
| MPDDRC_TPR0_TWTR()
| MPDDRC_TPR0_TMRD();
```

```

MPDDRC->MPDDRC_TPR1 = MPDDRC_TPR1_TRFC()
| MPDDRC_TPR1_TXSNR()
| MPDDRC_TPR1_TXSRD()
| MPDDRC_TPR1_TXP();
```

```

MPDDRC->MPDDRC_TPR2 = MPDDRC_TPR2_TXARD()
| MPDDRC_TPR2_TXARDS()
| MPDDRC_TPR2_TRPA()
| MPDDRC_TPR2_TRTP()
| MPDDRC_TPR2_TFAW();
```

Mainly two different parameter families are to be customized:

- The “Memory Configuration” parameters:
 - CAS Latency
 - Number of Rows
 - Number of Columns
- the timings parameters

All these parameters are related to only a few registers of the SAMA5 (or other Atmel MPU):

- The “memory architecture” parameters have to be set into the `MPDDRC_CR` register (MPDDRC Configuration Register)
- The timings parameters have to be set into the MPDDRC Timing Parameter 0, 1, 2 Registers (`MPDDRC_TPR0`, `MPDDRC_TPR1`, `MPDDRC_TPR2`)

From the memory datasheet, all the parameters are described and introduced across the datasheet. Normally the timings are summarized into the table “AC Characteristics” and the CAS latency the number of row and column, directly from the “General Description”.



Find the related datasheet of the device (external_DDR2_device.pdf) in the folder named “Datasheet”. **The device part number is XXXXXXKB25I and the speed grade (5-5-5 or 6-6-6).**

Regarding the “memory architecture” parameters, let’s have a look at the different field of the register `MPDDRC_CR`:

MPDDRC_CR (RW), Reset Value: 0x00207024

Bit#	31	30	29	28	27	26	25	24
	-	-	-	-	-	-	-	-
Reset	0	0	0	0	0	0	0	0
Bit#	23	22	21	20	19	18	17	16
	UNAL	DECOD	NDQS	NB	-	-	ENRDM	DQMS
Reset	0	0	1	0	0	0	0	0
Bit#	15	14	13	12	11	10	9	8
	-	OCD			ZQ		DIS_DLL	DIC_DS
Reset	0	1	1	1	0	0	0	0
Bit#	7	6	5	4	3	2	1	0
	DLL	CAS			NR		NC	
Reset	0	0	1	0	0	1	0	0

MPDDRC_CR Register view

Using the datasheet for the Atmel device and the datasheet for the external memory, the configuration parameters have to be identified. The table below summarizes what are the functions of the different bit fields of the MPDDRC_CR register and where the appropriate values can be found in the external memory datasheet.

MPDDRC_CR bit-field	Function	Where is it in the external memory datasheet	Value to be set
NC → Bits 0-1	Number of Column Bits in the address bus	Ball Description: column address: A0 – A9	10
NR → Bits 2-3	Number of Column Bits in the address bus	Ball Description: row address: A0 – A12	13
CAS → Bits 4-5-6	CAS latency	General Description: CAS Latency 3, 4, 5, 6, 7	3 (min)
DLL → Bit 7	This bit defines the value of Reset DLL. This bit is found only in the DDR2-SDRAM devices	Digital Locked Loop, This is found only in the DDR2-SDRAM devices	1 (Enable DLL reset)
DIC_DS → Bit 8	Output Driver Impedance Control (Drive Strength). This bit is found only in the DDR2-SDRAM devices.	This bit name is described as “DS” in some memory datasheets. No DS found	0 (DDR2_NOR-MAL-STRENGTH)

MPDDRC_CR bit-field	Function	Where is it in the external memory datasheet	Value to be set
DIS_DLL → Bit 9	DISABLE DLL This value is used during the power-up sequence. It is only found in the DDR2-SDRAM devices.	Digital Locked Loop, This is found only in the DDR2-SDRAM devices.	0 Enable the DLL (let the reset value)
ZQ → Bit 10 – 11	ZQ Calibration: This parameter is used to calibrate DRAM On resistance (Ron) values over PVT	This field is found only in the low-power DDR2-SDRAM devices.	N.A. (let at the reset value)
OCD → Bit 12 – 13 - 14	Off Chip Driver This field is found only in the DDR2-SDRAM devices.	SDRAM Controller supports only two values for OCD (default calibration and exit from calibration). These values MUST always be programmed during the initialization sequence. The default calibration must be programmed first. After which the exit calibration and maintain settings must be programmed. See step 12 Of the Functional Description	7 DDR2_DE-FAULT_CALIB and 0 DDR2_EXIT-CALIB after the initialization.
DQMS → Bit 16	Mask Data is Shared	DQM is not shared with another controller	0 NOT_SHARED
ENRDM → Bit 17	Enable Read Measure	Not necessary	0 OFF
NB → Bit 20	Number of Banks	General description	1 8-banks
NDQS → Bit 21	This bit is found only in the DDR2-SDRAM devices.	Extend Mode Register Set Commands (EMRS)	0 Disabled
DECOD → Bit 22	Type of Decoding	Sequential is mandatory	0 SEQUENTIAL (let the reset value)
UNAL → Bit 23	Support Unaligned Access	General Description / Feature Edge-aligned with Read data and center-aligned with the Write data	0 Not supported

Therefore the step 2 can be completed as below:

```
/* Step 2: Program the features of DDR2-SDRAM device into the Timing Register.*/
MPDDRC->MPDDRC_CR = MPDDRC_CR_NR(13)
  | MPDDRC_CR_NC(10)
  | MPDDRC_CR_CAS(3)
  | MPDDRC_CR_NB_8
  | MPDDRC_CR_DLL_RESET_ENABLED
  | MPDDRC_CR_DQMS_NOT_SHARED
  | MPDDRC_CR_ENRDM_OFF
  | MPDDRC_CR_UNAL_UNSUPPORTED
  | MPDDRC_CR_NDQS_DISABLED
  | MPDDRC_CR_OCD(0x7);
```

Regarding the Timings, this time three different registers are used to store all the timings required to access the external memory:

MPDDRC_TPR0 (RW)

Bit#	31	30	29	28	27	26	25	24
	TMRD				RDC_WRRD	TWTR		

Bit#	23	22	21	20	19	18	17	16
	TRRD				TRP			

Bit#	15	14	13	12	11	10	9	8
	TRC				TWR			

Bit#	7	6	5	4	3	2	1	0
	TRCD				TRAS			

MPDDRC_TPR1 (RW)

Bit#	31	30	29	28	27	26	25	24
	-	-	-	-	TXP			

Bit#	23	22	21	20	19	18	17	16
	TXSRD							

Bit#	15	14	13	12	11	10	9	8
	TXSNR							

Bit#	7	6	5	4	3	2	1	0			
	-	-	-	TRFC							

MPDDRC_TPR2 (RW)

Bit#	31	30	29	28	27	26	25	24
	-	-	-	-	-	-	-	-
Bit#	23	22	21	20	19	18	17	16
	-	-	-	-				TFAW
Bit#	15	14	13	12	11	10	9	8
	-		TRTP					TRPA
Bit#	7	6	5	4	3	2	1	0
		TXARDS						TXARD



The timings configuration is obviously related to the bus clock frequency. In this case the DDR bus frequency provided by MCK is considered to be 133MHz, which gives a 7.52ns time period.

MPDDRC_TP _x bitfield	Function	Where is it in the external memory datasheet	Value to be set
MPDDRC_TPR0_TRAS	Active To pre-charge Delay: delay between an Activate command and a pre-charge command in number of SDCK clock cycles	AC Characteristics and Operating Condition: TRAS: Active to Pre-charge Command Period	45ns min.
MPDDRC_TPR0_TRCD	Row to Column Delay: delay between an Activate command and a Read/Write command in number of SDCK clock cycles.	AC Characteristics and Operating Condition: TRCD: Active to Read/Write Command Delay time	12.5ns min.
MPDDRC_TPR0_TWR	Write Recovery Delay: Write Recovery Time in number of SDCK clock cycles.	AC Characteristics and Operating Condition: TWR: Write recovery Time	15ns
MPDDRC_TPR0_TRC	Row Cycle Delay: delay between an Activate command and Refresh command in number of SDCK clock cycles	AC Characteristics and Operating Condition: TRC: Active to Refresh/Active command Period	57.5ns min.
MPDDRC_TPR0_TRP	Row Pre-charge Delay: delay between a pre-charge command and another command in number of SDCK clock cycles	AC Characteristics and Operating Condition: TRP: Pre-charge to active command period	12.5 ns min

MPDDRC_TPx bitfield	Function	Where is it in the external memory datasheet	Value to be set
MPDDRC_TPR0_TRRD	Active Bank A to Active Bank B: delay between an Activate command in Bank A and an Activate command in Bank B in number of SDCK clock cycles	AC Characteristics and Operating Condition: TRRD: Active to active command period for 2KB page size	10ns
MPDDRC_TPR0_TWTR	Internal Write to Read Delay: internal Write to Read command time in number of SDCK clock cycles	AC Characteristics and Operating Condition: TWTR: Internal write to read command delay	7.5ns
MPDDRC_TPR0_RDC_WRRD	Reduce Write to Read Delay: delay between write to read access for the low-power DDR-SDRAM devices with a latency equal to 2. To use this feature, the TWTR field must be equal to 0. Note that some devices do not support this feature.	AC Characteristics and Operating Condition: Not Supported	N-A
MPDDRC_TPR0_TMRD	Load Mode Register Command to Activate or Refresh Command: delay between a Load mode register command and an Activate or Refresh command in number of SDCK clock cycles.	AC Characteristics and Operating Condition: TMRD: Mode Register set command cycle time	2 clock cycles
MPDDRC_TPR1_TXP	Exit Power-down Delay to First Command: delay between CKE set high and a Valid command in number of SDCK clock cycles	AC Characteristics and Operating Condition: TXP: Exit pre-charge power down to any command	2 clock cycles
MPDDRC_TPR1_TXSRD	Exit Self-refresh Delay to Read Command: delay between CKE set high and a Read command in number of SDCK clock cycles	AC Characteristics and Operating Condition: TXSRD: Self refresh to read command	200 clock cycles
MPDDRC_TPR1_TXSNR	Exit Self-refresh Delay to Non Read Command: delay between CKE set high and a Non Read command in number of SDCK clock cycles	AC Characteristics and Operating Condition: TXSNR: Exit Self Refresh to a non-Read command.	tRFC+10 = 137.5ns min.
MPDDRC_TPR1_TRFC	Row Cycle Delay: Delay between a Refresh command or a Refresh and Activate command in number of SDCK clock cycles.	IDD Measurement Test Parameter and AC Characteristics and Operating Condition: TRFC: Auto Refresh To Active/ Auto Refresh command period	127.5ns
MPDDRC_TPR2_TFAW	Four Active Windows: DDR2 devices with eight banks (1Gb or larger) have an additional requirement concerning tFAW timing. This requires that no more than four Activate commands may be issued in any given tFAW (MIN) period. This field is found only in the DDR2-SDRAM and LPDDR2-SDRAM devices	IDD Measurement Test Parameter and AC Characteristics and Operating Condition: Four Activate Window for 2KB page size.	45ns

MPDDRC_TPx bitfield	Function	Where is it in the external memory datasheet	Value to be set
MPDDRC_TPR2_TRTP	Read to Pre-charge: This field defines the delay between Read command and a Pre-charge command in number of SDCK clock cycles	AC Characteristics and Operating Condition: TRTP: Internal Read to Pre-charge command Delay.	7.5ns
MPDDRC_TPR2_TRPA	Row Pre-charge All Delay: This field defines the delay between a Pre-charge All Banks command and another command in number of SDCK clock cycles.	Burst read with Auto-Pre-charge: TRP All	TRPALL= TRP+1 x TCK)
MPDDRC_TPR2_TXARDS	Exit Active Power Down Delay to Read Command in Mode "Slow Exit": delay between CKE set high and a Read command in number of SDCK clock cycles. This field is found only in the DDR2-SDRAM devices.	AC Characteristics and Operating Condition: TXARDS: Exit Active power own to read command	10 clock cycles
MPDDRC_TPR2_TXARD	Exit Active Power Down Delay to Read Command in Mode "Fast Exit": delay between CKE set high and a Read command in number of SDCK clock cycles. This field is found only in the DDR2-SDRAM devices.	AC Characteristics and Operating Condition: Exit on Active power down to Read command	3 clock cycles

Step 2 can be completed as follow:

```
/* Step 2: Program the features of DDR2-SDRAM device into the Timing Register.*/
MPDDRC->MPDDRC_CR = MPDDRC_CR_NR(13)
  | MPDDRC_CR_NC(10)
  | MPDDRC_CR_CAS(3)
  | MPDDRC_CR_NB_8
  | MPDDRC_CR_DLL_RESET_ENABLED
  | MPDDRC_CR_DQMS_NOT_SHARED
  | MPDDRC_CR_ENRDM_OFF
  | MPDDRC_CR_UNAL_UNSUPPORTED
  | MPDDRC_CR_NDQS_DISABLED
  | MPDDRC_CR_OCD(0x7) ;

MPDDRC->MPDDRC_TPR0 = MPDDRC_TPR0_TRAS(6)      // 6 * 7.5 = 45 ns
  | MPDDRC_TPR0_TRCD(2)    // 2 * 7.5 = 15 ns
  | MPDDRC_TPR0_TWR(2)    // 3 * 7.5 = 22.5 ns
  | MPDDRC_TPR0_TRC(8)    // 8 * 7.5 = 60 ns
  | MPDDRC_TPR0_TRP(2)    // 2 * 7.5 = 15 ns
  | MPDDRC_TPR0_TRRD(1)   // 2 * 7.5 = 15 ns
  | MPDDRC_TPR0_TWTR(2)   // 2 clock cycle
  | MPDDRC_TPR0_TMRD(2)   // 2 clock cycles

MPDDRC->MPDDRC_TPR1 = MPDDRC_TPR1_TRFC(14)      // 18 * 7.5 = 135 ns (min 127.5 ns for 1Gb DDR)
  | MPDDRC_TPR1_TXSNR(16) // 20 * 7.5 > 142.5ns
  | MPDDRC_TPR1_TXSRD(208) // min 200 clock cycles,
  | MPDDRC_TPR1_TXP(2);   // 2 * 7.5 = 15 ns

MPDDRC->MPDDRC_TPR2 = MPDDRC_TPR2_TXARD(7)      // min 2 clock cycles
  | MPDDRC_TPR2_TXARDS(7) // min 7 clock cycles
  | MPDDRC_TPR2_TRPA(2)   // min 18ns
  | MPDDRC_TPR2_TRTP(2)   // 2 * 7.5 = 15 ns (min 7.5ns)
  | MPDDRC_TPR2_TFAW(10);
```

8 Compile the SAM-BA Applets and Test Your Modifications

At this moment, the applets are customized, and the tools required to compile them are already installed. Let's start with the applet compilation by using:

- Sourcery CodeBench Lite 2012.09-63 for ARM EABI
- GNU make 3.81
- GNU Core utils 5.3



Before compiling the modified applets, the make file has to be updated accordingly to the new board (my_training_board) entry name and directory in order to update the existing binary file in the [Atmel\sam-ba_2.14\tcl_lib\my_training_board](#) directory.

Go to the modified applet path: [Atmel\sam-ba_2.14\applets\my_training_board\sam-ba_applets\lowlevelinit](#) and open the *make* file in a text editor:

- Replace the code line #34 “*BOARD = at91sama5d3x-ek*” by “*BOARD = my_customized_board*”

Replace the code line #40 “*BOARD_DIR=at91sama5d3x-ek*” by “*BOARD_DIR = my_customized_board*” as described below: (my_training_board or my_customized_board)

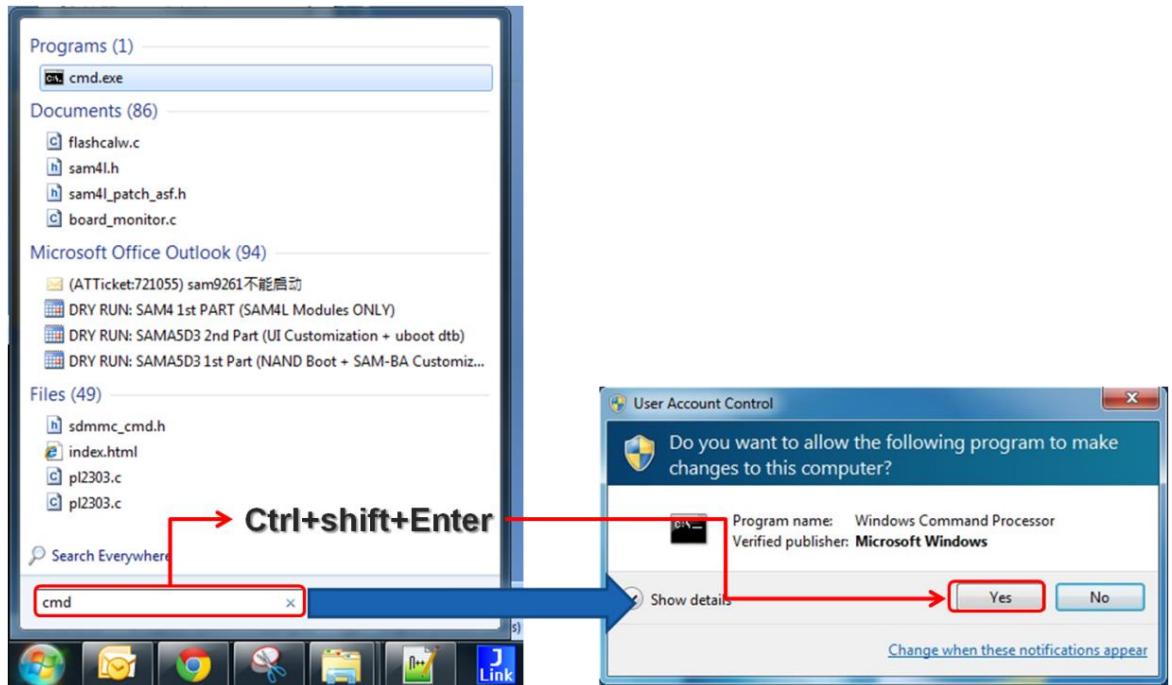
```
31 # Chip & board used for compilation
32 # (can be overriden by adding CHIP=chip and BOARD=board to the command-line)
33 CHIP = sama5d3x
34 BOARD = my_training_board
35
36 DYN = OFF
37
38 # Makefile for compiling applet-extram
39
40 BOARD_DIR = my_training_board
41
```

Save your modifications

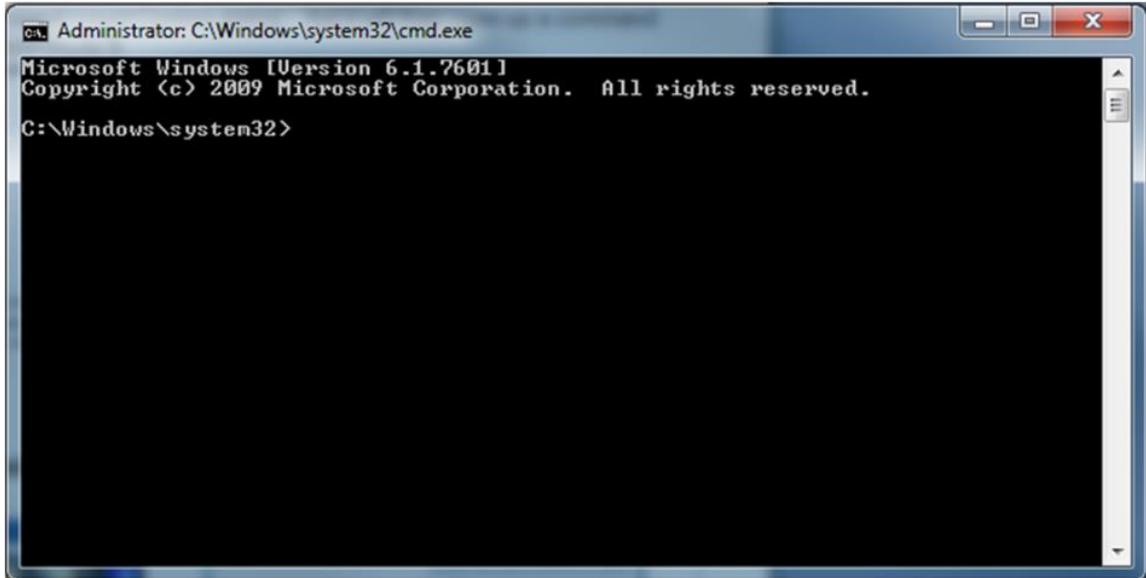
The make file will update the applet binary file in the [C:\Program Files \(x86\)\Atmel\sam-ba_2.14\tcl_lib\my_training_board](#) directory.

Compile SAM-BA applets with the modified [board_lowlevel.c](#).

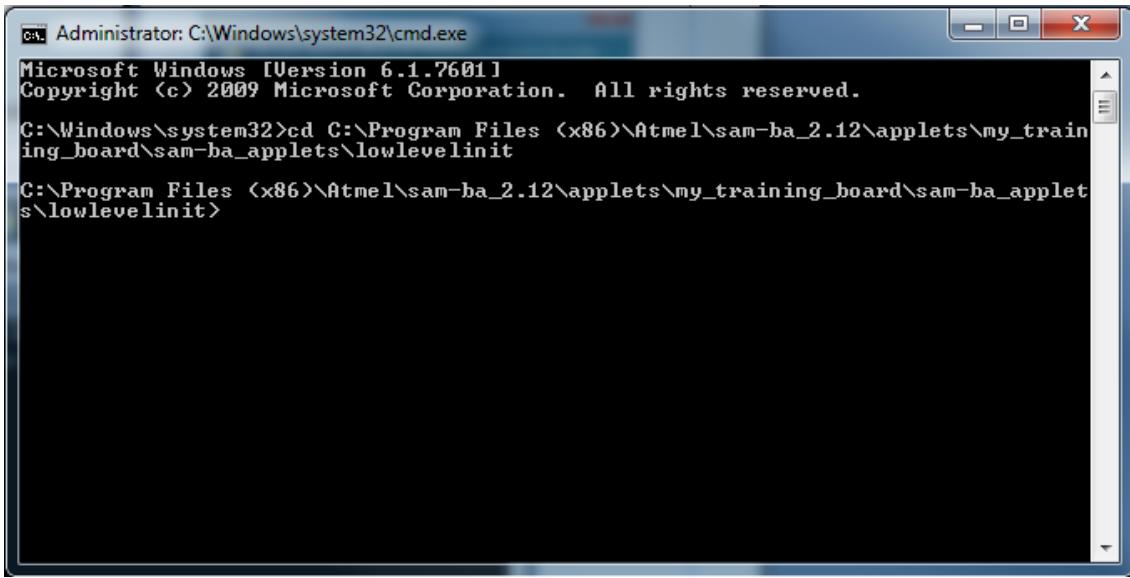
- Run a Windows [command prompt as administrator](#) by using [Start->run->](#)
 - Type “[cmd](#)” in the “[search programs and files](#)” field.
 - Now, [instead of hitting the Enter key, use Ctrl+Shift + Enter](#), you will be prompted with the User Account Control dialog. Then a command prompt in Administrator mode will open.



- The [command prompt](#) window appears



- Go to the "C:\Program Files (x86)\Atmel\sam-ba_2.12\applets\my_training_board\sam-ba_applets\lowlevelinit" by using the command:
`cd "C:\Program Files (x86)\Atmel\sam-ba_2.12\applets\my_training_board\sam-ba_applets\lowlevelinit"`

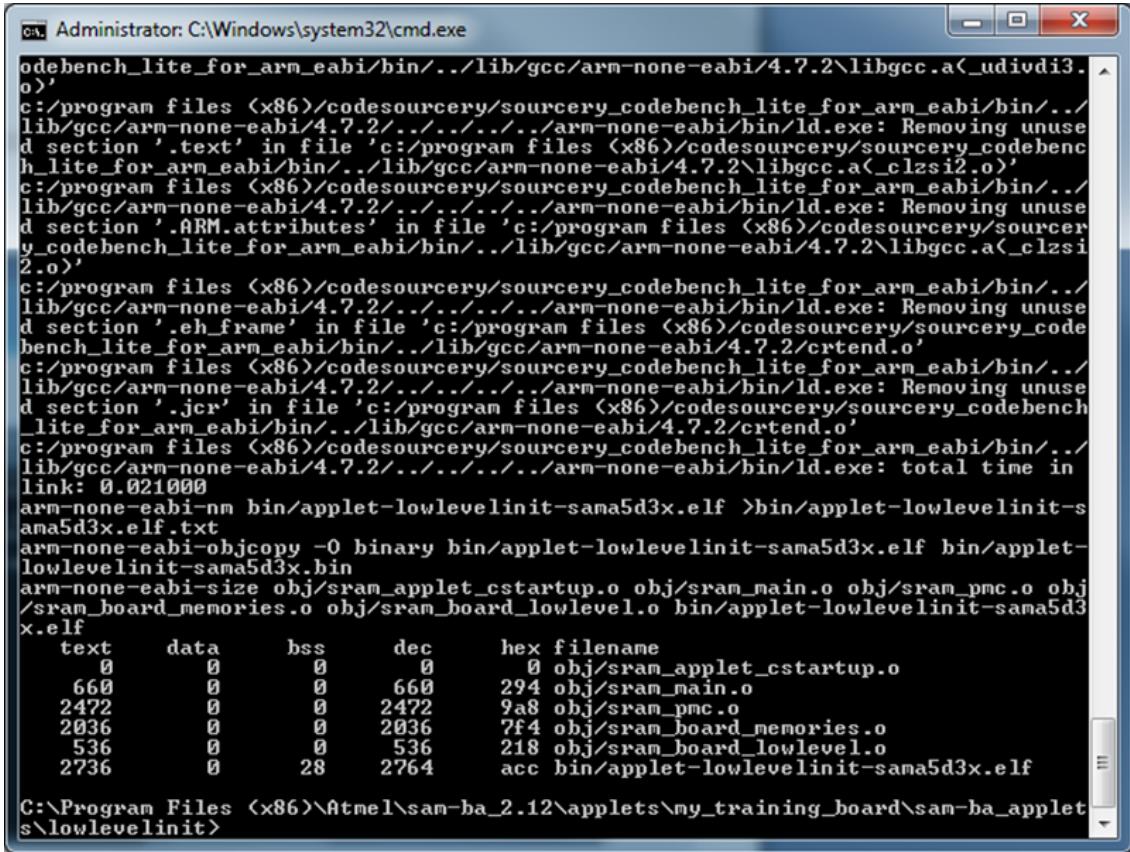


```
Administrator: C:\Windows\system32\cmd.exe
Microsoft Windows [Version 6.1.7601]
Copyright (c) 2009 Microsoft Corporation. All rights reserved.

C:\Windows\system32>cd C:\Program Files (x86)\Atmel\sam-ba_2.12\applets\my_training_board\sam-ba_applets\lowlevelinit

C:\Program Files (x86)\Atmel\sam-ba_2.12\applets\my_training_board\sam-ba_applets\lowlevelinit>
```

- Type the command `make` and press `enter`:

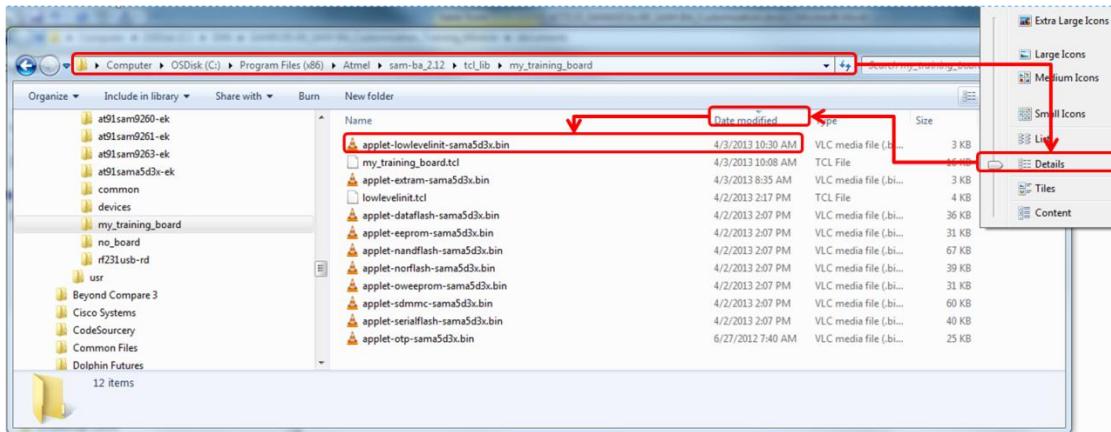


```
Administrator: C:\Windows\system32\cmd.exe
odebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/libgcc.a<_udivid3.o>
c:/program files (x86)/codesourcery/sourcery_codebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/.../.../arm-none-eabi/bin/ld.exe: Removing unused section '.text' in file 'c:/program files (x86)/codesourcery/sourcery_codebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/libgcc.a<_clzsi2.o>'
c:/program files (x86)/codesourcery/sourcery_codebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/.../.../arm-none-eabi/bin/ld.exe: Removing unused section '.ARM.attributes' in file 'c:/program files (x86)/codesourcery/sourcery_codebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/libgcc.a<_clzsi2.o>'
c:/program files (x86)/codesourcery/sourcery_codebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/.../.../arm-none-eabi/bin/ld.exe: Removing unused section '.eh_frame' in file 'c:/program files (x86)/codesourcery/sourcery_codebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/crtend.o'
c:/program files (x86)/codesourcery/sourcery_codebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/.../.../arm-none-eabi/bin/ld.exe: Removing unused section '.jcr' in file 'c:/program files (x86)/codesourcery/sourcery_codebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/crtend.o'
c:/program files (x86)/codesourcery/sourcery_codebench_lite_for_arm_eabi/bin/.../lib/gcc/arm-none-eabi/4.7.2/.../.../arm-none-eabi/bin/ld.exe: total time in link: 0.021000
arm-none-eabi-nm bin/applet-lowlevelinit-sama5d3x.elf >bin/applet-lowlevelinit-sama5d3x.elf.txt
arm-none-eabi-objcopy -O binary bin/applet-lowlevelinit-sama5d3x.elf bin/applet-lowlevelinit-sama5d3x.bin
arm-none-eabi-size obj/sram_applet_cstartup.o obj/sram_main.o obj/sram_pmc.o obj/sram_board_memories.o obj/sram_board_lowlevel.o bin/applet-lowlevelinit-sama5d3x.elf
      text      data      bss      dec      hex filename
      0        0        0        0        0 obj/sram_applet_cstartup.o
    660        0        0     660     294 obj/sram_main.o
   2472        0        0    2472     9a8 obj/sram_pmc.o
   2036        0        0    2036     7f4 obj/sram_board_memories.o
    536        0        0     536     218 obj/sram_board_lowlevel.o
   2736        0       28    2764     acc bin/applet-lowlevelinit-sama5d3x.elf

C:\Program Files (x86)\Atmel\sam-ba_2.12\applets\my_training_board\sam-ba_applets\lowlevelinit>
```

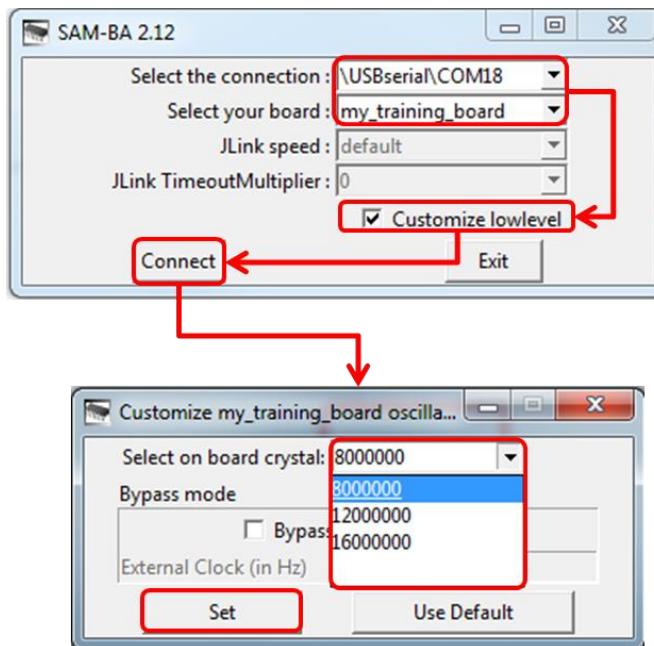
The applet is now compiled. This you can check by:

- going into the `C:\Program Files (x86)\Atmel\sam-ba_2.14\tcl_lib\my_training_board` directory and
- using the window explorer “Details” view and
- sorting the directory contents in a descending order of the “Date modified”. You can see that your lowlevel applet is the only applet which has been updated

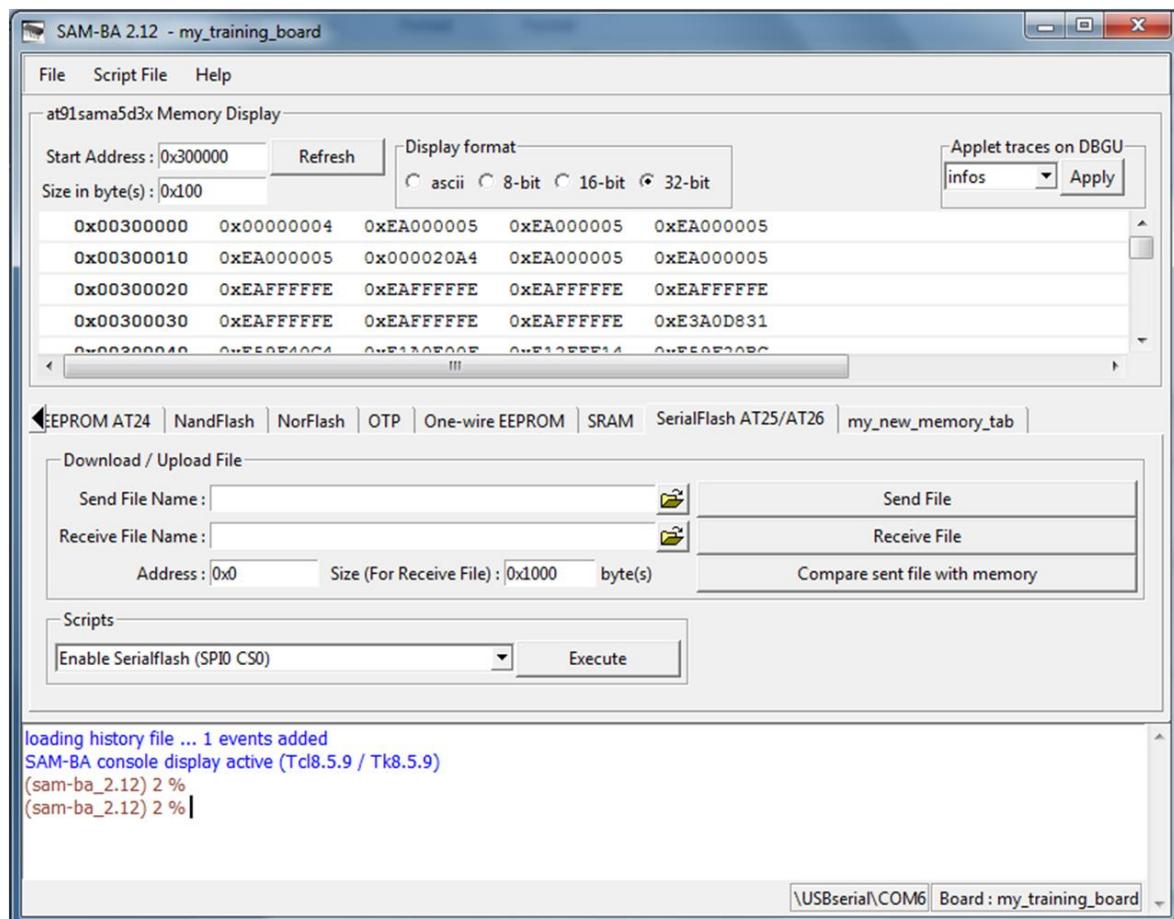


Restart SAM-BA GUI and click on the customized low level check box:

- Choose any value in the “*Select on board crystal*” drop down menu
- And click on “*Set*”



The SAM-BA GUI main window should appear and the red LED should be switched on by the CPU module.



9 References

Document	Comments
sam-ba user guide.pdf	User guide provided in the doc directory inside the SAM-BA installation directory
SAMA5D3x Product Datasheet	Available on the Atmel website: http://www.atmel.com/products/microcontrollers/arm/sama5.aspx?tab=documents
SAM-BA Customization Hands-on	This training is shared on request. It is also included inside this application note final package.

Appendix A Full Implementation of the Bypass Mode

```

/***
 * \brief Configure the PMC in bypass mode. An external clock should be input to XIN as the source clock.
 *
 * \param extClk The frequency of the external clock
 */
static void bypass_LowLevelInit (uint32_t extClk)
{
    /* First Switch the MCK to the main clock oscillator */
    PMC_SwitchMck2Main();

    /* enable external OSC 12 MHz bypass */
    PMC->CKGR_MOR = (PMC->CKGR_MOR | CKGR_MOR_MOSCXTBY) | CKGR_MOR_KEY(0x37);

    /* switch MAIN clock to external OSC */
    PMC->CKGR_MOR |= CKGR_MOR_MOSCSEL | CKGR_MOR_KEY(0x37);

    /* wait MAIN clock status change for external OSC 12 MHz selection*/
    while(!(PMC->PMC_SR & PMC_SR_MOSCSELS));

    /* in case where MCK is running on MAIN CLK */
    while(!(PMC->PMC_SR & PMC_SR_MCKRDY));

    /**
     * The PLLA configuration will depend on the extClk value which represents the frequency of the external
     * clock signal.
     * In this case we have to configure for any value to have the PLLA well configured.
     * As a reminder of the PLL electrical characteristics:
     * - Fout (the output frequency) must be in a range between 400 MHz and 800MHz (in worst case)
     * - Fin (the input Frequency) must be in a range between 8MHz and 50 MHz
     * - t (start-up time) must be in a range between 25 us and 100 us.
     */
    switch (extClk) {
        /* When external clock frequency is 12MHz */
        case 12000000:
            PMC_SetPllA( CKGR_PLLAR_STUCKTO1 | //this bit must be set to 1 (Bit 29 must always be set to
1 when programming the CKGR_PLLAR.)
                CKGR_PLLAR_PLLACOUNT(0x3F) | //this bit-field is the number of slow clock cycles before the
LOCKA bit is set in PMC_SR after CKGR_PLLAR is written.
                CKGR_PLLAR_OUTA(0x0) | //To be programmed to 0.
                CKGR_PLLAR_MULA(65) | //0 the PLLA is disabled, 1 up to 127: The PLLA Clock fre-
quency is the PLLA input frequency multiplied by MULA + 1.
                //In this case: 12*(65+1)= 792 MHz
                CKGR_PLLAR_DIVA(1), //PLLA divider: DIVA=1 divider is bypassed
                0); // refer to the function PMC_SetPllA(uint32_t pll, uint32_t
cpcr) from the pmc.c file, but this resets the PMC_PLLICPR register

            PMC->PMC_PLLICPR = (0x3u << 8); //refer to the 27.14.20 PLL Charge Pump Current Register para-
graph of the product datasheet, IPLL_PLLA: Engineering Configuration PLL ==> Should be written to 3.

            PMC_SetMckPllDiv(PMC_MCKR_PLLADIV2_DIV2); //Bit PLLADIV2 must always be set to 1 when MDIV is set to 3.
            //In this case 792/2 = 396MHz
            PMC_SetMckPrescaler(PMC_MCKR_PRES_CLOCK); //Selected clock without prescaler on the master clock
            PMC_SetMckDivider(PMC_MCKR_MDIV_PCK_DIV3); //Master Clock is Prescaler Output Clock divided by 3.
            //Finally we get 396/3= 132MHz as final frequency
            PMC_SwitchMck2Pll(); //MCK is now switched on the PLLA. MCK =132MHz.
            break;

        /* When external clock frequency is 16MHz */
        case 16000000:
            PMC_SetPllA( CKGR_PLLAR_STUCKTO1 | //this bit must be set to 1 (Bit 29 must always be set to 1
when programming the CKGR_PLLAR.)
                CKGR_PLLAR_PLLACOUNT(0x3F) | //this bitfield is the number of slow clock cycles before the
LOCKA bit is set in PMC_SR after CKGR_PLLAR is written.
                CKGR_PLLAR_OUTA(0x0) | //To be programmed to 0.
                CKGR_PLLAR_MULA(49) | //0 the PLLA is disabled, 1 up to 127: The PLLA Clock fre-
quency is the PLLA input frequency multiplied by MULA + 1.
                //In this case: 16*(49+1)= 800 MHz
                CKGR_PLLAR_DIVA(1), //PLLA divider: DIVA=1 divider is bypassed
                0); //refer to the function PMC_SetPllA(uint32_t pll, uint32_t
cpcr) in the pmc.c file, but this resets the PMC_PLLICPR register
            PMC->PMC_PLLICPR = (0x3u << 8); //refer to the 27.14.20 PLL Charge Pump Current Register para-
graph of the product datasheet, IPLL_PLLA: Engineering Configuration PLL ==> Should be written to 3.

            PMC_SetMckPllDiv(PMC_MCKR_PLLADIV2_DIV2); //Bit PLLADIV2 must always be set to 1 when MDIV is set to 3.
    }
}

```

```

    PMC_SetMckPrescaler(PMC_MCKR_PRES_CLOCK); //In this case 800/2 = 400MHz
    PMC_SetMckDivider(PMC_MCKR_MDIV_PCK_DIV3); //Selected clock without prescaler on the master clock
                                                //Master Clock is Prescaler Output Clock divided by 3.
                                                //Finally we get 400/3= 133.3333MHz as final frequency
    PMC_SwitchMck2Pll(); //MCK is now switched on the PLLA. MCK =133.3333MHz.
    break;

/* When external clock frequency is 19MHz */
case 19000000:
    PMC_SetPllA( CKGR_PLLAR_STUCKTO1 | //this bit must be set to 1 (Bit 29 must always be set to 1
when programming the CKGR_PLLAR.)
                CKGR_PLLAR_PLLACOUNT(0x3F) | //this bitfield is the number of slow clock cycles before the
LOCKA bit is set in PMC_SR after CKGR_PLLAR is written.
                CKGR_PLLAR_OUTA(0x0) | //To be programmed to 0.
                CKGR_PLLAR_MULA(40) | //0 the PLLA is disabled, 1 up to 127: The PLLA Clock frequency is the PLLA input frequency multiplied by MULA + 1.
                CKGR_PLLAR_DIVA(1), //In this case: 19*(40+1)= 779 MHz
                0); //refer to the function PMC_SetPllA(uint32_t pll, uint32_t
cpcr) in the pmc.c file, but this resets the PMC_PLLICPR register
    PMC->PMC_PLLICPR = (0x3u << 8); //refer to the 27.14.20 PLL Charge Pump Current Register paragraph of the product datasheet, IPPLL_PLLA: Engineering Configuration PLL ==> Should be written to 3.

    PMC_SetMckPllDiv(PMC_MCKR_PLLADIV2_DIV2); //Bit PLLADIV2 must always be set to 1 when MDIV is set to 3.
                                                //In this case 779/2 = 389.5MHz
    PMC_SetMckPrescaler(PMC_MCKR_PRES_CLOCK); //Selected clock without prescaler on the master clock
    PMC_SetMckDivider(PMC_MCKR_MDIV_PCK_DIV3); //Master Clock is Prescaler Output Clock divided by 3.
                                                //Finally we get 389.5/3= 133MHz as final frequency
    PMC_SwitchMck2Pll(); //MCK is now switched on the PLLA. MCK =129.8333MHz.
    break;

/* When external clock frequency is 19MHz */
case 19200000:
    PMC_SetPllA( CKGR_PLLAR_STUCKTO1 | //this bit must be set to 1 (Bit 29 must always be set to 1
when programming the CKGR_PLLAR.)
                CKGR_PLLAR_PLLACOUNT(0x3F) | //this bitfield is the number of slow clock cycles before the
LOCKA bit is set in PMC_SR after CKGR_PLLAR is written.
                CKGR_PLLAR_OUTA(0x0) | //To be programmed to 0.
                CKGR_PLLAR_MULA(40) | //0 the PLLA is disabled, 1 up to 127: The PLLA Clock frequency is the PLLA input frequency multiplied by MULA + 1.
                CKGR_PLLAR_DIVA(1), //In this case: 19.2*(38+1)= 768 MHz
                0); //refer to the function PMC_SetPllA(uint32_t pll, uint32_t
cpcr) in the pmc.c file, but this resets the PMC_PLLICPR register
    PMC->PMC_PLLICPR = (0x3u << 8); //refer to the 27.14.20 PLL Charge Pump Current Register paragraph of the product datasheet, IPPLL_PLLA: Engineering Configuration PLL ==> Should be written to 3.

    PMC_SetMckPllDiv(PMC_MCKR_PLLADIV2_DIV2); //Bit PLLADIV2 must always be set to 1 when MDIV is set to 3.
                                                //In this case 768/2 = 384MHz
    PMC_SetMckPrescaler(PMC_MCKR_PRES_CLOCK); //Selected clock without prescaler on the master clock
    PMC_SetMckDivider(PMC_MCKR_MDIV_PCK_DIV3); //Master Clock is Prescaler Output Clock divided by 3.
                                                //Finally we get 384/3= 128MHz as final frequency
    PMC_SwitchMck2Pll(); //MCK is now switched on the PLLA. MCK =128MHz.
    break;

/* When external clock frequency is 24MHz */
case 24000000:
    PMC_SetPllA( CKGR_PLLAR_STUCKTO1 | //this bit must be set to 1 (Bit 29 must always be set to 1
when programming the CKGR_PLLAR.)
                CKGR_PLLAR_PLLACOUNT(0x3F) | //this bitfield is the number of slow clock cycles before the
LOCKA bit is set in PMC_SR after CKGR_PLLAR is written.
                CKGR_PLLAR_OUTA(0x0) | //To be programmed to 0.
                CKGR_PLLAR_MULA(32) | //0 the PLLA is disabled, 1 up to 127: The PLLA Clock frequency is the PLLA input frequency multiplied by MULA + 1.
                CKGR_PLLAR_DIVA(1), //In this case: 24*(32+1)= 792 MHz
                0); //refer to the function PMC_SetPllA(uint32_t pll, uint32_t
cpcr) in the pmc.c file, but this resets the PMC_PLLICPR register
    PMC->PMC_PLLICPR = (0x3u << 8); //refer to the 27.14.20 PLL Charge Pump Current Register paragraph of the product datasheet, IPPLL_PLLA: Engineering Configuration PLL ==> Should be written to 3.

    PMC_SetMckPllDiv(PMC_MCKR_PLLADIV2_DIV2); //Bit PLLADIV2 must always be set to 1 when MDIV is set to 3.
                                                //In this case 792/2 = 396MHz
    PMC_SetMckPrescaler(PMC_MCKR_PRES_CLOCK); //Selected clock without prescaler on the master clock
    PMC_SetMckDivider(PMC_MCKR_MDIV_PCK_DIV3); //Master Clock is Prescaler Output Clock divided by 3.
                                                //Finally we get 396/3= 132MHz as final frequency
    PMC_SwitchMck2Pll(); //MCK is now switched on the PLLA. MCK =132MHz.

```

```

        break;

    default:
        break;
    }

    /**
     *   The next step is optional but useful if user wants to reduce the overall power consumption
     */
    /* disable internal RC 12 MHz*/
    PMC->CKGR_MOR = (PMC->CKGR_MOR & ~CKGR_MOR_MOSCRCEN) | CKGR_MOR_KEY(0x37);

    /**
     *   The next step is optional but useful to check on scope if the MCK is correctly configured through PCK1
     (PD31)
     */

    /* Configure PCK1 to measure MCK */
    PIOD->PIO_IDR = (1<<31);                                     //Disable Interrupt on PD31
    //abcdsr = PIOD->PIO_ABCDSR[0];
    PIOD->PIO_ABCDSR[0] |= (1<<31);                                //enable the Peripheral B function
which is PCK1
    //abcdsr = PIOD->PIO_ABCDSR[1];
    PIOD->PIO_ABCDSR[1] &= ~(1<<31);                                //enable the Peripheral B function which is
PCK1
    PIOD->PIO_PDR = (1<<31);

    /* Disable programmable clock 1 output */
    REG_PMC_SCDR = PMC_SCDR_PCK1;                                    //Disable the PCK1 output before using
it
    /* Enable the DAC master clock */
    PMC->PMC_PCK[1] = PMC_PCK_CSS_MCK_CLK | PMC_PCK_PRES_CLOCK;    // Select the master clock (MCK) to
connect it to the PCK1 without prescaler.
    /* Enable programmable clock 1 output */
    REG_PMC_SCER = PMC_SCER_PCK1;                                    //Enable the PCK1 output before using
it
    /* Wait for the PCKRDY1 bit to be set in the PMC_SR register*/
    while ((REG_PMC_SR & PMC_SR_PCKRDY1) == 0);                      //

    /**
     *   The next step is mandatory to be sure that no interrupt will hit during the communication with SAM-BA
     */
     /* select FIQ */
    AIC->AIC_SSR = 0;
    AIC->AIC_SVR = (unsigned int) defaultFiqHandler;

    for (i = 1; i < 31; i++)
    {
        AIC->AIC_SSR = i;
        AIC->AIC_SVR = (unsigned int) defaultIrqHandler;
    }

    AIC->AIC_SPU = (unsigned int) defaultSpuriousHandler;

    /* Disable all interrupts */
    for (i = 1; i < 31; i++)
    {
        AIC->AIC_SSR = i;
        AIC->AIC_IDCR = 1;
    }
    /* Clear All pending interrupts flags */
    for (i = 1; i < 31; i++)
    {
        AIC->AIC_SSR = i;
        AIC->AIC_ICCR = 1;
    }
    /* Perform 8 IT acknowledge (write any value in EOICR) */
    for (i = 0; i < 8; i++)
    {
        AIC->AIC_EOICR = 0;
    }
}

```

Appendix B Revision History

Doc Rev.	Date	Comments
42438A	06/2015	Initial document release.



Atmel[®] Enabling Unlimited Possibilities[®]



Atmel Corporation 1600 Technology Drive, San Jose, CA 95110 USA T: (+1)(408) 441.0311 F: (+1)(408) 436.4200 | www.atmel.com

© 2015 Atmel Corporation. / Rev.: Atmel-42438A-SAM-BA-Overview-and-Customization-Process_ApplicationNote_AT09423_062015.

Atmel[®], Atmel logo and combinations thereof, Enabling Unlimited Possibilities[®], SAM-BA[®], and others are registered trademarks or trademarks of Atmel Corporation in U.S. and other countries. ARM[®], ARM Connected[®] logo, and others are the registered trademarks or trademarks of ARM Ltd. Windows[®] is a registered trademark of Microsoft Corporation in U.S. and or other countries. Other terms and product names may be trademarks of others.

DISCLAIMER: The information in this document is provided in connection with Atmel products. No license, express or implied, by estoppel or otherwise, to any intellectual property right is granted by this document or in connection with the sale of Atmel products. EXCEPT AS SET FORTH IN THE ATTEL TERMS AND CONDITIONS OF SALES LOCATED ON THE ATTEL WEBSITE, ATTEL ASSUMES NO LIABILITY WHATSOEVER AND DISCLAIMS ANY EXPRESS, IMPLIED OR STATUTORY WARRANTY RELATING TO ITS PRODUCTS INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT. IN NO EVENT SHALL ATTEL BE LIABLE FOR ANY DIRECT, INDIRECT, CONSEQUENTIAL, PUNITIVE, SPECIAL OR INCIDENTAL DAMAGES (INCLUDING, WITHOUT LIMITATION, DAMAGES FOR LOSS AND PROFITS, BUSINESS INTERRUPTION, OR LOSS OF INFORMATION) ARISING OUT OF THE USE OR INABILITY TO USE THIS DOCUMENT, EVEN IF ATTEL HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. Atmel makes no representations or warranties with respect to the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and products descriptions at any time without notice. Atmel does not make any commitment to update the information contained herein. Unless specifically provided otherwise, Atmel products are not suitable for, and shall not be used in, automotive applications. Atmel products are not intended, authorized, or warranted for use as components in applications intended to support or sustain life.

SAFETY-CRITICAL, MILITARY, AND AUTOMOTIVE APPLICATIONS DISCLAIMER: Atmel products are not designed for and will not be used in connection with any applications where the failure of such products would reasonably be expected to result in significant personal injury or death ("Safety-Critical Applications") without an Atmel officer's specific written consent. Safety-Critical Applications include, without limitation, life support devices and systems, equipment or systems for the operation of nuclear facilities and weapons systems. Atmel products are not designed nor intended for use in military or aerospace applications or environments unless specifically designated by Atmel as military-grade. Atmel products are not designed nor intended for use in automotive applications unless specifically designated by Atmel as automotive-grade.